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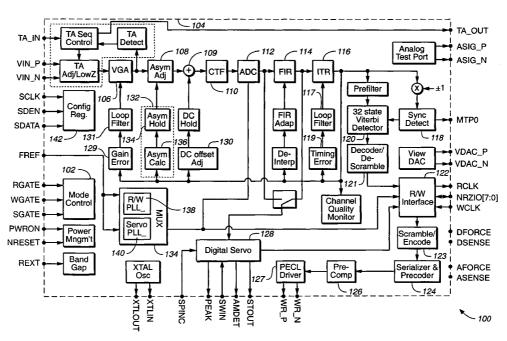
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(54) Title: IMPROVED READ/WRITE CHANNEL



(57) Abstract: An improved sampled amplitude read/write channel is provided. The system is an integrated Generalized Partial Response Maximum Likelihood (GPRML) read channel incorporating Read, Write, and Servo modes of operation. One implementation includes a 32/34 rate parity code and matched Viterbi detector, a 32 state Viterbi detector optimal parity processor, robust frame synchronization, self-adaptive equalization, thermal asperity detection and compensation, adaptive magneto-resistive asymmetry compensation, low latency interpolated timing recovery and programmable write precompensation.





IMPROVED READ/WRITE CHANNEL CROSS-REFERENCE TO RELATED APPLICATIONS

This application claims priority from U.S. Provisional Application Serial No. *00P7564*, filed April 5, 2000, which is hereby incorporated by reference in its entirety as if fully set forth herein. A copy is attached as the Appendix.

BACKGROUND OF THE INVENTION FIELD OF THE INVENTION

The present invention relates to disk drives and, particularly, to an improved read/write channel.

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DESCRIPTION OF THE RELATED ART

In a magnetic recording system, data are encoded and written onto a disk in regions of differing magnetization. To read the data out, they are first detected and then decoded. The writing and reading occurs using a magnetic head, such as inductive heads or magneto-resistive heads.

FIG. 54 illustrates an exemplary read-write channel system according to the prior art. As shown, the system includes an encoder 5402, read/write head 5404, disk 5406, detector 5408, and decoder 5410. User data are provided to the encoder 5402. Once encoded, the input data may be subject to further channel or modulation coding, as well as error correction coding, and are then written onto the disk 5406 by the head 5404.

To write the channel data onto the disk, the bits are converted into a write current waveform. When the write current waveform takes a positive value, it magnetizes the disk in a first direction; when negative, it magnetizes the disk in a second direction. These states of magnetization are typically described using NRZ or NRZI data. In the NRZ scheme, a one (1) represents one direction of magnetization, and a zero (0) represents another. In the NRZI scheme, a one (1) identifies a transition, and a zero (0) represents no transition.

As noted above, prior to converting the data to the magnetization pattern, it is typically encoded (e.g., using encoder 5402). The encoding typically minimizes the number of adjacent transitions (to reduce intersymbol interference)

and to avoid long strings of zeroes (which can cause problems with channel synchronization and detection.). Coding types include run length limited codes and other known types.

To read the disk 5406, the head reads an analog signal and provides it to the detector 5408. A variety of detectors are commonly used. These include peak detectors or sampled data detection techniques. The detector 5408 recovers the data and provides it to the decoder 5410, which decodes the channel data.

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In sampled data detection systems, the readback signal is filtered and sampled at a channel rate of 1/T, where T is the duration of a channel symbol. One such technique is referred to as "partial response with maximum likelihood" (PRML). In PRML systems, the output of the noisy partial response channel is sampled at the channel rate and detected using a maximum likelihood Viterbi detector.

The partial response channel has a transfer function of the form (1-D)(1+D) or $1-D^2$, where D represents a unit time delay operator with unit-time T. Thus, the noiseless output of the partial response channel is equal to the input signal minus a version of the input delayed in time by period 2T.

To further increase recording density and decrease the need for equalization, higher order PRML systems have been developed. The extended partial response with maximum likelihood (EPRML) channel has a transfer function of the form $(1-D)(1+D)^2$ or $(1+D-D^2-D^3)$. Thus, the noiseless output of the extended partial response channel is equal to the input signal minus a version of the input signal delayed in time by 2T, minus a version of the input signal delayed in time by 3T and plus a version of the input signal delayed in time by T. Similarly, the E²PRML channel has a transfer function of the form $(1-D)(1+D)^3$.

As noted above, Viterbi decoders are typically employed in sampled amplitude channels. Viterbi decoders are specific implementation of the Viterbi algorithm. A Viterbi detector unit is based on periodic examination of metrics associated with alternate sequences of recorded bits, wherein each sequence is typically labeled as a "path" and the associated metric is designated a "path metric." The most probable correct path is then determined by choosing a

minimum path metric based on an iterative process involving successive comparison of associated path metrics.

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In particular, two paths within a constrained, predetermined path length are examined. Since the recorded bit only depends on the constraint length corresponding to a finite number of neighbor bits, it becomes possible to abandon the path associated with the larger of the two path metrics corresponding to each path pair. Consequently, the number of possible paths can be restricted to a finite value by abandoning all but one of the total number of paths each time a new bit is added and examined during the data detection procedure. This process of path abandonment in order to compute the best path to each node of the trellis is executed by a sequence of operations commonly referred to as add-compare-select or ACS.

SUMMARY OF THE INVENTION

According to one embodiment of the present, an improved sampled amplitude read/write channel is provided. The system is an integrated Generalized Partial Response Maximum Likelihood (GPRML) read channel incorporating Read, Write, and Servo modes of operation. One implementation includes a 32/34 rate parity code and matched Viterbi detector, a 32 state Viterbi detector optimal parity processor, robust frame synchronization, self-adaptive equalization, thermal asperity detection and compensation, adaptive magnetoresistive asymmetry compensation, low latency interpolated timing recovery and programmable write precompensation.

BRIEF DESCRIPTION OF THE DRAWINGS

A better understanding of the invention is obtained when the following detailed description is considered in conjunction with the following drawings in which:

- FIG. 1 is a block diagram of a read/write channel according to a specific embodiment of the invention;
- FIG. 2 is a diagram input impedance switches according to an embodiment of the invention;

- FIG. 3 is a diagram of thermal asperity detection and correction according to an embodiment of the invention;
- FIG. 4 is a diagram of thermal asperity correction waveforms according to an embodiment of the invention;
- FIG. 5 is a diagram of MR Asymmetry compensation according to an embodiment of the invention;

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- FIG. 6 is a diagram of a timing control subsystem according to an embodiment of the invention;
- FIG. 7 is a diagram of a timing loop filter according to an embodiment of the invention:
 - FIG. 8 is a diagram of timing acquisition according to an embodiment of the invention;
 - FIG. 9 is a diagram of an AGC loop according to an embodiment of the invention;
- FIG. 10 is a diagram of an AGC loop filter according to an embodiment of the invention;
 - FIG. 11 is a diagram of a DC restore loop according to an embodiment of the invention;
 - FIG. 12 is a diagram of AGC shadow register operation in read mode according to an embodiment of the invention;
 - FIG. 13 is a diagram of AGC shadow register operation in servo mode according to an embodiment of the invention;
 - FIG. 14 is a diagram of DC restore shadow register operation according to an embodiment of the invention:
- 25 FIG. 15 is a diagram of an MR Asymmetry compensation loop according to an embodiment of the invention;
 - FIG. 16 is a diagram of MR Asymmetry shadow register operation according to an embodiment of the invention:
 - FIG. 17 is a diagram of FIR filter structure according to an embodiment of the invention:
 - FIG. 18 is a diagram of FIR adaptation according to an embodiment of the invention:

- FIG. 19 is a diagram of FIR Adaptation Read Mode Timing according to an embodiment of the invention;
- FIG. 20 is a diagram of a Viterbi detector according to an embodiment of the invention;
- FIG. 21 is a write path block diagram according to an embodiment of the invention:
 - FIG. 22 is a scrambler/descrambler block diagram according to an embodiment of the invention;
- FIG. 23 is a diagram of a PRBS generator according to an embodiment of the invention;
 - FIG. 24 is a block diagram of a precoder according to an embodiment of the invention;
 - FIG. 25 is a diagram of write precomp according to an embodiment of the invention;
 - FIG. 26 is a write PECL interface according to an embodiment of the invention;

- FIG. 27 is a diagram of PECL logic levels according to an embodiment of the invention:
- FIG. 28 is a block diagram of a digital servo according to an embodiment of the invention;
 - FIG. 29 is a block diagram of a correlator according to an embodiment of the invention;
 - FIG. 30 is a diagram of a correlator frequency response according to an embodiment of the invention;
- FIG. 31 is a timing diagram of unoriented search (manual AGC) according to an embodiment of the invention;
 - FIG. 32 is a timing diagram of unoriented search (auto sample AGC) according to an embodiment of the invention;
- FIG. 33 is a timing diagram of oriented search (normal AGC) according to an embodiment of the invention;
 - FIG. 34 is a diagram of servo address mark polarity according to an embodiment of the invention:

- FIG. 35 is a diagram of NRZI read interface timing according to an embodiment of the invention;
- FIG. 36 is a diagram of NRZI write interface timing according to an embodiment of the invention;
- FIG. 37 is a diagram of a read mode/write mode PLL according to an embodiment of the invention;
 - FIG. 38 is a diagram of a servo mode PLL according to an embodiment of the invention;
- FIG. 39 is a diagram of serial port timing according to an embodiment of the invention;
 - FIG. 40 is a diagram of read mode sector architecture according to an embodiment of the invention;
 - FIG. 41 is a diagram of read mode operation acquire timing according to an embodiment of the invention;
 - FIG. 42 is a diagram of read mode gate extension according to an embodiment of the invention;

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- FIG. 43 is a diagram of normal write operation according to an embodiment of the invention;
- FIG. 44 is a diagram of direct write operation according to an embodiment of the invention;
 - FIG. 45 is a diagram of system operation according to an embodiment of the invention;
 - FIG. 46 is a diagram of write mode to idle mode recovery according to an embodiment of the invention;
 - FIG. 47a and FIG. 47b illustrate channel quality measurements according to an embodiment of the invention;
 - FIG. 48 illustrates a measurement interval timer state machine according to an embodiment of the invention;
 - FIG. 49 illustrates CQM data collection single sector according to an embodiment of the invention;
 - FIG. 50 illustrates CQM data collection multiple sectors according to an embodiment of the invention;

- FIG. 51 illustrates analog signal injection according to an embodiment of the invention;
- FIG. 52 illustrates a view ADC function according to an embodiment of the invention:
- FIG. 53 illustrates an analog test port according to an embodiment of the invention; and
 - FIG. 54 is a diagram of a read-write channel system according to the prior art.

DETAILED DESCRIPTION OF AN EMBODIMENT OF THE INVENTION System Overview

Modulation Code

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The modulation code used in one embodiment of the invention is a rate 32/34 block code. All 34-bit codewords satisfy a 'Charge module 2" (Qmod2) parity constraint. The code achieves about 1dB net coding gain by forcing the charge in each codeword to be even. As a consequence of this parity constraint, all error sequences with odd parity are eliminated. This includes; di-bit drop-in and drop-outs (0,+1 0), tri-bit related errors (+1,-1,+1), pentabit related errors (+1,-1,+1,-1,+1), etc. The (Qmod2 constraint offers more immunity to errors than uncoded or maximum transition run (MTR) codes under normal operating environments.

The modulation code is also designed to achieve good worst-case timing information, maximizing the minimum timing information content in any codeword. Each 34 bit codeword has at least a minimum of 7 timing units of information. For ECC compatibility, minimum-distance error events on the coded trellis are limited to cause errors in no more than 4 decoded user bytes. Thus, best system performance is achieved using an outer error correcting code with 8-bit symbols, GF(256), and with greater than or equal to 4-way interleave. The code properties are summarized in Table 1: Code Properties

Rate	Parity	Minimum # timing counts per code word	Max # consecutive 0's	Max Burst Length
32/34	Even	7	17	4 bytes

Table 1: Code Properties

Viterbi Sequence Detector

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The sequence detector is implemented using a 32-state Viterbi detector that is the product of a 16-state Noise Predictive Inter-Symbol Interference (NP ISI) Viterbi algorithm and a 2-state time-varying charge parity trellis. The 32-state product trellis is pruned back to 16-states at every 34th bit-cycle to enforce the charge parity constraint at the block boundary. This implementation of the parity code is an optimal maximum likelihood solution, and has none of the sub-optimal characteristics of prior solutions, e.g., failure at block boundaries, sensitivity to changing error event structure, etc.

In order to provide good performance across a wide range of user operating conditions, the system allows the user to choose from four different noise-predictive Viterbi algorithms.

Noise Predictive (3,2,1) is best suited for applications with low to moderate user densities. It performs well in these areas even with high media noise.

Noise Predictive (2,2, 1) is best suited for applications with moderate media noise and moderate to high user densities.

Noise Predictive (3,1, 1) is best suited for applications with low to moderate user density and very high media noise.

EPR4 is included as a legacy mode, and performs close to Noise Predictive {3,2,1} in most environments.

Exemplary Viterbi detection is described in commonly assigned U.S. Patent Application Serial No., 99P7685, titled "Trellis Code for EPRML", filed _____, U.S. Patent Application Serial No. 99P7767, titled "Survival Selection Rule," filed _____, and U.S. Patent Application Serial No. 99P7766, titled "Supporting ME2PRML and M2EPRML with the Same Trellis Structure," filed _____, which are hereby incorporated by reference in their entireties as if fully set forth herein.

Channel Architecture

Turning now to the drawings and, with particular attention to FIG. 1, a block diagram of a read/write channel according to a specific embodiment of the invention is shown therein and designated generally by the reference numeral 100.

As will be discussed in greater detail below, the system 100 is operable in a plurality of modes, selectable with the inputs RGATE, WGATE, SGATE, and the mode control unit 102. The modes are Read Mode, Write Mode, Normal Write Mode, Known Data Write Mode, Write Mode During Servo Mode, Servo Mode, Idle Mode, Doze Mode, and Suspend Mode.

The operating modes of the read/write channel are determined by the state of five pins: RGATE, WGATE, SGATE, PWRDN, NRESET, and two registers: 04<2>, and 04<1>. The operating modes are shown in Table 2:

Mode		Reg Bits					
	RAGTE	WGATE	SGATE	PWRDN	NRESET	04<2	04<1>
Read mode	1	Х	0	0	.1	Х	0
Write mode	0	1	0	0	1	X	0
Servo mode	Х	Х	1	. 0	1	0	0
Write/Servo mode	0	1	1	0	1	1	0
Idle mode	0	0	0	0	1	Х	0
Doze mode	0	0	0	1	1	Х	0
Suspend	Х	Х	Х	.,X	1	Х	1
	Х	Х	Х	Х	0	X	Х

Table 2: Mode Control

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In the read mode, RGATE is asserted, and the read channel is activated. In the read channel, a bit sequence is provided via thermal asperity compensation 104 to a variable gain amplifier 106 to adjust the amplitude of the signal. DC offset control 130 and loop filter/gain error correction 131 also may be provided. Further, an asymmetry control unit 132 including an asymmetry adjustment unit 134 and asymmetry control 136 may be provided to compensate for magneto-resistive asymmetry effects. An exemplary system for magnetoresistive asymmetry control is described in co-pending U.S. Patent No. _____, filed ____, titled "Magneto-Resistive Asymmetry Control Loop" [99P7554], which is hereby incorporated by reference in its entirety as if fully set forth herein.

The signal is provided to a continuous time filter 110, such as a four pole Butterworth filter, for example, to attenuate high frequency noise and minimize aliasing into baseband after sampling. The signal is then provided to an analog to digital converter (ADC) 112 to sample the output of the continuous time filter (CTF) 110.

A finite impulse response (FIR) filter 114 provides additional equalization of the signal to the desired response. The output of the FIR 114 is provided to an interpolated timing recovery unit 116, which is used to recover the discrete time sequence. Exemplary timing recovery is described in commonly assigned U.S. Patent Application Serial No. 99E7966, "Asynchronous Timing for Interpolated Timing Recovery," filed _____, and U.S. Patent Application Serial No. 99E7967, "Synchronous Timing for Interpolated Timing Recovery," filed _____, which are hereby incorporated by reference in their entireties as if fully set forth herein.

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The output of the interpolated timing recovery unit 116 is used to provide a feedback control to the DC offset control 130, the gain error 131, the asymmetry control 132 and the FIR 114. The output of the interpolated timing recovery 116 is further provided to a Viterbi detector 120 and a sync detector 118. Sync mark information is then provided to the Viterbi detector 120 for use in sequence detection. The Viterbi detector output is then provided to the decoder 121 which decodes the encoding provided by the encoder (not shown). Exemplary sync mark detection is described in U.S. Patent Application Serial No., 99P7768, "Phase Assisted Synchronization Detector," filed, _____, which is hereby incorporated by reference in its entirety as if fully set forth herein. As described therein, relatively short sync byte detection may be performed, thereby saving overhead. Further, the sync byte detector 118 is programmably polarity sensitive such that the polarity of the data stream entering the sync detector and the Viterbi detector may be flipped. Exemplary acquisition signal estimation is described in U.S. Patent Serial No. 99P7764, titled "An Acquisition Signal Error Estimator," filed _____, which is hereby incorporated by reference in its entirety as if fully set forth herein. Once the sync byte is detected, data are placed on the R/W interface 122.

In the Write Mode, circuitry in the write path is enabled. In particular, write data are provided to as NRZIO data to the interface 122, then are scrambled and encoded in unit 123, then serialized and precoded using serializer/precoder 124, and precompensated using precomepnsator 126. The write data are then provided to a PECL driver 127.

In the Normal Write Mode, WGATE is asserted and the disk drive controller (not shown) clocks a 00h (hex) byte to the NRZIO interface 122. The device output is a 2T preamble pattern until the data marker, a FFh byte, is received from the controller. At that point, the device inserts a unique sync byte into the output data stream, which replaces the received FFh byte. Subsequent data transferred from the controller is scrambled, encoded (123) and then transferred to the PECL interface 127 as encoded user data.

The Known Data Write mode is a variation of a normal Write. When 20<3> is set to 1, the device write output is a sector of internally generated data. The operation begins when WGATE is asserted and the controller clocks a 00h (hex) byte to the NRZIO interface 122. The device writes a 2T preamble pattern until the data marker, a FFh byte, is received from the controller. At this point, the device inserts a unique sync-byte into the output data stream, which replaces the received FFh byte, followed by write data consisting of an internally generated repeating pseudo-random binary sequence (PRBS), the output of a linear feedback shift register (LFSR) circuit. Subsequent user data transferred from the controller to the NRZIO interface 122 is ignored for the duration of the write cycle.

The activation of Read Mode, Write Mode, and Servo Modes are governed by a set of precedence rules as outlined in Table 2. Write Mode usually has the lowest precedence and can be overridden by Read Mode or Servo Modes. However, when register 04<1>= 1, Write Mode may also occur during Servo Mode. Both Servo and Write Mode may take place simultaneously. Servo Mode must be active before the device will enter Write Servo Mode.

During Servo mode, the VGA and AGC loops, as well as the CTF, 110 ADC 112, and FIR filter 114 sections of the read path are active, and are programmed to a unique set of servo register values. The equalized and conditioned sample values are sent to a servo synchronizer that functions to determine time intervals needed for digital based asynchronous peak detection. Asynchronous peak detection is used to determine the peak position required to demodulate the Gray code. A and B servo bursts are digitally integrated to produce burst area estimates that are transferred to the disk controller via the

NRZIO interface 122.

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Idle Mode is defined as the absence of Read mode, Write mode and Servo mode activity. All analog circuitry and frequency synthesizers are enabled, and the analog to digital converter (ADC) and DC Restore are active.

In Doze Mode all nonessential circuitry is disabled. Register bits 98<1:0> and 98<1:0> determine if the synthesizers are enabled. Upon transition from Doze Mode to Idle Mode, a start-up time is required to allow the frequency synthesizers and analog circuitry to stabilize. The timing rules are defined in Table 3.

Parameter	Time	Description
T _{r/r}	24 PLL clocks	Contiguous Read mode to Read mode
T _{s/d}	500 ms	Suspend to doze mode
T _{d/I}	100 us	Doze mode to idle mode
T _{i/s}	24 PLL clocks	Idle mode to servo mode
T _{s/I}	24 PLL clocks	Servo mode to idle mode
T _{r/i}	24 PLL clocks	Read mode to Idle mode

Table 3: Mode Timing Rules

Suspend Mode turns off all channel read/write activity. The configuration registers retain their settings and determine the initial state after N RESET = 0.

The system device may be divided into functional partitions that may be powered on or off depending on which mode is active. In the following table, 1 is powered-on, and 0 is powered-off.

Modes	Band Gap	Synth	Analog FE	Servo	ADC	FIR	ITR/Viterbi	Read I/F	Write I/F
Read	1	1	1	0	1	1	1	1	0
Write	1	1	0	0	0	0	0	0	1
Servo	1	1	1	1	1	1	0	0	0
Idle	1	1	1	0	1	0	0	0	0
Doze	1	0	0	0	0	0	0	0	0
Suspend	0	0	0	0	0	0	0	0	0

Table 4: Power Modes

Read Mode

In the embodiment illustrated, the read path includes differential input pins VIN_P, VIN_N, thermal asperity and compensation unit 104, VGA 106, MR

asymmetry compensation 108, continuous time filter (CTF) 110, analog-to-digital converter (ADC) 112, finite impulse response filter (FIR) 114, interpolated timing recovery unit (ITR) 116, Viterbi detector 120, decoder 121, and interface 122, as well as associated feedback and control circuitry.

A differential signal from a preamplifier (not shown) is transferred to the VGA 106 through the VIN_P and VIN_N pins. External capacitors (not shown) couple the preamplifier signal to the VGA 106. In one implementation, the VGA inputs are internally biased so that external DC biasing components are not required. The normal operating signal input level at pins VIN_P and V1N_N is 40-400 mV peak-to-peak differential.

An internal 8-bit DAC that is adjusted by the Automatic Gain Control (AGC) loop (described below) controls the gain of the VGA 106. The initial gain for read and servo operations are programmed as 2s-complement numbers in registers 7A<7:0> and 7B<7:0>, respectively. The VGA control range is from 0 dB to 20 dB.

Impedance switches 202, 208, in series and in parallel with the inputs of the VGA 106, are shown in Figure 2. These switches allow reduced recovery time from transients that occur during write sequences and thermal asperity events. During a normal Read mode operation, the series switches 202, 208 are closed and the shunt switch 210 is opened, setting the input impedance to 250-2000 Ohms.

When the impedance switches 202, 208 are used to compensate a thermal asperity event, the AC coupling pole frequency is increased by adjusting the shunt impedance ZADJ 210 to reduce the input impedance. The input impedance is varied dynamically over time.

During Write mode, the switches 202, 208 in series with the VGA inputs are opened, providing a high input impedance. Simultaneously, the shunt input resistance 210 is reduced. A more detailed explanation of the use of the impedance switching used for Write mode to Idle mode recovery is found below.

Prior to being input to the VGA 106, in certain embodiments, thermal asperity (TA) detection and correction is provided. Figure 3 illustrates an exemplary thermal asperity detection and correction unit or circuit 104. In

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particular, a TA Detection and Correction Unit 104 includes a TA Detect Unit 306, a TA Control Unit 304, and a TA Compensation Unit 302. The TA detection and correction circuitry 104 acts to reduce the effects of distortion caused when the magneto-resistive (MR) head encounters a TA on the disk.

The overall objective of the TA compensation circuit 104 is to reduce overload and decrease recovery time during a TA event. Ideally, the bit length of the compensated error burst will be reduced so that ECC correction is possible.

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The TA detect block 306 includes a lowpass filter (not shown) coupled to a threshold detector (not shown). The amplitude-normalized signal from the output of the VGA 106 is sent through the TA detect low-pass filter and then applied to the threshold detector. The threshold level is independently programmable for Read mode and Servo modes by using registers 89<3:0> and 39<7:4> respectively. A TA event is defined to have occurred when the low-pass filter output exceeds the threshold value for the time set by register 88<5:4>.

When a TA event is detected, the TA_OUT pin is asserted by the TA Control unit 304. In addition, an internal compensation sequence is initiated in the TA Compensation Unit 302 that changes the input high-pass pole frequency at the VGA input as described in Figure 4. The input time-constant decays exponentially over a time period, set by T_T, to the initial nominal value. The gain of the DC restore loop 130 is also increased to allow for faster baseline recovery. Timing, gain and FIR adaptation loops are put in hold mode for the duration of the TA event. In addition, the MR asymmetry loop is put in hold mode until the end of the RGATE. External or internal TA detection may be selected by register 88<7>. Relevant user programmable parameters are shown in Table 5:

Parameter	Range	Default	Register
Detection enable	N/A	Disabled=1	88<1>
TA detection threshold (Read mode)	0 –15	0	89<3:0>
TA detection threshold (Servo mode)	0-15	0	89<7:4>
TA low-pass bandwidth	5.5-10 MHz	10 MHz	88<3:2>
Duration of timing and gain loop hold	6 bytes	a.e.	Fixed
Rp values	12, 5	12	8A<2>
TL	1-4 bytes		8A<4:3>

TT	100-1600 ns	400 ns	8A<6:5>

Table 5: TA Compensation Registers

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As shown in Figure 5, the output of the VGA 106 is provided to a Magneto-resistive Asymmetry Compensation Unit (MRACU) 108. As shown, the MRACU 108 includes a squaring function 502, a scaling multiplier function 504, and an adder 506. The output of the VGA 106 is squared by the squaring function 502 and multiplied by the scaling factor Vmr in scaling multiplier 504, and then added to itself using adder 506. This combination provides a nonlinear transfer function from the VGA 106 to the input of the continuous time filter (CTF) 110 in a form that may be adjusted to compensate for second harmonic distortion created by the MR head. The term Vmr adjusts the magnitude of compensation. The value of Vmr is automatically determined by an MR asymmetry compensation loop as will be described below with reference to Figure 15.

An adder function 109 following the compensation circuit 108 is used to nullify the accumulated DC offset in the analog signal path. A voltage, Vdc derived from a DC restore control loop (described in greater detail below, with reference to Figure 11), is added to the signal to cancel the DC value of the signal into the CTF 110 and ADC 112. The DC restore control loop is implemented in the digital domain.

The CTF 110 in one implementation is a 4-pole continuous time low pass analog filter and is used to truncate the noise bandwidth input to the analog to digital converter (ADC) 112. The low pass characteristic also prevents aliased frequency components beyond the Nyquist frequency from falling in the pass band.

The frequency response of the filter does not correspond to a standard polynomial. The filter itself is a cascade of two second order s-domain transfer functions, given below:

$$H(s) = \frac{1}{(s^2 + (\omega_{01}/Q1)s + 1)(s^2 + (\omega_{02}/Q2)s + 1)}$$

The ω_0 (pole-pair frequency) and Q (pole-pair quality factor) of each biquad are

independently adjustable. In one implementation, ω_0 is programmable from 2π x 87.5 Mrad/s to 2π x 350 Mrad/s (4:1 ratio).

In one implementation, the ADC 112 is a 6-bit, background calibrated, flash ADC. The use of an interpolated timing recovery architecture allows more channel latency. The latency may be exploited to optimize speed, power and performance in the design of the ADC.

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In one implementation, the system uses a digital interpolated timing recovery (ITR) method to resample readback waveform samples at the proper time instances required for sequence detection. Figure 6 shows the phase-locked loop structure that is used to synchronize to the phase and frequency of the incoming readback bit stream.

In particular, asynchronous samples from the FIR 114 are provided to an 8-tap interpolation filter 602. The interpolated samples are then provided in a loop including a timing error unit 119, a first order loop filter 117, and a timing accumulator base and phase calculator 602. The timing accumulator 602 also receives an input from a zero phase restart unit 604.

The equalized and oversampled data values from the ADC are interpolated using a 8-tap digital FIR interpolation filter. With this technique, the sample phase is represented as a binary number which is the input to the interpolation filter.

The Timing Error block 119 processes interpolated samples to produce the timing corrections that are used for tracking and acquisition modes respectively. The errors are filtered by a digital pole-zero filter 117 combination to produce the estimated error in interpolation sample time. The "Time Accum" block 602 translates its input into two signals: the resample phase within a clock cycle, and uk, which acts as a not-strobe to indicate when a clock period does not contain a resample. When mk is asserted, the ITR output for the corresponding clock cycle is ignored for all downstream processing. The 8-tap filter 602 estimates the sample value between the asynchronous samples to produce time-normalized interpolated sample values. Since the device uses a 6.67% oversampling ratio, approximately every 16th clock cycle is not used.

The timing loop filter 117 is synthesized in the digital domain. A block

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diagram of the 1st order digital loop filter 117 is described in Figure 7. The timing loop filter output is the sum of a digital integrator 701, representing a pole, and a proportional term α 704, representing a zero. The integrator 701 includes a scaling factor β , accumulator register R 708 and feedback adder 706.

The contributions of the pole and zero are dynamically changed during the lock-on sequence by varying α and β to minimize phase and frequency capture time. The upper path 701, containing integrating register R 708, stores the resampled frequency setting while the lower path 704 causes phase adjustments that are required for loop stability and for reduction of peak phase errors.

The timing algorithm proceeds through three distinct modes. The three timing mode intervals are shown pictorially in Figure 8: a "zero-phase" mode 802, where the resampling phase is set to a predetermined value with respect to the average phase of the preamble, a second "fast-acquire" mode 806, where the frequency of the loop is adjusted, and a third and final "data-tracking" mode 808, where the timing loop is phase and frequency locked and the timing corrections are derived by averaging over many bits. This is sometimes called the three gear system.

The AGC loop, shown in Figure 9, sets the overall voltage gain of the read path so that the output amplitude of the ADC 112 is independent of channel input voltage variations. The function of the AGC loop is to provide a normalized signal amplitude input for the Viterbi detector 120. The AGC loop also functions to constrain the signal voltage to be within the dynamic range of the ADC 113.

Shown in Figure 9 are VGA 106, CTF 110, ADC 112, FIR 114, ITR 116, Gain error Calculation 129, and Loop Filter 131. Gain corrections, Gn are derived from interpolator output samples, x.

During fast-acquire mode, the AGC loop gain is increased, and only non-zero sample estimates are used. Gain errors are integrated using the digital loop filter 131 as shown in Figure 10. The loop filter 131 includes integrator having an adder 1002, register 1004 and D/A 1006. The gain register 1004, R, accumulates gain error terms until the control voltage to the VGA stage VAGC, is set to the value that makes the amplitude input to the Viterbi detector 120 equal to the target number.

Accumulated DC offset in the analog signal path is cancelled using the DC restore control loop shown in Figure 11. DC offset is measured only during the data field. The loop filter includes an integrator having an adder 1102, register 1104 and D/A 1106. At each bit clock cycle, an error term, e, is calculated and added to the accumulator value R 1104 which is coupled to a DAC 1106. In turn, the DAC output adds a correcting voltage to the analog signal path before the CTF 110 using adder 109. In this manner, the control loop functions to nullify DC offset as measured at the ITR output.

The initialization of the register R 1004 used in the AGC (FIG. 10) is accomplished using a corresponding shadow register, as illustrated in Figure 12. Shown are states 1202 and 1204. Shadow register operation is as follows: The AGC accumulator R 1004 is always loaded with the contents of the AGC shadow register when RGATE is asserted (1202). The shadow register can be loaded or read back (1204) by the serial interface. Alternately, when 78<1> is set, the shadow register is used to save the contents of the AGC accumulator 1004 at the deassertion of RGATE.

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Typically the shadow register is loaded with a 'best guess' initial gain setting through the serial interface. Successive read cycles are performed with 78<1> set to 1, so that a new initial gain setting is saved after each sector. When the gain setting has converged and is no longer changing, the new value is saved and used as the initial gain setting for non-feedback AGC modes, when 78<1> is set to 0.

During Servo mode, a separate accumulation register and shadow register are used to control the AGC, as shown in Figure 13. If register bit 78<0>=1 the servo AGC accumulator is updated from the shadow register when SGATE is asserted (1304). If 78<0>=0 the servo AGC accumulator is updated with the value of the read AGC accumulator that has been derived from a previous read operation (1302).

Similarly, the initialization of the register R (1104) used in the DC restore (DCR) loop (Figure 11) is accomplished using a corresponding shadow register, as shown in Figure 14. The DCR accumulator R (1104) is always loaded with the contents of the read AGC shadow register when RGATE is asserted (1406). The

shadow register can be loaded or read-back by means of the serial interface (1408). When 78<3> is set, the read shadow register is used to save the contents of the AGC accumulator at the de-assertion of RGATE (1402). The DCR accumulator R (1104) is always loaded with the contents of the servo shadow register when SGATE is asserted (1406). However, the operation of this register is different than in read, since the DC restore loop does not adapt during servo. The DCR servo shadow register is initialized either by the serial interface, or if register 78<2> is set, then it is loaded with the results of a previous read operation.

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The MR asymmetry compensation loop operates only during the user data portion of the sector in Read mode. The compensation ioop architecture is shown in Figure 15, essentially the circuit of Figure 5 with the input to the multiplier 506 shown as including summer 1502, accumulator register R 1504, and D/A 1506.

An asymmetry error term, en, derived from three consecutive sample values of the data, is added to the MR asymmetry accumulator R 1504 that accumulates to a value Mn. The accumulator 1504 drives a DAC 1506, producing an output, Vmr that is used to vary the value of V²vga, a signal proportional to the square of the analog output of the VGA 106. The output of the MR asymmetry compensation circuit becomes (Vvga + Vmr x V²vga). The feedback loop adjusts the amplitude of (Vmr x V²vga) to a value that will compensate for the ²nd harmonic distortion produced by the MR head nonlinear transfer function. The loop gain, γmr has only one setting.

The accumulation register R (1504) which is used in the MR asymmetry (MRA) correction loop, is initialized using a shadow register as shown in Figure 16. Use and operation of the MR shadow register is identical to that of the DC restore shadow register (Figure 14).

The FIR 114 is a 10-tap Finite Impulse Response Filter (FIR) and is used to complete the equalization of the digitized signal to the EPRML target waveform. The topology of the filter is shown in Figure 17. The active FIR coefficients (tap weights) 1700-1709 may be loaded with the contents of the shadow coefficient registers at the start of read or servo operations. Two sets of shadow registers are used, one for Read mode and one for Servo mode, as

shown in Figure 18. The values of the Read mode and Servo mode FIR shadow registers (1802, 1804) can be modified through the serial port when NOT in Read mode or Servo mode. Only the read shadow registers 1802 can be updated with values derived from a self-adaptive read operation. The values of the Servo mode shadow registers 1802 are always assigned through the serial port. During a read operation, the FIR coefficients are transferred from the shadow registers to the F1R coefficient registers 1806 on assertion of RGATE. FIR filter self adaptation is enabled when 3D<2>=1. After completion of a read, and if 3D<3>=1,then values of the Read shadow registers 1804 are updated by the contents of the FIR coefficients derived from the previous read operation. However if the FIR_SAT signal is asserted, indicating that one or more FIR filter coefficients have saturated, then the update is aborted and inaccurate coefficients are discarded.

In self-adaptive mode, selected filter taps may be programmed to serve as cursor taps by registers 30<7:0>and 30<0>. Selected taps retain their initial coefficient settings while other taps are adapted. This technique prevents unintended phase and amplitude shifts while the filter is adapting. There are no restrictions on which taps or how many taps can be defined as cursor taps. When 3D<3>=0, the FIR shadow register is not updated when RGATE is deasserted and the FIR coefficients are set to a fixed set of values at the start of every read operation. If 3D<2>=1,the FIR filter will self-adapt during a subsequent read operation. However, if 3D<2>=0, the FIR filter operates in fixed mode with a fixed set of coefficients. In Servo mode, the FIR filter only operates with a fixed set of coefficients, which are loaded from the servo shadow registers at the assertion of SGATE.

In normal self-adaptive mode, the de-interpolated estimate of the amplitude sample error and an estimate of the sample are used to calculate an equalizer error term that is used to adjust the individual tap coefficients of the FIR filter 114. When FIR self-adaptation is required in low SNR environments, FIR tap coefficients may be found by using an enhanced algorithm. Known-data is used instead of estimated data to calculate equalizer error. To enable known-data FIR adaptation, 20<3>bit is set to 1 and the data sector is written using a

known-data write. Since no user data is transferred through the NRZIO interface 122, this mode is used to only to find reliable FIR coefficients which in turn, may be used to preset the FIR equalizer during normal operation. As shown in Figure 19, FIR tap adaptation is enabled shortly after sync byte is detected. The delay, Tadp is fixed and not adjustable.

The sync-byte detector 118 (Figure 1) permits a synchronization mark as short as seven bits without sacrifice in the likelihood of correct byte synchronization. The sync-byte detector 118 is polarity sensitive. A programmable invert function is used to flip the polarity of the data entering the synchronization detector 118 and the Viterbi detector 120. The user must determine the correct polarity empirically. The polarity is selected by register 60<0>. Knowledge of signal polarity is also used to exploit a known start-state during Viterbi detection, thereby reducing the likelihood of initial Viterbi error events.

The sequence detector 120 is shown in FIG. 20. The sequence detector 120 is implemented using a 32-state EPRML Viterbi detector that uses a time varying trellis. The detector 120 includes a branch metric calculation unit 122, an Add Compare Select (ACS) unit 124, a time variance control 128, and a path memory 126. The Viterbi detector 120 uses a path memory of 68 bits to ensure that the burst error limiting properties of the modulation code are fully exploited. Amplitude and time normalized samples from the timing interpolator are used to calculate the branch-metrics 122 for the trellis. The 32-state Viterbi detector is implemented as radix-4 Add-Compare-Select (ACS) units. The ACS unit 124's output consists of decisions that are stored in the path memory 126. After all possible sequences have converged, detected data is sent to the NRZ formatter for decoding and descrambling.

Table 6 outlines the rate 32/34 code properties.

Rate	Parity	Transitions/ 1/2	Max Consec 0's	Max Burst
		codeword		Length
32/34	Even	7	17	4 bytes

Table 6 Code Properties

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Write Mode

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Figure 21 illustrates the write path. As discussed above, the Write path includes the scrambler/encoder 123, serializer/precoder 124, pre-comp 126, and PECL driver 127.

Write data received from the NRZIO interface 122 (FIG. 1) is normally scrambled in scrambler/encoder 123 to ensure a low probability of repetitive sequences. Next, the data is encoded in scrambler/encoder 123 so that all resulting sequences satisfy the Qmod2 code constraint of the rate 32/34 code. Finally, the data from the encoder 123 is precoded using precoder 124 before being sent to the precompensation circuit 126 and the PECL output driver 127. The PECL output driver 127 is designed to have low skew with a fast rise-time to accommodate Write mode speeds greater than 750 Mbit/s.

Data placed on the NRZIO interface (NRZ data) is scrambled before encoding and descrambled on readback. These functions are represented in Figure 1 by blocks 121 and 123, and are illustrated in greater detail in Figure 22. The scrambler/descrambler function may be implemented as an encoder/decoder 2200, a register 2204, a parallel/serial converter 2206, and XOR gates 2208, 2210.

Scrambling is primarily used to break up long runs of repetitive sequences. The scrambler includes a linear feedback shift register (LFSR) 2204 with suitable feedback connections. During a write operation, the output of the LFSR 2204, a pseudo-random binary sequence (PRBS), is XOR'ed with the NRZ data before encoding. During a read operation, the output from the decoder 2200 is XOR'ed with the same PRBS before being clocked out to the NRZIO pins.

The PRBS generator 2300 along with its generator polynomial is shown in Figure 23. The PRBS generated by the LFSR 2204 (Figure 22) is described by a generator polynomial $G(D) = 1 + D^4 + D^9$, where D represents a delay of one NRZ bit.

Data received from the controller is encoded using a rate 32/34 code mapping. The encoder 2200 (FIG. 22) converts 32 NRZ bits to 34 channel bits.

Upon readback, the decoder 2200 (FIG. 22) receives data from the Viterbi Detector and converts it back to NRZ data. The decoder synchronizes to the data

upon detection of the sync-byte pattern. The encoder and scrambler 123 can be bypassed during a Write mode operation by setting register 20<0> to 1. In addition, the write precoder 124 is bypassed by setting register 20<1> to 1. When both the scrambler 123 and precoder 124 are disabled, the device enters the direct Write mode. Data from the NRZIO bus is transferred directly to the precompensation circuit 126, to the PECL interface 127 and then to the read/write preamplifier. Direct Write mode only effects the write path. If a subsequent read operation is desired, the user write data must contain the preamble and sync-byte format as well as any necessary bytes appended. Interface clocking is automatically modified.

The serializer/precoder 124 is shown in Figure 24 and receives data from the encoder 123 that is used to generate an unprecompensated write current pattern. Byte-wide write data is first converted to serial data before being applied to the precoder 124. The precoder 124 performs a bit-by-bit mapping, where the delay blocks 2402, 2404 represent a delay of 1 bit-clock period each.

The precompensation circuit 126 is shown in Figure 25 and shifts the time that a write data transition occurs. This attempts to compensate for the nonlinear bit shift effect of the write process. The circuit includes a plurality of phase select units 2502a-2502d, a shift register 2504, select logic 2506, and a MUX register 2508. The circuit can select from 48 equidistant phases of write clock. The programmable range is 0-37.5% of the period of the write clock, with a delay step of .78125%. First order precompensation is selected by setting register 21 <3> to 1. Decoding logic decides how much time shift to apply to a given transition according to the rules in Table 7:

T(-2)	T(-1)	T(0) shift (% of bit period)	Level	
1st order pre	ecomp 21<3> =	= 1		
Χ	Tr	24<6:0>x.78125%	1	·
Χ	None	0		
2nd order precor	mp	21<3> = 0		
Tr	None	22<6:0>x .78125%	2	
None	Tr	24<6:0>x.78125%		
Tr	Tr	23<5:0> x .78125%	2	
None	None	0		
"Tr" indicates the	presence of a write tra	nsition		

Table 7: Write Precomp Settings

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The PECL interface 127 is illustrated in Figure 26. The PECL interface

interfaces to a preamp 2600. Fast current-switch outputs are provided to transfer write data to the read/write preamp. The logic levels are shown in Figure 27 and Table 8.

Parameter	Min.	Max.	
PECL output high voltage	1.8V	VDDP	
PECL output low voltage	1.4 V	VDDP – 0.4 V	
Tr and Tf (10 to 90%)		.25 ns	

Table 8: PECL Interface Specifications

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Servo Function

The path for Servo Mode is illustrated in Figure 28. When in Servo mode the analog signal path of the VGA 106, filter 110, and ADC 112, share the same circuitry that is used by the channel in Read mode. The analog filter 110 has separate and programmable cutoff and boost values that are enabled when SGATE is asserted. The digital servo 128 includes a correlator 2801 which outputs to a peak detector 2804 and ABS Value unit 2806. The output of the ABS Value unit 2806 is provided to a Burst Accumulator 2808 which outputs a burst value to the interface 122. The peak detector 2804 provides outputs to a preamble detector 2802 and to AM detect logic 2810 and Gray Code logic 2812; the outputs of these logic units 2810, 2812 are also provided to the interface 122.

The digital servo block 128 uses an asynchronous clock (i.e. no phase or frequency coherence to servo data) that is programmed to a sample rate of 8X, 10X, or 12X multiples of the servo synchronization frequency. The clock is generated by a dedicated PLL servo synthesizer, which is programmed to achieve the desired oversample rate.

The correlator circuit 2801 is shown in greater detail in Figure 29. The correlator 2801 is a simplified matched filter that is used to detect di-bits. This circuit suppresses DC shift, low frequency noise and second harmonic distortion such as amplitude asymmetry in MR heads. The correlator 2801 is a FIR filter producing an output of x_{k+n} - x_k where n can be programmed to 4,5 or 6 using MUX 2902 to match over-sample rates of 8X, 10X or 12X respectively. The correlator transfer function is illustrated in Figure 30.

The preamble detect block 2802 enables address mark detection when a

valid Servo preamble is detected. It contains the control logic that generates the signal, sample_AGC, which is an input to the AGC block 129/131. The preamble detect block 2802 is configured in several different modes, depending on which search mode is current. The search modes are explained in greater detail below.

Register R[*]I, is programmed with the number of consecutive di-bits that must be detected to qualify as detected preamble. Register RIi*]2, contains a bit to disable the preamble detector. Either a micro or a timer enables the preamble detector to begin the search, and the circuit waits for a peak to be detected. When a peak is found the circuit will look for the another peak to occur within a given window. The size of the window is based on the over-sample ratio. When peak is detected outside of the expected window, or if the peak isn't detected within the window at all, the detector will reset and start the process over. However when a valid peak is detected, a second counter is incremented. When this second counter is equal to the value programmed in register R[*]1, the preamble_detected signal is asserted. This signal remains active until an address mark has been detected, or until the search has been terminated.

The sample_AGC signal has three different modes of operation: it can be manually controlled with a register bit, it may be configured to auto sample after each successful preamble detection, or a normal mode that is used in oriented search mode where sample_AGC will be active after the "start search" bit is set.

The AGC block 129/131 receives the sampled value of "peak sample" from the peak detector and calculates a correction that is input to the VGA. The gain DAC in the AGC block is only updated when the signal, sample_AGC, from the preamble detect block is asserted. The AGC can also be preset prior to each servo sample by initializing the AGC_preset register R[*]3. Preset occurs on the next rising edge of SGATE. During initial searches when SGATE is always active, initializing the preset Register will generate an update of the gain DAC. If the preset register is loaded when SGATE is switching, the new value will update the GDAC on the next rising edge of SGATE.

The AGC block has a linear, and non-linear mode. Four gain bits control the gain as a function of the mode selected. Register R[*]4, an eight bit signed number is used to preset the AGC correction value. Register R[*]5 is

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programmed with the desired target AGC peak value, which is compared to the peak samples, with the difference being the AGC error. The AGC error is scaled as a function on the gain settings, then added to the previous AGC correction. The AGC correction is then formed from numerically integrated gain errors. The AGC correction input to the VGA is an eight bit unsigned number centered around 80H. The AGC_sample signal may be forced active by register control, when used for an initial search. Register R[*]6 is used to program the number of corrections to be made in normal and auto-sample modes. Examples of how the hardware and software may be used in different search modes are discussed below.

Unoriented Search Mode

Signaling for the unoriented search mode is shown in Figure 31.

- 1. Get out of the latch.
- 2. Force SGATE active using the "timerset' register in the controller.
- 3. Preset AGC gain to a high value, set AGC to non-linear mode.
- 4. The bit register R~7*]I 0 in the channel comes up reset so that the preamble detect logic is enabled on power-up.
- 5. Set Force AGC bit, register R{*]I 1, for manual mode. This allows the AGC loop to run during the entire time that the servo gate is active. Due to the use of non-linear mode AGC, the loop should acquire relatively quickly over servo data and move to only moderately higher gain over non-servo data.
- 6. Set uP Search bit, register R[*]12. This will start the preamble detector. When the preamble is detected, the address mark detect logic will be enabled.
- 7. After the address mark has been detected, clear the uP_Search bit, register R[*]12. In this mode, the search will be controlled by the microprocessor by setting and clearing this bit.
- 8. Complete the normal AMET/GRAY CODE qualification code algorithm that is currently in use. In this mode the search is still controlled by the controller, using the uP_Search bit in the system.

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After a number of address marks found, we may switch the enable_auto_sample bit, register R[*]I 3, to the Auto-sample mode setting, which clears the force-AGC bit. This will enable the logic that will generate a sample_AGC window after the preamble is detected for the number of di-bits programmed in the AGQ.sampleval register R[*]14. After the qualification is complete, switch to oriented search mode.

Unoriented Search (Auto Sample AGC) Oriented Search Mode

- Set en_amsync bit in the channel and in the controller to enable the timer controlled searches. These are two separate bits with the same name that have the same function. This assumes that the timers have all been programmed in the controller.
- 2. Clear the register R[*]20<> bit and set the register R[*]21 <> bits. Setting the register R[*]register R[*]21<> bit puts the sample AGC logic in the normal AGC mode. This enables sampleAGC for the number of di-bits programmed in the register R[*]22. This register may have to be reprogrammed if the number of sample di-bits is different than the number required in the auto-sample mode. In this mode, the sampleAGC window will start after the start search (spincomm) timer goes active.

Head Switch (option 1)

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- 1. Switch heads. This occurs between servo bursts.
- 2. Preset AGC to high gain in the channel, non-linear AGC with high gain. The logic will remain in normal AGC mode.
- 3. Increase the AGQsample_val in the channel to allowing more time to acquire. (What would be the maximum required number of di-bits?)
- 4. Reprogram SGATE and spincomm timers to allow the use of more preamble. (Write to read recovery area.)
- 5. After first address mark, reprogram timers and AGCsample_val back to normal values. Set the AGC back to linear mode and normal gain.

Head Switch (option 2: worst case scenario)

- 1. Switch headsE
- 2. Force SGATE active using the timerset register in the controller.
- 3. Preset AGC to high gain, non-linear AGC. Set AGC in non-linear mode, same as unoriented search.
- 4. Set Force_AGC bit in channel. Controller timers will still be in oriented search mode, wider window.
- 5. Wait for AMDET to interrupt to the uP, then clear the Force_AGC bit in the channel. Normal AGC operation will continue from this point.

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The peak detector 2804 (FIG. 28) derives a signal, peak_samples, that is used for the AGC. Other peak detector outputs are; peak found and threshold crossed. The input to the peak detector is sample and sample minusl signals from the correlator 2801. The peak detector 2804 only detects positive peaks. The incoming samples are compared to a programmable threshold, and when either a positive or negative sample crosses the threshold, the threshold crossed output will be set. This signal remains set until the peak is found. The peak is found using the following algorithm: Wait until threshold crossed is true. Then wait until the current sample is less than the previous sample, sample minus 1, indicating that the peak has been reached. Next, there are two sample pairing conditions to be considered. If the sample_minusl is less than the sampleminus2, then the peak occurred at sample minus 2, or if the sample is less than the sample_minus 1,then the peak occurred at sample minus 1. When the peak sample is found, the peak_found signal is asserted, and at the threshold crossed signal is cleared. The peak found signal will remain active for one sample clock period.

There is an input to the peak detector, sample AGC, which is output from the preamble detector 2802. When this signal is asserted, the value of each detected peak will be registered on the peak sample output, one sample clock after the peakjound signal is asserted. This is the value used by the AGC block to generate a gain correction.

The Address Mark Detect circuit 2810 (Figure 28) is designed around a

programmable address mark of nine bits. The address mark is defined by programming 9 bits composed of registers R[*] and R[*]. Table 7 illustrates the address mark format. In this example a written pattern of 8 zero's, followed by a di-bit is represented.

8	7	6	5	4	3	2	1	0
R[*]<0>	R[*]<7>	R[*]<6>	R[*]<5>	R[*]<4>	R[*]<3>	R[*]<2>	R[*]<1>	R[*]<0>
0	0	0	0	0	0	0	0	1

Table 9 Servo Address Mark Format

The address mark detector 2810 also contains a voting circuit that can be enabled to allow a finite number of errors to occur within the address mark. The number of allowed errors is programmed in register bits RE*]18. After a servo event, it is possible to poll register bits R[*11 9 to determine how many errors were made in the previous servo event, as shown in Table 10:

	R[*]	Number of	R[*]	Actual	Errors
		Allowed Errors		Detected	
15	00	0	Bit 7	0	Errors
	01	1	Bit 6	1	Error
	10	2	Bit 5	2	Errors
	11	N/A			

Table 10 Servo Mark Detection Settings

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Figure 34 shows a 10 MHz servo waveform with the address mark and the correct polarity for the address mark dibit.

The Gray code detector 2812 has four functions: to detect the Gray code bits, to generate a Gray clock, to store the Gray code data in a shift register and to generate the grayendb signal. The gray decode block 2812 is clocked by a counter (grayent) that increments on each falling edge of the sample count. This counter is held preset when AMDET is low and is reset at the end of each di-bit cell/window. The preset value can be programmed in the grayendval register Ril*], and is adjusted based on the oversample ratio. The reset value is determined based on the sample rate selected. Once the address mark is detected, the Gray code detector 2812 is enabled, and the timing of the detector is (becomes) relative to the peak of the address mark di-bit. The AMDET signal

has a resolution of +1-1 half rate clock, which is 1/2 the oversample frequency.

The Gray data flip-flop is set any time that a peak is detected and is reset at the start of every di-bit window (when grayjrcnt=0). The Gray clock is generated 1/2 sample clock prior to the end of the cell. The Gray clock is used to shift the data into the Gray code shift register. It no address mark is detected, the shift register will contain the data from the last burst.

The grayendb signal determines how many Gray codes are to be shifted in. This value is programmable with the gray.endval register, which is compared to a counter that determines the number of gray clocks that have occurred.

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Example:

Sample rate=12x~6 clocks per di-bit

Graypreset=2

Graycnt=0-5

15 Graycnt=0=reset gray data FF

Graycnt=5~gray clock

The Reset AMDET timer runs off of the reference clock and the counter is reset with a synchronized AMDET signal. It can be programmed with a 12-bit value for the time the AMDET signal is reset. The rst_amb signal resets AMDET, and also resets or re-enables several other functions within the digital servo block.

Time desired in ns is R[*]30<> x TFREF Note: The resolution is +/~1 TFREF due to the synchronization of the AMDET signal, which resets the counter.

The Demod block 2808 calculates the values for the A,B,C, and C position bursts. This function accumulates the magnitude of all of the samples in the accumulation window to measure the area of a burst. The strobe signal from the controller enables a counter (not shown) clocked by the sample clock. The counter is used as a 2-edge timer that opens a window to enable the accumulator. Two 6-bit registers control the timer, called start_accum and stop accum. When the window is open, the accumulator sums the absolute value of

the output samples of the correlator. There are four separate adders, 2 pairs that are interleaved, one that sums the two samples and one that accumulates the output of the first adder. When the en_accum signal goes inactive, an additional adder sums the output of the two interleaved accumulators. There is additional clock delay that will have to be considered when centering the windows around the bursts. The peakjound and en_accum signals come out on a test pin and should be useful in centering the sample windows.

From the rising edge of the strobe signal, the en_accum signal goes active after the number of clocks programmed in register R[*]40. When programming the start register, one needs to account for the preload required by the correlator of half of a di-bit. The value programmed in the stop.accum register should allow the signal en_accum, to go inactive 2-3 clocks prior to the falling edge of strobe. This will allow time for the final addition and setup of the output latch. The accumulator is cleared 2 to 3 sample clocks after the falling edge of the strobe. The clear signal to the accumulator is deasserted 2 sample clocks later. This means that the strobe is deasserted a minimum of 5 sample clocks.

The Data Transfer block 122 controls the NRZIO bus during a servo burst. The servo controller is clocked by the negative edge of RCLK. When the servo address mark is detected, the NRZIO interface receives data from the servo. In this state, data is set to all zeros. The servo controller is controlled by a synchronized version of the strobe signal (synchronized to RCLK). The servo controller waits for the first transition (rising edge) of the strobe signal A_burst. On the next falling edge of RCLK after the rising edge of the strobe the NRZIO output is a sync byte, followed by the 3 bytes of Gray code, followed by all zeros again. The sync byte out will be the same sync byte that is used by the channel. All data will be clocked out on the falling edge of RCLK. On the falling edge of the first strobe, the channel will output a sync byte, followed by the two bytes of data. This will be repeated for the B,O and C. The data transfer after the D burst will have 1 additional byte that will be a status byte from the channel.

Note that the inactive time between strobe pulses must be at least 1 RCLK cycle to ensure proper operation of the data transfer. RCLK is a divided down version of the read synthesizer and is "gapped" to account for the channel code rate. So

for a 1 6/17 rate channel, RCLK has three spacings of 8T, followed by one spacing of 9T. The worst case RCLK spacing is: 1/(channel rate) *9 where the channel rate is 17/16 * NRZ Pate.

5 Common Functions

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Several functional blocks are shared by the read, write, and servo sections of the channel. These are the NRZ interface 122, the R/W PLL 138, the Servo PLL 140, and the serial interface 142.

The R/W interface 122 provides a read clock RCLK, receives a write clock WCLK, and reads and writes data on a byte wide NRZIO interface. NRZI read interface timing is shown in Figure 35. NRZI write timing is shown in Figure 36. While the figures show byte-wide data being clocked to and from the channel on the rising edge of the clock, the polarity of the RCLK and WCLK signals may be altered by programming registers 20<4> and 20<5>, so that data may be clocked on either edge. Interface timing rules are defined in Table 11:

Parameter	Sim.	Condition	Min.	Max.	Units	
RCLK, NRZIO rise/fail time	Tr & tf	20-pF output load, 10-90%		3.7	Ns	
RCLK to NRZIO delay	Тр	Falling edge of RCLK to NRZ out		3.5	ns	
NRZIO setup time	Tsu	NRZ data valid to rising edge of WCLK	3		Ns	
NRZIO hold time	tn	Rising edge of WCLK to NRZ data invalid	2		Ns	
RCLK high	Thr	Period RCLK is high	4	5	15/16 bit period	
RCLK low time	Tlr	Period RCLK is low	4	6	15/16 bit period	
WCLK high time	Thw	Period WCLK is high	4	5	Bit period	
WCLK low time	Tlw	Period WCLK is low	4	5	Bit period	
RCLK and WCLK periodicity		(8+9+8+9+8+9) 51 PLL clock e	dges	A.E.O.	•	
Direct Write mode WCLK periodicity		(8+8+8+8+8) = 48 PLL clock edges				

Table 11: NRZIO Interface Timing.

A one-period ambiguity exists in RCLK high and low times. This constraint is reflected in the clock times listed in Table 11.

The PLL synthesizer 134 uses a single phase locked loop 138 to

synthesize Read mode and Write mode (R/W) clock signals. A second PLL 140 is used to synthesize Servo mode clock signals. Both PLL designs are identical,

with the exception of a 16/15 frequency translation function that is added to the R/W PLL 138. The designs have been optimized for high bandwidth, fast lock-on operation and extremely low jitter output.

A block diagram of the R/W PLL synthesizer block 138 is shown in Figure 37, and the specifications follow in Table 14. The PLL output frequency is determined by Equation 2:

 $RWFREQ = NREF \times (N-P/16)/(2 \times (M+1))$ Eq. 2 The N and P values should be chosen such that: $700 \text{ MHz} <= FREF \times (N-P/8) <= 1600 \text{ MHz}$

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As shown, the synthesizer block 138 includes a phase detector 3702, a charge pump 3704, loop filter 3706, VCO 3708, frequency translation circuit 3710, divider 3712, and feedback divider 3714. The input FREF is an external reference input frequency, and N, P and M are integers. The output bit-rate frequency is programmed by loading the 91<5:0>, the 90<7:4> and the 90<2:0>registers.

The operation of the P/W PLL 138 is as follows: The VCO output frequency, Fvco, which is in the range of 800-1 600 MHz, is divided by the fractional divider 3714 of factor (N - P/16), and then phase-compared to an input reference frequency FREF, by phase detector 3702. Use of the fractional divider 3714 allows the phase detector 3702 to sample the phase error at a high rate, providing faster lock-on times with lower VCO phase jitter. The PLL P/W clock output is obtained by dividing Fvco by 2(M +1) using digital divider 3812. The user sets the R/W clock frequency to be the same as the desired encoded bitrate. When the PLL provides the Read mode clock, a 1 6/1 5 frequency translation circuit 3710 is automatically inserted in the clock path to increase the clock rate by 6.66% (the bit-rate is unchanged). This provides an oversampled clock for use by the interpolated timing recovery (ITR) circuitry 116 (Figure 1).

A block diagram of the Servo PLL synthesizer block 140 is shown in Figure 38, and the specifications follow in Table 12. The Servo PLL 140 is similar to the R/W PLL 138 in form and operation. A separate and complete set of registers are used to program the Servo PLL 140. The PLL output frequency is

determined by Equation 3:

Servo FREQ = FREF x (Ns - Ps/16)/(Ms+1) The Ns and Ps values should be chosen such that: 700 MHz <= FREF x (Ns - Ps/8) <= 1600 MHz

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As shown, the synthesizer block 140 includes a phase detector 3802, a charge pump 3804, loop filter 3806, VCO 3808, divider 3812, and feedback divider 3814. The Servo output frequency is programmed by loading; the 91<5:0>, 90<7:4> and 90<2:0> registers. When a non standard FREF frequency is employed then Equation 3 is used to find Ps M_5 , and Lp_5 values, subject to constraints of Equation 3.

Parameter	Symbol	Min	Max	Register(s)	Notes	
Reference Frequency	FREF	20 MHz	80 MHz	98<7:4>	in steps of 5Mhz	
VCO Frequency	Fvco	800 MHz	1600 MHz			
Write or servo clock		53.125 MHz	800 MHz			
Settling Time			10 usec			
Absolute jitter			15 psec		1 sigma	
Register settings – Read Mode/Write Mode						
N divide value	N	12	48	N= 91<5:0>		
P divide value	Р	0	15	P= 90<7:4>		
M divide value	M	0	7	M= 90<2:0>		
Register settings – servo mode						
Ns divide value	Ns	12	48	Ns= 93<5:0>		
Ps divide value	Ps	0	15	Ps= 92<7:4>		
Ms divide value	Ms	0	7	Ms= 92<2:0>		

Table 12: Clock Synthesizer Specifications

The serial interface 142 allows communication between the controller and the internal control registers of the device. Any given internal control register may be read-only (R), write-only (W) or both read and write (RW). The serial interface 142 communicates by three control pins, SDEN, SDATA and SCLK, by using the transfer protocol shown in Figure 39 with port timing rules specified in Table 13.

Parameter	Min	Max
t _{d1}	5 ns	
t _{d2}	5 ns	
t _{hd}	10 ns	

Table 13 Serial Port Timing Specification

The interface controller arbitrates the transfer and is always responsible

for setting the direction of the transfer, for generating the address bits and for generating the clock. The transfer protocol is structured as an 18-bit word. The first bit is used to indicate a write-to or read-from the device. The next eight bits function as address bits, with the LSB sent first. A dummy "turn-around" bit is added in the middle of the bit stream to allow time for a direction change on the bust Eight data bits follow either to or from the device, depending on the direction of the transfer.

During a register write operation, SDEN is asserted and serial data on the S DATA pin is clocked to the device on the positive edge of SCLK. After the 1 8-bit sequence is complete, byte-wide data is transferred to the selected device control register on the negative edge of SDEN.

During a register read operation, the bus direction and the address are clocked into the device on the positive edge of SCLK. After the turn-around bit, the device assumes control of the S DATA line and places the contents of the requested register, LSB first, to SDATA on the falling edge of SCLK.

System Operation

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Operation of the Read, Write, and Direct Write modes follows and, in particular, on exemplary timing relationships that are in effect when transitioning from one mode to another.

Read Mode Sequence

Exemplary read mode sector architecture is shown in Figure 40. Shown are the RGATE waveform 4002, the Read Signal 4004, the MTP wave form 4005, and the NRZIO wave form 4007.

The Read Signal 4004 includes a preamble 4006, sync byte 4008, and user data 4010. The preamble 4006 is implemented as a series of 2T-spaced transitions, with T being the encoded bit period. The preamble readback pattern input to the ADC 112 is a sine wave of frequency 1/4T. In one implementation, the system has a preamble length of 96 bits, although shorter and longer preamble lengths may be used. If the preamble field 4006 is less than 80 bits, the timing and gain synchronization may become unreliable. The preamble field

4006 is a known reference pattern that is used to set up timing, gain and DC-restore loops. Because the preamble is a single frequency, it cannot be used as a reference to adjust the self adaptive FIR equalizer.

A sector read operation begins with the assertion of RGATE 4002. The timing loop cycle occurs in three phases, dividing the preamble 4006 into distinct regions: zero-phase restart 4012, fast-acquire 4014, and data tracking 4016. During the first phase, zero-phase restart 4012, the initial phase of the timing loop is adjusted. The second phase, fast-acquire 4014, is primarily used for frequency acquisition. After the first and second phases, the timing loop phase-frequency is close to the target phase-frequency value and within the capture range of the third and final phase, data-tracking 4016. During tracking 4016, the timing loop response is adjusted to be slow responding, requiring many averaged data samples to generate significant clock timing adjustments. Tracking mode 4016 is used for accurate and jitter-free data clock regeneration when reading user data. The AGC loop (Figure 9) operates throughout all three timing phases. However, the loop gain of the AGC is increased during the zero-phase restart and fastacquire phases so that channel gain is close to the correct value before entering tracking mode. The AGC tracking phase adjusts the gain very slowly throughout the user data and requires an average of many samples to significantly change the gain setting.

Programmable counters (not shown) are used to define the time intervals for each phase of the acquire sequence 4014. Acquisition timing periods may be adjusted for preamble lengths up to 500 bits by programming the counter-timers described in Figure 41. The range of values allowed for each counter is specified in Table 14.

Delay	Description	Range	Register	Default
Tadp	FIR self adapt	Fixed		
Tacq	Timing and dc fast acquire	0-127 nibbles	09<6:0>	
Tagc	AGC acquire	0-127 nibbles	0A<6:0>	

Table 14: Counter Values

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A sector read operation begins with the assertion of RGATE 4002 (FIG. 40). The system cycles through the loop acquire sequence described above. After the sequence is completed, timing and gain control loops have converged and the tracking mode 4016 is entered. The device begins detecting data and

searches for a unique sync-byte pattern 4008 in the bit-stream. The sync-byte 4008 is a special pattern used as a marker to indicate the start of user data. Once the sync-byte 4008 has been detected, an FFh byte is output on the NRZIO bus. Subsequent detected and decoded user data bytes continue as output for as long as RGATE 4002 is asserted.

Approximately 16 bytes of read data latency are associated with a read operation as shown in Figure 40 and Figure 42. As a consequence, when RGATE 4002 is de-asserted at the end of a sector 4203, 16 bytes of data are left to be transferred to the controller. This residual data can be transferred using one of two methods, as selected by register 04<0>. The first method is for the controller to assert RGATE 4002 after the physical end of sector data, until the entire sector has been transferred. This is adequate provided the end of sector gap 4206 is greater than 16 bytes.

Using the second method, RGATE 4002 is de-asserted at the end of the sector. The device internally extends RGATE 4002 to flush out the residual data that is in the data path. When reading consecutive sectors, the combined length of the sector gap, the preamble length, and the sync mark must be longer than the 15 byte read latency, and the controller must be able to accept NRZ data even after RGATE has been de-asserted.

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Write Mode Sequences

Data may be transferred from the controller to the NRZIO interface 122 (FIG. 1), through the system to the write preamp by two basic methods, called Normal and Direct modes. Both methods have selectable options that modify how write data is processed.

Normal Write Mode

The timing of a Normal Write mode operation is shown in Figure 43. Shown are a WGATE waveform 4300, an NRZIO waveform 4302, and a Write Data waveform 4304. A normal Write mode operation is initiated when WGATE 4300 is asserted. A series of 00h bytes 4303 (Figure 43) are sent from the controller to the device on the NRZIO interface 122 (FIG. 1). The encoder 123 output is a series of 2T-spaced transitions that generate the preamble 4306. The

preamble 4306 is continued for as long as 00h bytes are sent to the interface 122. When an FFh byte 4305 appears on the NRZIO interface 122, write logic output is a sync-byte 4308 in place of the FFh, followed by encoded user data 4307 lasting the duration of WGATE assertion. Write data is subsequently precompensated and transferred to the PECL output stage 127. In the implementation illustrated, the Write path latency is 9 bytes. Data may be clocked to the device on the NRZIO interface 122 on either the rising or falling edge of RCLK depending on the setting of register 20<4> 1.

Direct Write Mode

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The write sequence for a direct Write mode operation is shown in Figure 44. Shown are a WGATE waveform 4400, an NRZIO waveform 4402, and a Write Data waveform 4404. In operation, in a manner analogous tothe normal Write mode, WGATE 4400 is asserted; however, the encoder and scrambler 123 are bypassed by setting register 20<1 >=1 and the write precoder124 is bypassed by setting register 20<1 >=1. NRZIO data is serialized, precompensated and then transferred directly to the PECL output 127 without modification. The controller sends a sequence of 00h bytes, followed by one FFh byte 4403. This is followed by the continuation of user data 4405 for as long as WGATE is asserted; the FFh byte is not transferred. If a Read mode operation is desired after a Direct Write mode, the write data placed on the NRZIO interface 122 must contain the preamble, sync-byte, encoded data and any necessary ECC bytes.

System Timing

A system timing diagram is shown in Figure 45. Timing rules are listed in Table 15:

Parameter	Min Time	Description
T _{s/r}	24 Read mode PLL Clocks	Servo to read
T _{r/s}	24 Read mode PLL Clocks	Read to servo
T _{s/w}	24 Read mode PLL Clocks	Servo to write
T _{w/s}	24 Read mode PLL Clocks	Write to servo
T _{w/s}	24 Read mode PLL Clocks	Servo mode to write mode/servo mode
T _{s/w}	24 Read mode PLL Clocks	Write mode/servo mode to idel mode
T _{w/w}	24 Read mode PLL Clocks	Write mode to write mode
T _{r/r}	24 Read mode PLL Clocks	Read mode to read mode
T _{s/d}	500 ns	Suspend mode to doze mode
T _{d/I}	100 us	Doze mode to idle mode

T _{i/s}	24 Read mode PLL Clocks	Idle mode to servo mode
T _{s/I}	24 Read mode PLL Clocks	Servo mode to idle mode
$T_{r/i}$	24 Read mode PLL Clocks	Read mode to idle mode

Table 15: Timing Rules

Write Mode to Idle Mode Recovery

The timing diagram of the recovery sequence appears in Figure 45. In particular, shown are a WGATE waveform 4600, a HiZ waveform 4602, and a LoZ waveform 4604. When WGATE 4600 is asserted, the series switches 202, 208 (Figure 2), which are connected between the VGA input pins and the VGA circuit, are set to an open or high impedance (HiZ) state. The high impedance state prevents write voltage transients from entering the VGA 106 (Figure 1) and overloading the analog signal path. The HiZ condition is maintained for the duration of WGATE and is extended past the de-assertion of WGATE for a programmable length of time, Thr, set in a register. In addition, a shunt resistance 210 connected in parallel with the VGA inputs, is set to a low impedance value (LoZ) during WGATE. The LoZ period starts 50 ns before the end of HiZ and extends for a period of time, TLR, set in a register.

Parameter	Description	Time/Resistance 50 ns x R,[TBD]	
Thr	Time VGA input-open is active after WGATE		
Tlr	Time VGA input-LoZ active after (Thr -50 ns)	50 ns x R,[TBD]	
	Select 200, 400,1K or 2K Ohms for shunt LoZ	R	

15 Table 16

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Channel Quality Monitor (CQM)

The functions shown in Figures 47a and 47b may be used to collect statistical data on the overall performance of the magnetic recording channel. The active measurement function is selected by the FUNSEL register, 70<2:0>, as defined by Table 17:

FUNSEL register 70<2:0>	Function
0000	MSE1, squared error of received sample minus estimated sample (slicer)
0001	MSE2, squared error of received samples minus known sample (known data mode)
0010	MSE3, squared error of selected parameter
0011	SAT, surface analysis testing

0100	Histogram 1, referenced to estimated samples (slicer)
0101	Histogram 2
0110	Histogram 3
0111	Error rate
1000	Di-bit extraction

Table 17: Channel Quality FUnctions

The parameter to be measured is selected by the MONSEL register, 70<6:3>. Taken together, the values of the FUNSEL and MONSEL registers define a CQM test. The combination of function and parameter that are supported are shown by an "X" in Table 18:

Test Register	FUNSE	L Regist	er 70<2:0)>		****			
MONSEL	MSE	MSE	MSE	SAT	HIST	HIST	HIST	Error	Di-
70<6:3>	1	2	3	0011	1	2	3	0111	bit
	0000	0001	0010		0100	0101	0110		1000
0000 ITR Data	Χ	X		X	X	Χ			X
0001 Gain Error			X				X		
0010 Timing Error			X				X		
0011 DC Restore			X				X		
0100 MR Asym.			X				X		
Error									
0101 FIR Adt.			X				X		
Error		Į.							
0110 Sector Errors								Х	
1									
0111 Sector Errors								X	
2									
1000 VA bit error								X	
1001 Slicer error								X	
1010 ECC BER								X	

Tale 18: Quality Monitor Test Matrix

CQM measurements are controlled by a finite state machine (FSM) that manages the selected test. The FSM state diagram is described in Figure 48, allowed state transitions are listed in Table 19 and state variables are specified in Table

10 18.

Event	Trigger			
Trigger	Interface sets 68<5>=1. Enables and resets the state machine.			
Start	(on sync0byte found if (68<4>=1)) otherwise on RGATE assertion			
P Complete	P count is complete setting 68<3>=1			
RGATE before P	RGATE ends before P setting 68<0>=1, an error indicator			
Span sectors	RGATE ends before Q and sector span is enabled, 68<1>=1			
M Done	On (RGATE if 68<1>=0) otherwise on (Q count complete which also sets 68<2>=1)			

Table 19: CQM Measurement

REG Variable	Definition	٦
Variable		١
		_

68<7>	Trigger and reset
68<4>	Start on sync byte found enable
68<3>	P and count indicator
68<2>	Q end count indicator
68<1>	Enable sector span
68<0>	Error flag
69<7:0>	P and count value – Specific WAIT time (16 bit units)
6A<7:0>	12 bit Q end count value – MEASURE sample (in multiples of 16 bits)
6B<3:0>	
6B<7:4>	12 bit Q counter value – number of measurements accumulator (in multiples of
6C<7:0>	16 bits)
72<7:0>	Top 16 bits of CQM 20 bit measurement accumulator (measurement)
71<7:0>	
6D<5:0>	T _H , high threshold
6E<5:0>	T _L , low threshold
6F<7:0>	T _E , Error squared threshold
6D<7>	Sector error type

Table 20: CQM Variables

Single sector operation is described in Figure 49. The measurement sequence is initiated when register 68<5> is set to 1. This event resets the state indicators and the P,Q and M counters. The FSM advances to the WAIT state where it waits for an RGATE assertion or a sync-byte-found signal depending on 68<4>. When the selected condition occurs, the FSM advances to the PAUSE state where a delay timer, F, counts P bits before transitioning to the MEASURE state. As a precautionary check, if the FSM is in the PAUSE state when RGATE is de-asserted, an error flag, register 68<0>, is set to 1 and the FSM returns to Idle mode.

While in the MEASURE state, data collection is enabled and parametric test data is accumulated in a 20-bit-wide register, called the M accumulator. Only the top 16 bits of the register are accessible through the serial port. An overflow condition is indicated by all the bits in the register being set to 1. A unit counter, or C counter, is enabled to keep track of the number of measurements processed. The Q counter and the M accumulator are active until the end count, in registers 6A <7:0> and 60<7:0>, is reached or RGATE is de-asserted Normally, measurement data accumulates until the end of sector, signalled by the end of RGATE. However, if 68<1> = 1, data will accumulate until the end count of the Q counter, 6A<7:0> and 60<7:0>. The FSM returns to Idle mode, and the measurement value, contained in the M accumulator, and the number of measurements made contained in the C counter, may be retrieved through the serial interface.

Multiple sector operation is described in Figure 50. If 68<1>=1 and if the end count is not attained when RGATE is deasserted, the FSM returns to the WAIT state and will continue to collect more data on the next sector or sectors. When the Q counter end count is reached, and the required number of measurements have been made, the FSM sets indicator 68<1> to "1", and returns to the Idle mode state. With this method, the measurement may span multiple sectors.

Mean Squared Error

MSE1, MSE2 and MSE3 tests measure squared error. It is left to the user to calculate the real mean squared error by dividing the measured squared error by the number of measurements made, the value that is accumulated in the M counter.

For the MSE1 test, the error is calculated as the difference of the received sample output from the !TR and the estimated noiseless sample value. In the MSE2 test, the error is calculated as the difference in the received sample output from the ITR and a calculated sample derived from an onboard linear feedback shift register (LFSR). The MSE 3 test is used to measure the standard deviation of loop error signals.

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Error Rate Tests

The M counter can be used to accumulate errors by using an number of different measures. When an error rate measurement is selected, the C counter increments on sectors read, i.e. on RGATE deassertion. After Q sectors have been tested, the state machine transitions to the Idle mode state. Assuming 512 byte sectors, 268 million bits may be tested before the counter overflows. This allows measuring error rates to 1 errors per bit.

Sector Error Rate (Zero-Pattern Method)

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An all 00h byte data pattern is sent to the scrambler and encoder during Write mode. The 00h byte pattern is scrambled before being encoded and written to the disk. Upon readback, the detector, decoder and descrambler invert the

process to reconstruct the 00h byte pattern. Errors are detected by the occurrence of non-O0~ bytes. The error accumulator counts sector errors using two different criteria:

- —A sector with 1 or more bytes in error, counted as 1 sector in error, 6D.zz7> = 0.
- A sector with 5 or more bytes in error, counted as 1 sector in error,
 6D_7> = 1.

Statistically, for channel error rates less than 1 0~ errors/bit, most sectors in error will contain only a single error event. However, that one error event may corrupt several bytes. When a single error event causes mis-synchronization, hundreds of bytes in error may be generated. Measure (1) will count either outcome as one error. Measure (2) will count only sectors with long bursts of errors, which are probably not EGG correctable. In order to test large numbers of bits, the 0CM state machine parameter should be set to span multiple sectors.

Slicer Bit Error Rate

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The output of the slicer circuit is compared to known data generated by a linear feedback shift register. For correct comparisons sector data must be written using the known-dataJ Write mode. Bit-wise miscompares are accumulated in the M counter. In order to test large numbers of bits, the CQM state machine parameter should be set to span multiple 71 sectors.

Viterbi (VA) Bit Error Rate

The output of the Viterbi detector is compared to known data generated by a linear feedback shift register. For correct comparisons sector data must be written using theknown-data Write mode. Bit-wise miscompares are accumulated in the M counter. In order to test large numbers of bits, the 0CM state machine parameter should be set to span multiple sectors.

Bit Error Rate with ECC

Sector data is written using the "zero pattern' method as outlined in the sector error rate test. Byte output from the decoder is de-interleaved into four

byte interleave sequences. One of the four interleave sequences is selected to be byte-wise compared to a zero byte. Byte miscompares are accumulated in the M counter. In order to test large numbers of bits, the 0CM state machine parameter should be set to span multiple sectors.

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Di-bit Measurement

The di-bit extraction test deconvolves a pseudo-random binary readback sequence that has been written previously to a sector as data. The measurement evaluates one sector to determine one value of the di-bit function. Subsequent values are obtained by shifting the phase of the pseudo-random binary sequence (PRBS) that is used to generate known-data in the deconvolution equation. Data must be written using known-data Write mode. That is, 20<3> bit set to 1. When a normal Write cycle is executed, the device output is a repeating PRES data pattern that takes the place of normal encoded write data. ~Write data input to the NRZIO interface from the controller is ignored. The synchronization field and sync-byte are output just as in a normal write, although a repeating PRBS is substituted for data.

On readback, the 127 bit PRBS is derived from a linear feedback shift register (LFSR) that performs the polynomial recursion, xn+8 = (Xri 7+Xn+3+l)mod2• In this extraction algorithm, the phase of the PRBS determines the time variable of the extracted di-bit function. In order to obtain all 127 values of the extracted di-bit the phase of the PRBS is incremented by changing the starting value, the seed of the LFSR contained in 73<6:0>.

For the most accurate result, measurement data should be accumulated over multiples of 127 amplitude (ITR) samples. Since the C counter increments in multiples of 16 bits a recommended ending value for Q is 127, which is 16 x 127 = 2032 bits

SNR Margining Tests

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Three different methods for SNR margin testing are supported in the S0A8700 device; additive white noise, off-track interference emulation and noise multiplication.

Additive White Noise Test

A white noise generator circuit can be used to add noise to the readback signal at the input of the CTF, output of the VGA. This effectively lowers channel SNR and increases bit error rate. When enough noise is added so that the error rate is between 10⁻⁶ to 10⁻⁷ (errors/bit) the error rate becomes a sensitive indicator of the effect of channel parameter settings. Pre-comp, head current, equalizer settings, etc. may then be more easily adjusted to find optimal settings. Injected noise is "white", while preamp noise may be "colored", and as a result the channel parameter settings found using this method may be only close to optimal. Because injected noise is added after the VGA, the effective SNR obtained will be relatively independent of the signal level input of the VGA, and will be repeatable to the extent that the CTF and FIR transfer functions are constant. The amplitude of the injected noise, which has a 300 MHz noise bandwidth is varied by register R,[TBD]. This can produce effective SNR's of 15dB to 25dB. SNR herein is defined as the isolated pulse peak voltage divided by RMS noise voltage.

Off-Track Interference Emulator

The input to the Viterbi detector prefilter can be artificially corrupted by adding a scaled output from a linear feedback shift register (LFSR). The amplitude of the LFSR can be varied by register 75<7:0>. The frequency content of the LFSR signal is designed to match the spectrum of off-track interference experienced by the channel during off-track stress testing (OTO).

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Noise Multiplier Test

This test assumes known data, so a known-data write must be used to set up test data sectors. The known-data pattern used, a repeating PRBS, is modified to satisfy the parity constraint of the Viterbi detector by setting register 73<7> to 1.

The error signal at the input to the Viterbi detector prefilter is measured by comparing input amplitude samples to the known-data pattern. The derived error

signal is multiplied by a scaling factor and then added back to the known signal. This uniformly multiplies all noises and distortions by the scaling factor, creating a uniform degradation of the effective detector SNR. The amplitude of the noise multiplication error is adjusted by register 75<7:0>.

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Arbitrary Waveform Injection

The ViewDac circuit 5100 (Figure 52) can be used to generate arbitrary waveforms that may be used to simulate analog input signals. These waveforms can be injected at various nodes in the analog signal path as illustrated in Figure 51. A 32-word cyclic random access memory (RAM) 5102 is first loaded with waveform sample values via the serial interface. The clocked output samples are input to the viewdac (Vdac) 5100 where they are converted to analog values. As shown in Figure 51, the output of the viewdac can be connected to various inputs in the analog signal path as selected by register AB<2:0>. The cyclic RAM 5102 is clocked from either the P/W PLL or Servo PLL depending on the setting of AB<3>. Normally, in this mode the input signal from the preamp, VIN(P,N) is disconnected from the VGA by setting AB<4> to 1.

The analog signal injection function may be used to simulate typical sinusoidal input waveforms that can be used with the CQM, to measure and calibrate the frequency transfer function of the VGA 106 and CTF 119.

View DAC

The system according to an implementation of the present invention allows real time viewing of digital signals in the analog domain by using a high speed, 7-bit View DAC. The View DAC 5100 is shown in Figure 52, and operating modes are specified in Table 21 and Table 22. The view DAC circuit includes an input multiplexer 5202, clock multiplexer 5204, and View DAC 5206.

Register B0<2:0> controls the selection of internal signals which are routed to the View DAC. The selected data can then be brought off-chip at reduced or full speed depending upon the setting of B0<7:3>. The actual divisor will be the value of B0.<7:3>±1. For example, if the setting in this field is 000, then the data is divided by 1, and by 8 if the setting is 111.

B0<2:0>	Description		
---------	-------------	--	--

000	Selects a value of 0 into the View DAC input
001	Selects the output from the ADC
010	Selects the output from the FIR
011	Selects the output from the ITR
100	Selects the output from the Viterbi
101	Selects the output from a 128-byte RAM
110	Selects the output from a user loaded serial port register

Table 20: View DAC Input Select

B0<7:3>	Description
000	View DAC output is every clock period
001	View DAC output is every 2nd clock period
111	View DAC output is every 8th clock period

Table 22: View DAC Decimation

5 Analog Test Port

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A differential analog test port may be used to monitor and inject analog signals along the signal path of the front end of the system. VGA input pins VIN_P and VIN_N are multiplexed to input ports along the signal path. ASIG_P and ASIGN pins are switched to the selected output along the signal path as shown in Figure 53. Table 23 specifies the value of register AA<7:0> needed to connect a selected signal to the ASIG output pins.

AA<7:0>	Output Selected
00000000	No connect to Aout normal op.
00000001	Connects pins ASIG_P/ASIG_N to output test bus
00000010	VGA output
00000100	Asymmetry correction output
00001000	1 st biquad output
00010000	CTF output
00100000	8 dB buffer output
01000000	S/H output

Table 23: Analog Test Port

Multiplexed Test Pin (MTP)

A single MTP is used to connect to internal test signals. The function of the MTP is controlled by register BA<2:0>. Table 24 lists available signals

BA<2:0>	2:0> RGATE WGATE SERV		SERVO	MTP	Description	
000	Χ	X	X	NSYNC	Not sync byte found	
001	Χ	Χ	X	WRITE ERROR	WRITE error	
010	X	X	X	GRAY DATA	Grav decode output	

011	X	X	Х	PLLR LOCKED	Read PLL locked			
100	X	X	X X PLLS_LOCKED Servo PLL lock X X WRP_INVALID WRP invalid/W X X FIR_SATURATION FIR tap out of r 0 0 NSYNC Not sync byte f 1 X WRITE_ERROR WRITE error		Servo PLL locked			
101	X	Х	Х	WRP INVALID	WRP invalid/WRP error			
110	X	Х	Х	FIR SATURATION				
111	Х	0	0	PLLS_LOCKED Servo PLL locked WRP_INVALID WRP invalid/WRP error FIR_SATURATION FIR tap out of range NSYNC Not sync byte found WRITE_ERROR WRITE error				
111	0	1	Х	WRITE_ERROR	WRITE error			
111	0	0	1	GRAY_DATA	GRAY decode output			

Table 24: Multiplexed Test Pin

The invention described in the above detailed description is not intended to be limited to the specific form set forth herein, but is intended to cover such alternatives, modifications and equivalents as can reasonably be included within the spirit and scope of the appended claims.

APPENDIX

A copy of the provisional application specification follows.

CLAIMS

We claim:

1	1.	A read/write channel circuit, comprising:
2	a read	d path including:
3		a thermal asperity compensation unit for thermal asperity
4	comp	ensation;
5		a variable gain amplifier for adjusting an amplitude of a read signal;
6		an asymmetry control unit to compensate for magneto-resistive
7	asymı	metry;
8		a continuous time filter to attenuate high frequency noise;
9		a finite impulse response filter to provide equalization of said read
10	signal	·
11		an interpolated timing recovery unit for sequence recovery;
12		a sync byte detector for providing sync mark detection; and
13		a Viterbi detector;
14	a write	e path including:
15		a read/write interface for interfacing write data;
16		an encoder for encoding said write data; and
17		a PECL driver; and
18	a serv	o path including:
19		said variable gain amplifier;
20		said continuous time filter;
21		said finite impulse response filter; and
22		a servo synchronizer for determining time intervals needed for peak
23	detect	tion.
_	_	

- 2. A read/write channel in accordance with claim 1, said read path including an automatic gain control loop and a DC restore loop.
- 1 3. A read/write channel in accordance with claim 2, said write path including a scrambler.

1	4.	A read/write channel in accordance with claim 3, said write path
2	including a	precoder.
	_	
1	5.	A read/write channel in accordance with claim 4, said write path
2	including a	precompensation unit.
1	6.	A read/write channel in accordance with claim 5, said servo path
2	including a	correlator and preamble detector.
1	7.	A method, comprising:
2	prov	iding a read path, the read path including:
3	-	a thermal asperity compensation unit for thermal asperity
4	com	pensation;
5		a variable gain amplifier for adjusting an amplitude of a read signal;
6		an asymmetry control unit to compensate for magneto-resistive
7	asyn	nmetry;
8		a continuous time filter to attenuate high frequency noise;
9		a finite impulse response filter to provide equalization of said read
10	signa	al;
11		an interpolated timing recovery unit for sequence recovery;
12		a sync byte detector for providing sync mark detection; and
13		a Viterbi detector;
14	prov	iding a write path, including:
15		a read/write interface for interfacing write data;
16		an encoder for encoding said write data; and
17		a PECL driver; and
18	prov	iding a servo path, including:
19		said variable gain amplifier;
20		said continuous time filter;
21		said finite impulse response filter; and
22		a servo synchronizer for determining time intervals needed for peak

detection.

- 8. A method in accordance with claim 7, said read path including an automatic gain control loop and a DC restore loop.
- 9. A method in accordance with claim 8, said write path including a scrambler.
- 1 10. A method in accordance with claim 9, said write path including a precoder.
- 1 11. A method in accordance with claim 10, said write path including a precompensation unit.
- 1 12. A method in accordance with claim 11, said servo path including a correlator and preamble detector.

1

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1 Overview

The SCA8700 is a fully integrated Generalized Partial Response Maximum Likelihood (GPRML) read channel incorporating a complete set of functions required for Read, Write and Servo operation. The channel is fabricated in 0.18µm (drawn) Complementary Metal-Oxide Semiconductor (CMOS) technology and can operate at data rates in excess of 700 Mbit/s. The device is compatible for integration with the Infineon microcontroller family.

1.1 Features

~ General

- All CMOS digital preferred design strategy
- Super-integration compatibility with Infineon controllers
- 190-750 Mbits/sec data rate operation
- Generalized Partial Response Maximum Likelihood (GPRML) system
- 32/34 rate parity code and matched Viterbi detector
- 32-State Viterbi detector optimal parity trellis processor
- Robust frame synchronization with support for dual sync byte mode
- Self adaptive equalization system
- Thermal asperity detection and compensation
 - Adaptive MR head asymmetry compensation
 - Low latency, digitally interpolated timing recovery method
 - Fully programmable 2nd order write precompensation
 - Advanced automatic power management
 - 3.3 V (I/O)(+-10%) 1.8V Core (+-5%) power supply
 - Externally supplied 1.8V or internally regulated 1.8V with external pass transistor.
 - 0.18µm all CMOS process

~ Data Detection

- 32/34 rate parity code
- 32-State Viterbi detector optimal parity trelllis processor
- Generalized targets optimized for improved SNR in high media noise environments
- Support for four different generalized detection targets for different UBD's and noise
- Minimal overhead Viterbi shut-down method
- Viterbi margin stress-testing support
- On chip stress testing using additive white noise
- Viterbi error bursts compatible with existing ECC methods
- The likelihood of false or missed frame synchronization < 10⁻¹⁹

Programmable time-out and programmable error tolerance on sync byte detection

~ Gain Control

- Input amplitude range of 40 to 400 mV pp differential (1:10)
- Decision-directed digital acquisition and tracking loops
- High speed gain acquisition
- Separate AGC control registers for Read and Servo
- Fixed VGA gain mode
- Fast Write mode to Read mode recovery sequence

~ Equalization / Signal Conditioning

- 4-pole generalized anti-aliasing, bandwidth limiting filter with 4 to 1 ω_0 tuning range with adjustable Q enhancement.
- 10-tap digital FIR filter with adaptive and non-adaptive modes
- Multiple selectable FIR adaptation methods supported, including "known-data" mode

~ Timing Recovery

- All digital, Interpolated timing recovery method
- Low latency timing control loop
- Timing acquisition in 10 bytes in two phases
- Zero-phase restart
- Robust frame synchronization with support for dual sync byte operation

~ Frequency Synthesizer - Clock Generation

- Two PLL design; R/W PLL and Servo PLL
- Very low absolute jitter, < 15 ps (standard deviation) at 750 Mhz
- Fast settling time of 10 µs for rapid recovery when switching modes

~ Thermal Asperity Detect/Correction

- Selectable internal or external T/A detection
- Programmable progressive T/A event squelch and recovery sequences
- Dual sync field option for recovery from thermal asperities

~ MR Asymmetry

MR asymmetry correction adaptive or fixed to ±30% [(a-b)/(a+b)]

~ DC Baseline Control/Restore

- Auto-zero when Idle mode
- Active DC control to null offset during preamble and data

~ Write Mode

- High resolution programmable 1- or 2-level Write mode precomp with .78125% increments to 37.5% of the clock window
- Differential low-skew output driver to R/W amplifier
- Low time base jitter with < 5 ps (standard deviation)

~ Read Mode

- Self-adaptive compensation of MR head amplitude asymmetry
- Self-adaptive equalization
- Self-adaptive baseline restore
- On chip programmable stress; noise generator, Viterbi error multiplier, and offtrack emulation allow easy channel setup
- Pipelined Read mode data transfer feature

~ Servo

- Seagate Asynchronous Digital Servo

~ Channel Quality Monitor

- Mean Squared Error, Sample Window Accumulate, and Histogram profiling measurements with "known-data" mode for robust optimization and HDD self calibration
- Selectable trigger modes with programmable data acquisition-time window
- Surface defect scan with programmable positive and negative threshold
- Automatic precomp echo pulse extraction (di-bit extraction)
- Micro "self"-calibration of anti-aliasing filter bandwidth and boost
- On-board sector error rate measurement

~ Power

- Low power dissipation < 1.5 W with 80% duty cycle @ 700 Mb/s
- 1.8 V (Core)(+-5%), 3.3 V (I/O)(+-10%) supply
- Externally supplied 1.8V or internally regulated 1.8V with external pass transistor
- Extensive optimized power management

~ Signal Observability

- Analog Test Port that may be programmed to connect to analog nodes in the signal path
- View DAC that may be programmed to connect to several signals including FIR out, timing error, gain error.
- Multiplexed test output that can be programmed to "sync-byte found"
- Simultaneous analog read signal and digital eye-pattern outputs are provided

2 Channel Architecture

2.1 Modulation Code

The modulation code used in the SCA8700 is a rate 32/34 block code. All 34-bit codewords satisfy a "Charge modulo 2" (Qmod2) parity constraint. The code achieves about 1dB net coding gain by forcing the charge in each codeword to be even. As a consequence of this parity constraint, all error sequences with odd parity are eliminated. This includes; di-bit drop-in and drop-outs (0,+1,0), tri-bit related errors (+1,-1,+1), pentabit related errors (+1,-1,+1,-1,+1), etc. The (Qmod2 constraint offers more immunity to errors than uncoded or maximum transition run (MTR) codes under normal operating environments.

The SCA8700 modulation code is also designed to achieve good worst-case timing information, maximizing the minimum timing information content in any codeword. Each 34 bit codeword has at least a minimum of 7 timing units of information.

For ECC compatibility, minimum-distance error events on the coded trellis are limited to cause errors in no more than 4 decoded user bytes. Thus, best system performance is achieved using an outer error correcting code with 8-bit symbols, GF(256), and with greater than or equal to 4-way interleave. The code properties are summarized in Table 1.

Table 1	Code Properties

Rate Parity 32/34 Even		Minimum # Timing Units per Codeword	Max # Consec 0's	Max Burst Length
32/34	Even	7	17	4 bytes

2.2 Trellis Coded Noise Prediction Viterbi Algorithm

The sequence detector is implemented using a 32-state Viterbi detector that is the product of a 16-state Noise Predictive Inter-Symbol Interference (NP ISI) Viterbi algorithm and a 2-state time-varying charge parity trellis. The 32-state product trellis is pruned back to 16-states at every 34th bit-cycle to enforce the charge parity constraint at the block boundary. This implementation of the parity code is an optimal maximum likelihood solution, and has none of the sub-optimal characteristics of competing "post-processor" solutions, e.g., failure at block boundaries, sensitivity to changing error event structure, etc.

In order to provide good performance across a wide range of user operating conditions, the SCA8700 allows the user to choose from four different noise-predictive Viterbi algorithms.

- ~ Noise Predictive {3,2,1} is best suited for applications with low to moderate user densities. It performs well in these areas even with high media noise.
- ~ Noise Predictive {2,2,1} is best suited for applications with moderate media noise and moderate to high user densities.
- ~ Noise Predictive {3,1,1} is best suited for applications with low to moderate user density and very high media noise.
- ~ *EPR4* is included as a legacy mode, and performs close to Noise Predictive {3,2,1} in most environments.

2.3 Performance

The performance of the SCA8700 code and four noise predictive detector choices are illustrated for two realistic operating scenarios in Figure 1 and Figure 2. An uncoded EPR4 code and detector are included for historical comparison purposes. All measurements use the Error Event Rate (EER) rather than the Bit Error Rate (BER), because EER directly impacts the sector error rate after ECC, while the BER doesn't always correlate well with the sector error rate.

Figure 1 shows a realistic operating environment for a future drive with very high Tracks Per Inch (TPI), as is expected to occur with the introduction of two stage radial positioning systems. The user density is low to moderate, Du=2.5, and the media noise is high, 50% of the total noise. The SNR is defined as the ratio of signal to total noise powers at the preamp output, measured with random uncoded data. All signal and noise powers are measured in the Nyquist bandwidth of the coded-channel rate. The results show a 1 dB coding gain from the Qmod2 code, and an additional 0.5 dB improvement with NP{3,2,1}.

Figure 2 demonstrates a possible operating environment where the TPI is not as high as shown in Figure 1, e.g., due to cost or manufacturing problems with two-stage actuator and high TPI systems. In this scenario, on track SNR is high and supports high user density, Du=3.1, with 25% media noise power. In this example the read gap is two times the channel bit cell length. The results show a 3 dB gain for NP{1,2,1} and 2.5 dB gain for NP{2,2,1}.

This figure also illustrates that EPR4 and NP{3,2,1} are not appropriate detectors for this high UBD application.

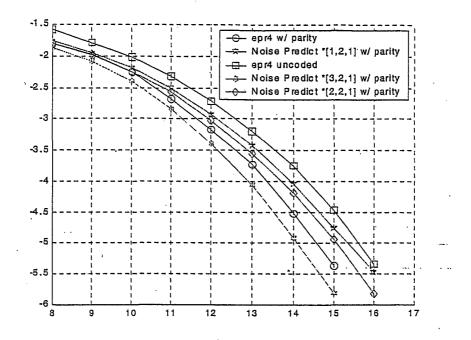


Figure 1 QMod2 Trellis Detectors At 2.5 Ubd in 50% Media Noise

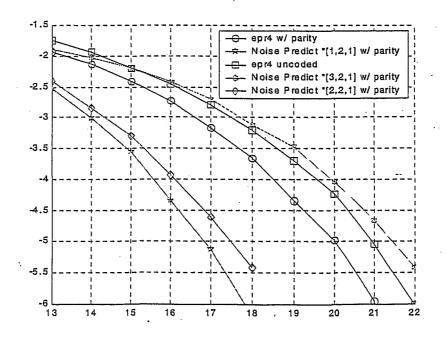
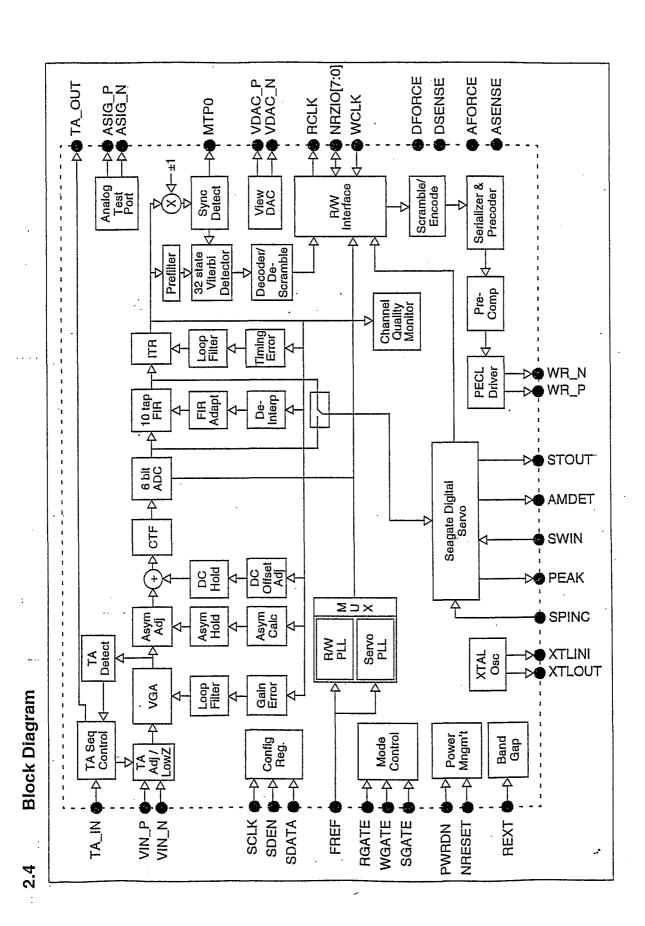


Figure 2 Qmod2 Trellis Detectors At 3.0 Ubd in 25% Media Noise



3 Operating Mode Definition

The operating modes of the SCA8700 are determined by the state of five pins: RGATE (Read Gate), WGATE (Write Gate), SGATE (Servo Gate), PWRDN (Power Down), NRESET (Not Reset), as well as the two registers, 04<2>, and 04<1>. The operating modes are shown in Table 2, and the state diagram is described by Figure 3.

Table 2 Mode Control

MODE	Pins					Reg Bits	
	RGATE	WGATE	SGATE	PWRDN	NRESET	04<1>	04<2>
Read mode	1	Х	0	0	1	Х	0
Write mode	0	1	0	0	1	Х	0
Servo mode	X	Х	1	0	1	0	0
Write/Servo mode	0	1	1	0	1	1 -	0
ldle mode	0	0	0	0	t	Х	0
Doze mode	0	0.	0	1	1	X	0
Suspend	X	Х	. X	Х	1	Х	1
,	X	Х	Х	Χ.	0	Х	X

3.1 Read Mode

When RGATE is asserted, the timing synchronization and gain acquisition operations start. Timing acquisition occurs in a series of phases. The process begins with zero-phase restart, followed by fast acquire and data-tracking phases. Concurrent with timing acquisition, an automatic gain loop adjusts the readback signal amplitude to a target value. Gain acquisition is also comprised of fast and slow acquire phases. While reading data, additional control loops compensate for MR head asymmetry and DC offset.

After the timing and gain acquisition phases are complete, the SCA8700 searches the readback data for a unique sync-byte that marks the beginning of valid user data. When the sync-byte is detected, user readback data is processed and detected data is placed on the R/W (NRZIO) interface.

3.2 Write Mode

In Write mode, all circuitry in the write path is enabled and write data is clocked from the controller to the channel NRZIO interface. Write data is synchronized, encoded, serialized, precoded and precompensated before being sent to the write preamp via a PECL interface.

3.2.1 Normal Write

A normal Write operation begins when WGATE is asserted and the controller clocks a 00h (hex) byte to the NRZIO interface. The device output is a 2T preamble pattern until the data marker, a FFh byte, is received from the controller. At this point, the device inserts a unique sync-byte into the output data stream, which replaces the received FFh byte. Subsequent data transferred from the controller is scrambled, encoded and then transferred to the PECL interface as encoded user data.

3.2.2 Known Data Write

A variation of a normal Write operation is known-data Write. When 20<3> is set to 1, the device write output is a sector of internally generated data. The operation begins when WGATE is asserted and the controller clocks a 00h (hex) byte to the NRZIO interface. The device writes a 2T preamble pattern until the data marker, a FFh byte, is received from the controller. At this point, the device inserts a unique sync-byte into the output data stream, which replaces the received FFh byte, followed by write data consisting of an internally generated repeating pseudo-random binary sequence (PRBS), the output of a linear feedback shift register (LFSR) circuit. Subsequent user data transferred from the controller to the NRZIO interface is ignored for the duration of the write cycle.

3.3 Write Mode During Servo Mode

The activation of Read mode, Write mode, and Servo modes are governed by a set of precedence rules as outlined in Table 2. Write mode usually has the lowest precedence and can be overridden by Read mode or Servo modes. However, when register 04<1>= 1, Write mode may also occur during Servo mode. Both Servo and Write mode may take place simultaneously. Servo mode must be active before the device will enter Write/Servo mode.

3.4 Servo Mode

During Servo mode, the VGA and AGC loops, as well as the CTF, ADC, and FIR filter sections of the read path, are active and are programmed to a unique set of servo register values. The equalized and conditioned sample values are sent to a servo synchronizer that functions to determine time intervals needed for digital based asynchronous peak detection. Asynchronous peak detection is used to determine the peak position required to demodulate the Gray code. A and B servo bursts are digitally integrated to produce burst area estimates that are transferred to the disk controller via the NRZIO interface.

3.5 Idle Mode

Idle mode is defined as the absence of Read mode, Write mode and Servo mode activity. All analog circuitry and frequency synthesizers are enabled, and the analog to digital converter (ADC) and DC Restore are active.

3.6 Doze Mode

In Doze mode all nonessential circuitry is disabled. Register bits 98<1:0> and 98<1:0> determine if the synthesizers are enabled. Upon transition from Doze mode to Idle mode, a start-up time is required to allow the frequency synthesizers and analog circuitry to stabilize. The timing rules are defined in Table 3.

3.7 Suspend Mode

Suspend mode turns off all channel read/write activity. The configuration registers retain their settings and determine the initial state after NRESET = 0.

3.8 Operating Modes

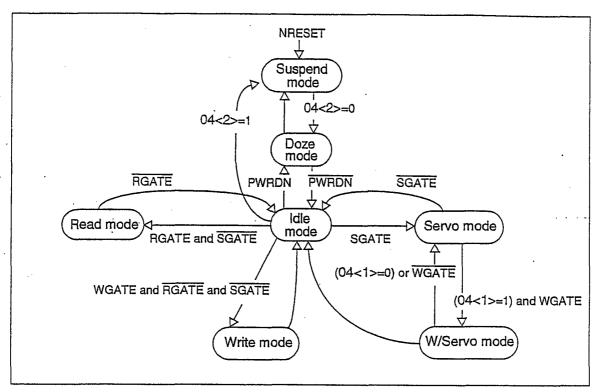


Figure 3 Operating modes

Table 3 Mode Timing Rules

Parameter	Time	Description Contiguous Read mode to Read mode		
Tr/r	24 PLL Clocks			
Ts/d	500 ms	Suspend to Doze mode		
Td/i	100 μs	Doze mode to Idle mode		
Ti/s	24 PLL Clocks	Idle mode to Servo mode		
Ts/i	24 PLL Clocks	Servo mode to Idle mode		
Tr/i	24 PLL Clocks	Read mode to Idle mode		

3.9 Power Management

The device is divided into functional partitions that may be powered-on or powered-off based on which operating mode is active. Refer to Table 4 where 1 is Powered-on, and 0 is Powered-off:

MODES	Band gap	Synth	Analog FE	Servo	ADC	FIR	ITR/ Viterbi	Read I/F	Write I/F
Read mode	: 1	1	1	0	1	1	1	1	0
Write mode	1	1	. 0	0	0	0	0	0 .	1
Servo mode	1	1	1	1	1	1	0	0	0
Idle mode	1	1	1	0	1	0	0	0	0
Doze mode	1	0	0	0	0	0	. 0	0	0
Suspend mode	. 0	0	0	0	0	0	0	. 0	0

4 Read Mode

The following sections are arranged in the order of the signal flow from the VGA through to the NRZIO interface. According to this rule, the descriptions of VGA, MR asymmetry and DC restore compensation circuits precede the descriptions of their respective control loop structures.

4.1 Variable Gain Amplifier (VGA)

The differential signal from the preamplifier is transferred to the SCA8700 VGA through the VIN_P and VIN_N pins. External capacitors are required to couple the preamplifier signal to the VGA. The VGA inputs are internally biased so that external DC biasing components are not required. The normal operating signal input level at pins VIN_P and VIN_N is 40-400 mV peak-to-peak differential.

An internal 8-bit DAC, that is adjusted by the Automatic Gain Control (AGC) loop controls the gain of the VGA. The initial gain for read and servo operations are programmed as 2s-complement numbers in registers 7A<7:0> and 7B<7:0>, respectively. The VGA control range is from 0 dB to 20 dB.

Impedance switches, in series and in parallel with the inputs of the VGA, are shown in Figure 4. These switches allow reduced recovery time from transients that occur during write sequences and thermal asperity events. During a normal Read mode operation, the series switches are closed and the shunt switch is opened, setting the input impedance to 250-2000 Ohms.

When the impedence switches are used to compensate a thermal asperity event, the AC coupling pole frequency is increased by adjusting ZADJ to reduce the input impedance. The input impedance is varied dynamically over time as shown in Figure 7.

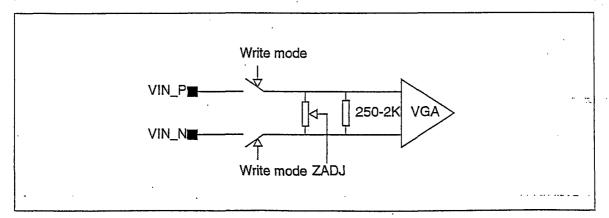


Figure 4 Input Impedance Switches

During Write mode, the switches in series with the VGA inputs are opened, providing a high input impedance. Simultaneously, the shunt input resistance is reduced. A more

detailed explanation of the use of impedance switching used for Write mode to Idle mode recovery can be found in Section 8.4.

4.2 MR Asymmetry Compensation and DC Restore

The MR head asymmetry compensation system is shown in Figure 5:

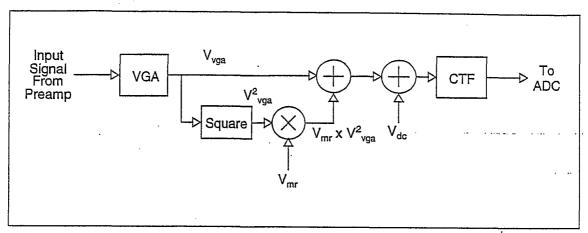


Figure 5 MR Asymmetry Compensation

The output of the VGA is squared and multiplied by the scaling factor V_{mr} , and then added to itself. This combination provides a nonlinear transfer function from the VGA to the input of the CTF in a form that may be adjusted to compensate for second harmonic distortion created by the MR head. V_{mr} adjusts the magnitude of compensation. The value of V_{mr} is automatically determined by an MR asymmetry compensation loop as described in Section 4.9.

An adder function following the compensation circuit is used to nullify the accumulated DC offset in the analog signal path. A voltage, $V_{\rm dc}$, derived from a DC restore control loop, is added to the signal to cancel the DC value of the signal into the CTF and ADC. The control loop is implemented in the digital domain and is described in Section 4.8.

4.3 Thermal Asperity (TA) Detection and Compensation

The overall objective of the TA compensation circuit is to reduce overload and decrease recovery time during a TA event. Ideally, the bit length of the compensated error burst will be reduced so that ECC correction is possible.

The SCA8700 incorporates TA detection and correction circuitry to reduce the effects of distortion caused when the MR head encounters a TA on the disk. The block diagram of the TA detect circuitry appears in Figure 6. The TA detect block is comprised of a low-pass filter coupled to a threshold detector. The amplitude-normalized signal from the output of the VGA is sent through the TA detect low-pass filter and then applied to the threshold detector. The threshold level is independently programmable for Read mode

and Servo modes by using registers 89<3:0> and 89<7:4> respectively. A TA event is defined to have occurred when the low-pass filter output exceeds the threshold value for the time set by register 88<5:4>.

When a TA event is detected, the TA_OUT pin is asserted. In addition, an internal compensation sequence is initiated that changes the input high-pass pole frequency at the VGA input as described in Figure 7. The input time-constant decays exponentially over a time period, set by T_τ , to the initial nominal value. The gain of the DC restore loop is also increased to allow for faster baseline recovery. Timing, gain and FIR adaptation loops are put in hold mode for the duration of the TA event. In addition, the MR asymmetry loop is put in hold mode until the end of the RGATE. External or internal TA detection may be selected by register 88<7>. Relevant user programmable parameters are shown in Table 5, and details of the operation of the TA compensation circuit are shown in Figure 6 and Figure 7.

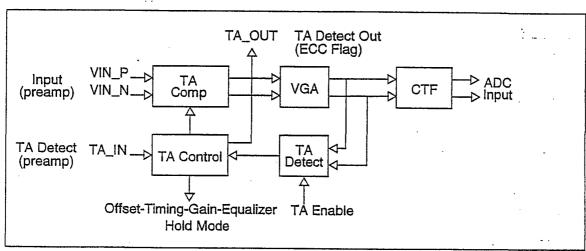


Figure 6 Thermal Asperity Detection And Correction

Table 5 TA Compensation	Registers
-------------------------	-----------

Parameter	Range	Default	Register 88<1>	
Detection enable	N/A	Disabled=1		
TA detection threshold (Read mode)	0 - 15	0	89<3:0>	
TA detection threshold (Servo mode)	0 -15	0 -15 0		
TA low-pass bandwidth	5.5-10 MHz	10 MHz	88<3:2>	
Duration of timing and gain loop hold	6 bytes		Fixed	
R _p values	12, 5	12	8A<2>	
T _L	1-4 bytes		8A<4:3>	
Тт	100-1600 ns	400 ns	8A<6:5>	

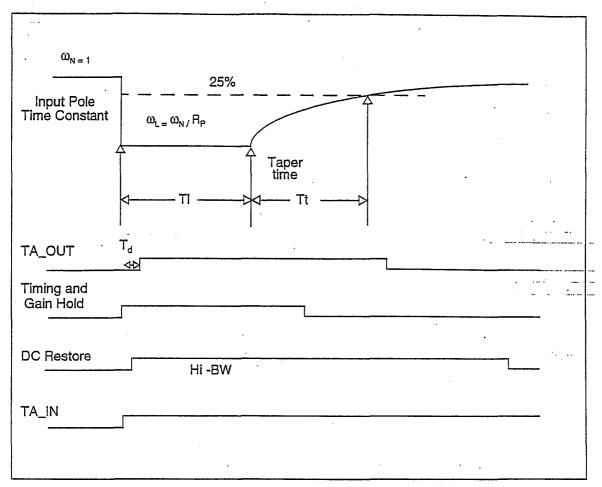


Figure 7 Thermal Asperity Compensation Algorithm

4.4 Continuous Time Filter (CTF)

San Miguel uses a 4-pole continuous time low pass analog filter to truncate the noise bandwidth input to the analog to digital converter (ADC). The low pass characteristic also prevents aliased frequency components beyond the Nyquist frequency from falling in the pass band.

The frequency response of the filter does not correspond to a standard polynomial. The filter itself consists of a cascade of two second order s-domain transfer functions, given below:

$$H(s) = \frac{1}{(s^2 + (\omega_{01}/Q1)s + 1)(s^2 + (\omega_{02}/Q2)s + 1)}$$
(1)

The ω_0 (pole-pair frequency) and Q (pole-pair quality factor) of each biquad are independently adjustable. ω_0 is programmable from 2π x *87.5 Mrad/s to 2π x

350Mrad/s (4:1 ratio). The Q for each Biquad is independently programmable in the range 0.6 to 1.6. Figure 8 and Figure 9 below are the frequency response and the phase response for the cases where Q1 is set to 1 and Q2 is set 1.6; ω_0 for both is set 1 rad/s. The standard 4 pole Butterworth response is also shown for comparison. As can be seen, up to 10dB boost can obtained in the pass band of the filter, when both Q's are set to 1.6.

The highest pole frequency is equal to 43% of 750Mb/s data rate (32/34 coding is assumed). ω_0 for each biquad is programmable in 2% steps (0.18dB) within the allowed range of 87.5 to 350 Mhz. The step size variation is in the range of 1.75Mhz to 7Mhz (2% of lowest and highest settings). Q has 7 linear steps in the range 1 to 1.6

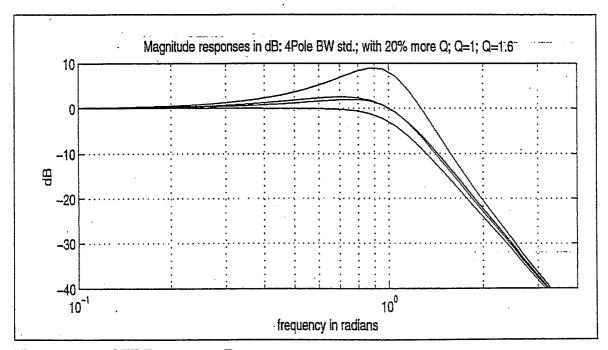


Figure 8 CTF Frequency Response

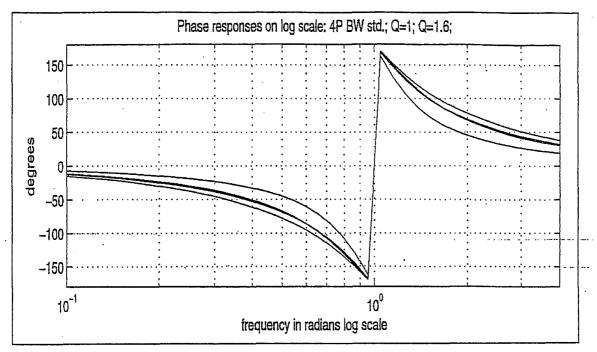


Figure 9 CTF Phase Response

4.5 Analog-to-Digital Converter (ADC)

The SCA8700 uses a 6-bit, background calibrated, flash ADC. The use of an interpolated timing recovery architecture allows more channel latency. The latency may be exploited to optimize speed, power and performance in the design of the ADC.

4.6 Timing Acquisition Loop

The SCA8700 uses a digital interpolated timing recovery (ITR) method to resample readback waveform samples at the proper time instances required for sequence detection. Figure 10 shows the phase-locked loop structure that is used to synchronize to the phase and frequency of the incoming readback bit stream. The equalized and oversampled data values from the ADC are interpolated using a 8-tap digital FIR interpolation filter. With this technique, the sample phase is represented as a binary

number, μ_{k} , m_{k} , which is the input to the interpolation filter.

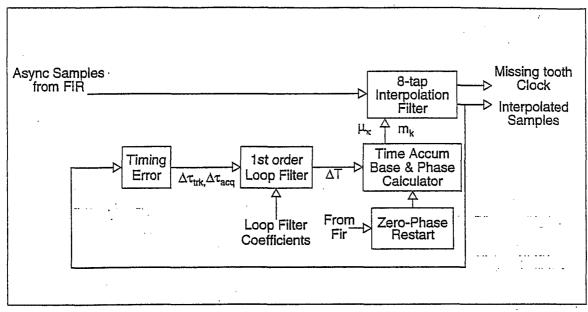


Figure 10 Timing Control Subsystem

The "Timing Error" block processes interpolated samples to produce the timing corrections, $\Delta\tau_{trk}$, and $\Delta\tau_{acq}$, that are used for tracking and acquisition modes respectively. The errors are filtered by a digital pole-zero filter combination to produce the estimated error in interpolation sample time, ΔT . The "Time Accum" block translates ΔT into two signals: μ_k , the resample phase within a clock cycle, and m_k , which acts as a not-strobe to indicate when a clock period does not contain a resample. When m_k is asserted, the ITR output for the corresponding clock cycle is ignored for all downstream processing. The 8-tap filter estimates the sample value between the asynchronous samples to produce time-normalized interpolated sample values. Since the device uses a 6.67% oversampling ratio, approximately every 16th clock cycle is not used.

The timing loop filter is synthesized in the digital domain. A block diagram of the 1st order digital loop filter is described in Figure 11:

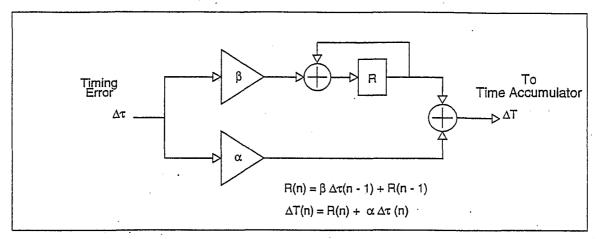


Figure 11 Timing Loop Filter

The timing loop filter output consists of the sum of a digital integrator, representing a pole, and a proportional term, representing a zero. The contributions of the pole and zero are dynamically changed during the lock-on sequence by varying α and β to minimize phase and frequency capture time. The upper path, containing integrating register R, stores the resampled frequency setting while the lower path causes phase adjustments that are required for loop stability and for reduction of peak phase errors.

The timing algorithm proceeds through three distinct modes: a "zero-phase" mode, where the resampling phase is set to a predetermined value with respect to the average phase of the preamble, a second "fast-acquire" mode, where the frequency of the loop is adjusted, and a third and final "data-tracking" mode, where the timing loop is phase and frequency locked and the timing corrections are derived by averaging over many bits. This is sometimes called the three gear system.

The three timing mode intervals are shown pictorially in Figure 12:

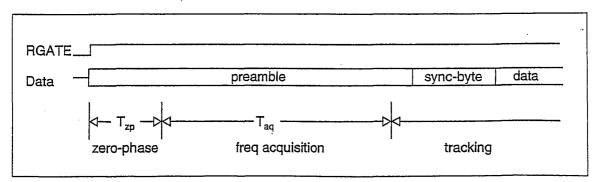


Figure 12 Timing Acquisition

4.7 Gain Acquisition, AGC Loop

The AGC loop sets the overall voltage gain of the read path so that the output amplitude of the ADC is independent of channel input voltage variations. The function of the AGC loop is to provide a normalized signal amplitude input for the Viterbi detector. The AGC also functions to constrain the signal voltage to be within the dynamic range of the ADC.

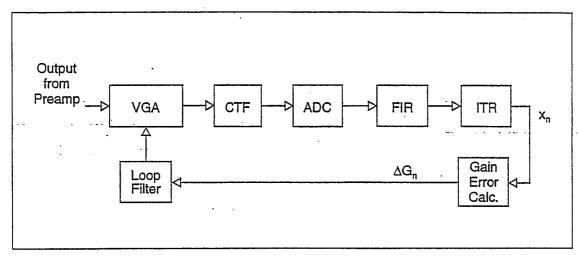


Figure 13 AGC Loop

Gain corrections, ΔG_n , are derived from interpolator output samples, x_n , as shown in Figure 13. During fast-acquire mode, the AGC loop gain is increased, and only non-zero sample estimates are used.

Gain errors are integrated using the digital loop filter as shown in Figure 14. The gain register, R, accumulates gain error terms until the control voltage to the VGA stage V_{AGC} , is set to the value that makes the amplitude input to the Viterbi detector equal to the target number.

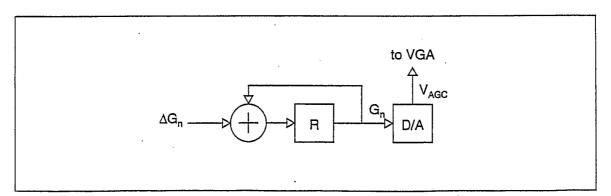


Figure 14 AGC Loop Filter

4.8 DC Restore Loop

Accumulated DC offset in the analog signal path is cancelled by means of a DC restore control loop. The method is described in Figure 15. DC offset is measured only during the data field.

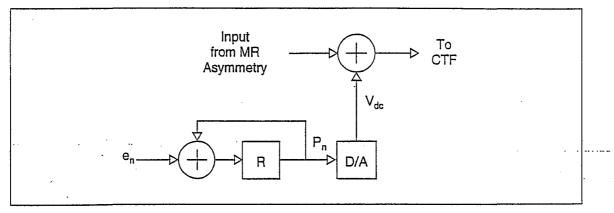


Figure 15 DC Restore Loop

At each bit clock cycle, an error term, e_n , is calculated and added to an accumulator which is coupled to a DAC. In turn, the DAC output adds a correcting voltage to the analog signal path before the CTF. In this manner, the control loop functions to nullify DC offset as measured at the ITR output.

4.8.1 AGC Shadow Register

The initialization of the register R used in the AGC is accomplished by means a corresponding shadow register. This concept is illustrated in Figure 16.

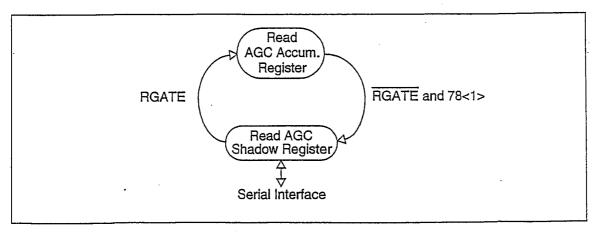


Figure 16 AGC Shadow Register - Read Mode

Shadow register operation is as follows: The AGC accumulator, R is always loaded with the contents of the AGC shadow register when RGATE is asserted. The shadow register

can be loaded or read back by means of the serial interface. Alternately, when 78<1> is set, the shadow register is used to save the contents of the AGC accumulator at the deassertion of RGATE. Refer to Figure 45.

Typically the shadow register is loaded with a "best guess" initial gain setting through the serial interface. Successive read cycles are performed with 78<1> set to 1, so that a new initial gain setting is saved after each sector. When the gain setting has converged and is no longer changing, the new value is saved and used as the initial gain setting for non-feedback AGC modes, when 78<1> is set to 0.

During Servo mode, a separate accumulation register and shadow register are used to control the AGC. If register bit 78<0>=1 the servo AGC accumulator is updated from the shadow register when SGATE is asserted. If 78<0>=0 the servo AGC accumulator is updated with the value of the read AGC accumulator that has been derived from a previous read operation. The concept is illustrated in Figure 17.

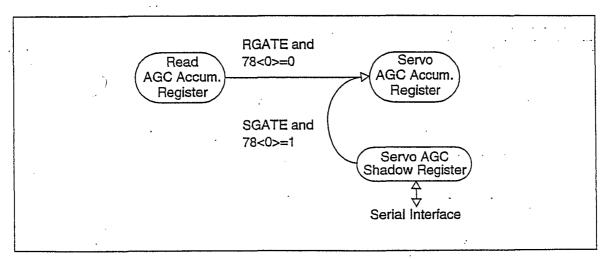


Figure 17 AGC Shadow Register - Servo Mode

4.8.2 DC Restore Loop Shadow Register

The initialization of the register R used in the DC restore (DCR) loop is accomplished by means of a corresponding shadow register. This concept is illustrated in Figure 18.

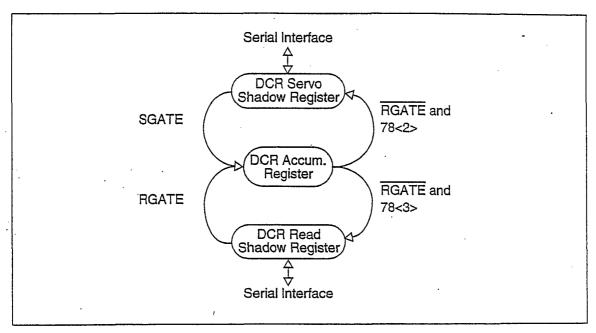


Figure 18 DC Restore Shadow Register

The DCR accumulator, R, is always loaded with the contents of the read AGC shadow register when RGATE is asserted. The shadow register can be loaded or read-back by means of the serial interface. When 78<3> is set, the read shadow register is used to save the contents of the AGC accumulator at the de-assertion of RGATE.

The DCR accumulator, R, is always loaded with the contents of the servo shadow register when SGATE is asserted. However, the operation of this register is different than in read, since the DC restore loop does not adapt during servo. The DCR servo shadow register is initialized either by the serial interface, or if register 78<2> is set, then it is loaded with the results of a previous read operation.

4.9 MR Asymmetry Compensation Loop

The MR asymmetry compensation loop operates only during the user data portion of the sector in Read mode. The compensation loop architecture is shown in Figure 19:

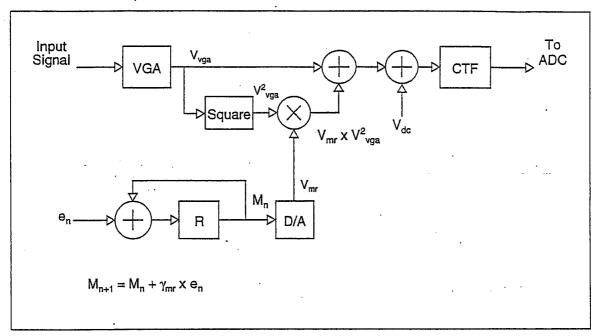


Figure 19 MR Asymmetry Compensation Loop

An asymmetry error term, e_n , derived from three consecutive sample values of the data, is added to the MR asymmetry accumulator R that accumulates to a value M_n . The accumulator drives a DAC, producing an output, V_{mr} , that is used to vary the value of V_{vga}^2 , a signal proportional to the square of the analog output of the VGA. The output of the MR asymmetry compensation circuit becomes ($V_{vga} + V_{mr} \times V_{vga}^2$). The feedback loop adjusts the amplitude of ($V_{mr} \times V_{vga}^2$) to a value that will compensate for the 2^{nd} harmonic distortion produced by the MR head nonlinear transfer function. The loop gain, γ_{mr} , has only one setting.

4.9.1 MR Asymmetry Shadow Register

The accumulation register R, which is used in the MR asymmetry (MRA) correction loop, is initialized by means of a shadow register as shown in Figure 20. Use and operation of the MR shadow register is identical to that of the DC restore shadow register. Use of the

MRA shadow register is illustrated in Figure 20.

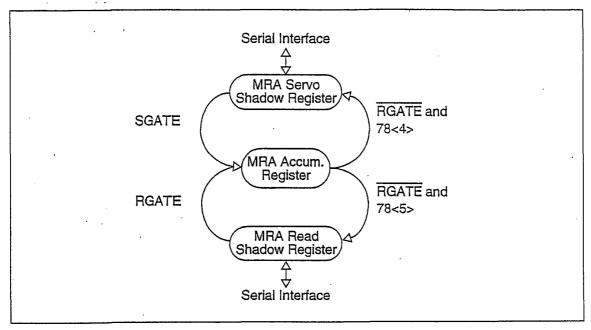


Figure 20 MR Asymmetry Shadow Register

4.10 Self-adaptive FIR Filter Equalizer

A 10-tap Finite Impulse Response Filter (FIR) is used to complete the equalization of the digitized signal to the EPRML target waveform. The topology of the filter is shown in Figure 21.

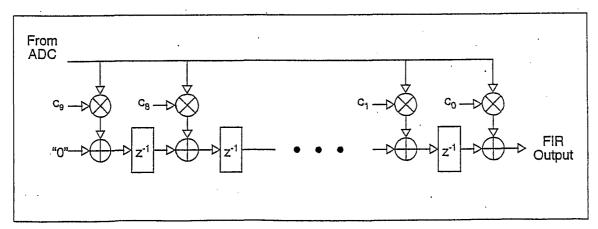


Figure 21 FIR Filter Structure

The active FIR coefficients (tap weights) may be loaded with the contents of the shadow coefficient registers at the start of read or servo operations. Two sets of shadow registers are used, one for Read mode and one for Servo mode. The concept is depicted in Figure

22. The values of the Read mode and Servo mode FIR shadow registers can be modified through the serial port when NOT in Read mode or Servo mode. Only the read shadow registers can be updated with values derived from a self-adaptive read operation. The values of the Servo mode shadow registers are always assigned through the serial port.

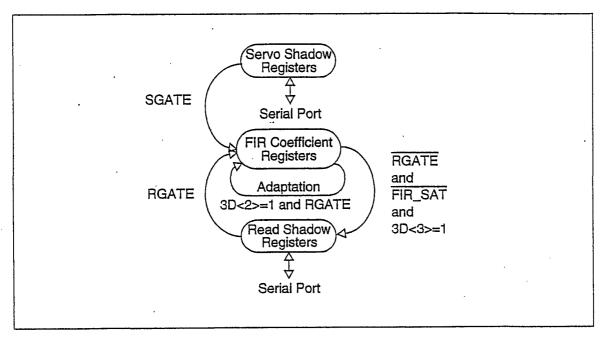


Figure 22 FIR Adaptation

During a read operation, the FIR coefficients are transferred from the shadow registers to the FIR coefficient registers on assertion of RGATE. FIR filter self adaptation is enabled when 3D<2>=1. After completion of a read, and if 3D<3>=1, then values of the Read shadow registers are updated by the contents of the FIR coefficients derived from the previous read operation. However if the FIR_SAT signal is asserted, indicating that one or more FIR filter coefficients have saturated, then the update is aborted and inaccurate coefficients are discarded.

In self-adaptive mode, selected filter taps may be programmed to serve as cursor taps by registers 3C<7:0>and 3D<0>. Selected taps retain their initial coefficient settings while other taps are adapted. This technique prevents unintended phase and amplitude shifts while the filter is adapting. There are no restrictions on which taps or how many taps can be defined as cursor taps.

When 3D<3>=0, the FIR shadow register is not updated when RGATE is deasserted and the FIR coefficients are set to a fixed set of values at the start of every read operation. If 3D<2>=1, the FIR filter will self-adapt during a subsequent read operation. However, if 3D<2>=0, the FIR filter operates in fixed mode with a fixed set of coefficients

In Servo mode, the FIR filter only operates with a fixed set of coefficients, which are loaded from the servo shadow registers at the assertion of SGATE.

4.11 FIR Filter Adaptation Loop

In normal self-adaptive mode, the de-interpolated estimate of the amplitude sample error and an estimate of the sample are used to calculate an equalizer error term that is used to adjust the individual tap coefficients of the FIR filter.

When FIR self-adaptation is required in low SNR environments, FIR tap coefficients may be found by using an enhanced algorithm. Known-data is used instead of estimated data to calculate equalizer error. To enable known-data FIR adaptation, 20<3>bit is set to 1 and the data sector is written using a known-data write. Since no user data is transferred through the NRZIO interface, this mode is used to only to find reliable FIR coefficients which in turn, may be used to preset the FIR equalizer during normal operation.

As shown in Figure 23, FIR tap adaptation is enabled shortly after sync byte is detected. The delay, T_{adp} is fixed and not adjustable.

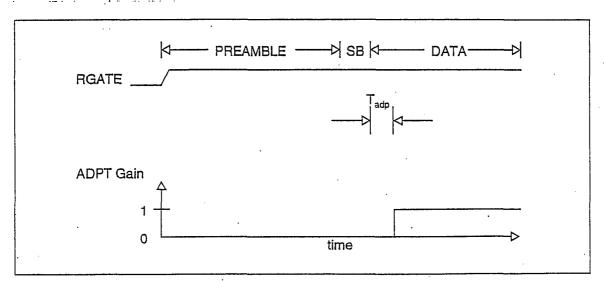


Figure 23 FIR Adaptation Read Mode Timing

A more complete definition of the adaptation time intervals is contained in Section 8.1.1. When RGATE is asserted, the gain of the adaptation loop is at first set to zero to keep the initial coefficient values unchanged until the end of preamble. At the beginning of the data area of the sector, loop gain is turned-on for the duration of RGATE.

4.12 Sync-Byte Detection

The sync-byte detector exploits a novel algorithm that permits a synchronization mark as short as seven bits without sacrifice in the likelihood of correct byte synchronization.

The sync-byte detector is polarity sensitive. A programmable invert function is used to flip the polarity of the data entering the synchronization detector and the Viterbi detector. The user must determine the correct polarity empirically. The polarity is selected by

register 60<0>. Knowledge of signal polarity is also used to exploit a known start-state during Viterbi detection, thereby reducing the likelihood of initial Viterbi error events.

4.13 Sequence Detector

The sequence detector is implemented using a 32-state EPRML Viterbi detector that uses a time varying trellis. The Viterbi detector uses a path memory of 68 bits to ensure that the burst error limiting properties of the modulation code are fully exploited. A block diagram describing the functional partition of the Viterbi detector is shown in Figure 24.

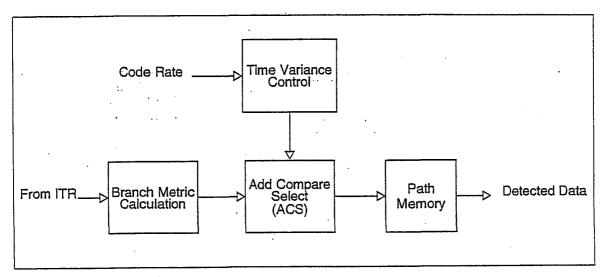


Figure 24 Viterbi Detector

Amplitude and time normalized samples from the timing interpolator are used to calculate the branch-metrics for the trellis. The 32-state Viterbi detector is implemented as radix-4 Add-Compare-Select (ACS) units. The ACS unit's output consists of decisions that are stored in the path memory. After all possible sequences have converged, detected data is sent to the NRZ formatter for decoding and descrambling.

Table 6 outlines the rate 32/34 code properties.

Table 6 Code Properties

Rate	Parity	Transitions/ 1/2 Codeword	Max # Consec 0's	Max Burst Length
32/34	Even	7	17	4 bytes

5 Write Mode

The Write mode path data flow is shown in Figure 25:

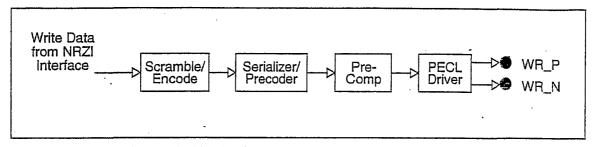


Figure 25 Write Path Block Diagram

Write data received from the NRZIO interface is normally scrambled to ensure a low probability of repetitive sequences. Next, the data is encoded so that all resulting sequences satisfy the Qmod2 code constraint of the rate 32/34 code. Finally, the data from the encoder is precoded before being sent to the precompensation circuit and the PECL output driver. The PECL output driver is designed to have low skew with a fast rise-time to accommodate Write mode speeds greater than 750 Mbit/s.

5.1 Scrambler / Descrambler

Data placed on the NRZIO interface (NRZ data) is scrambled before encoding and descrambled on readback. Scrambling is primarily used to break up long runs of repetitive sequences. The scrambler is composed of a linear feedback shift register (LFSR) with suitable feedback connections. During a write operation, the output of the LFSR, a pseudo-random binary sequence (PRBS), is XOR'ed with the NRZ data before encoding. During a read operation, the output from the decoder is XOR'ed with the same PRBS before being clocked out to the NRZIO pins. Figure 26 shows the scrambling and descrambling path of the data.

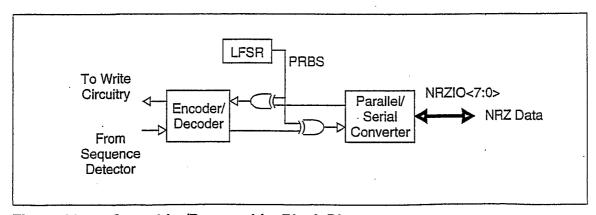


Figure 26 Scrambler/Descrambler Block Diagram

The PRBS generator used in the SCA8700, along with its generator polynomial, is shown in Figure 27. The PRBS generated by the LFSR is described by a generator polynomial G(D), where D represents a delay of one NRZ bit.

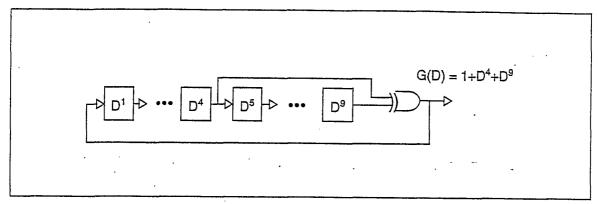


Figure 27 PRBS Generator

5.2 Encode-Decode

Data received from the controller is encoded using a rate 32/34 code mapping. The encoder converts 32 NRZ bits to 34 channel bits. Upon readback, the decoder receives data from the Viterbi Detector and converts it back to NRZ data. The decoder synchronizes to the data upon detection of the sync-byte pattern.

The encoder and scrambler can be bypassed during a Write mode operation by setting register 20<0> to 1. In addition, the write precoder is bypassed by setting register 20<1> to 1. When both the scrambler and precoder are disabled, the device enters the direct Write mode. Data from the NRZIO bus is transferred directly to the precompensation circuit, to the PECL interface and then to the read/write preamplifier. Direct Write mode only effects the write path. If a subsequent read operation is desired, the user write data must contain the preamble and sync-byte format as well as any necessary bytes appended. Interface clocking is automatically modified.

5.3 Serializer/Precoder

The serializer/precoder receives data from the encoder that is used to generate an unprecompensated write current pattern. Byte-wide write data is first converted to serial data before being applied to the precoder. The precoder, as shown in Figure 28, performs a bit-by-bit mapping, where the delay blocks represent a delay of 1 bit-clock period each.

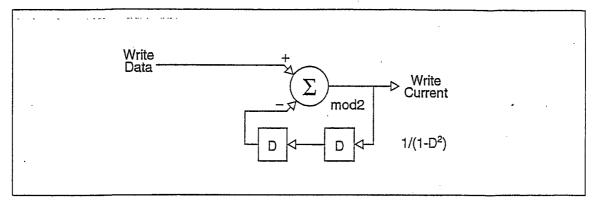


Figure 28 Precoder Block Diagram

5.4 Precompensation

The precompensation circuit shifts the time that a write data transition occurs. This attempts to compensate for the nonlinear bit shift effect of the write process.

The write precomp circuit block diagram is shown in Figure 29. The circuit can select from 48 equidistant phases of write clock. The programmable range is 0-37.5% of the period of the write clock, with a delay step of .78125%. First order precompensation is selected by setting register 21<3> to 1. Decoding logic decides how much time shift to apply to a given transition according to the rules in Table 7.

Table 7 Write Precomp Settings

T(-2)	T(-1)	T(0) shift (% of bit period)	Level
1st order pre	comp 21<3> = 1		·
X	Tr	24<6:0> x .78125%	- 1
Χ	none	0	
2nd order pre	ecomp 21<3> = 0)	
Tr	none	22<6:0>x .78125%	2
none	Tr.	24<6:0> x .78125%	
Tr	Tr	23<6:0> x .78125%	2
none	none	0 _ , .	

[&]quot;Tr" indicates the presence of a write transition

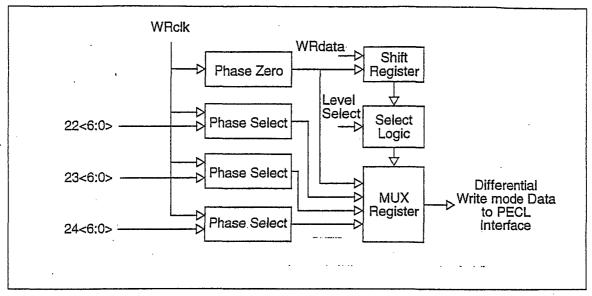


Figure 29 Write Precomp

5.5 Write Data (PECL) Interface

Fast current-switch outputs are provided to transfer write data to the read/write preamp. The interface is shown in Figure 30 and the logic levels are shown in Figure 31 and Table 8.

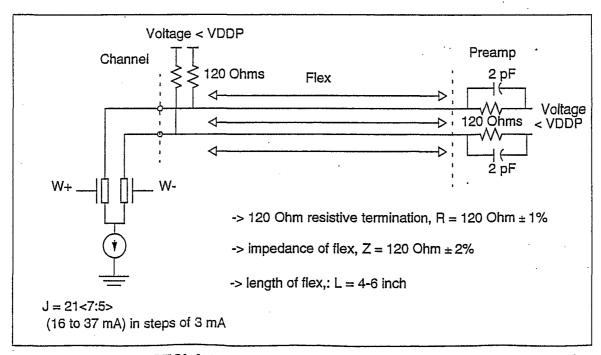


Figure 30 Write PECL Interface

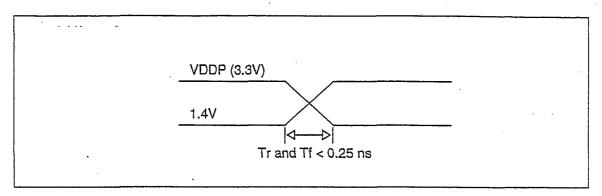


Figure 31 PECL Logic Levels

Table 8 PECL Interface Specifications

Parameter	min.	max.
PECL output high voltage	1.8 V	VDDP
PECL output low voltage	1.4 V	VDDP - 0.4V
Tr and Tf (10 to 90%)		.25 ns

6 Servo Function

When in Servo mode the analog signal path of the VGA, filter and ADC, as shown in Figure 32, share the same circuitry that is used by the channel in Read mode. The analog filter has separate and programmable cutoff and boost values that are enabled when SGATE is asserted. The digital servo block uses an asynchronous clock (i.e. no phase or frequency coherence to servo data) that is programed to a sample rate of 8X, 10X or 12X multiples of the servo synchronization frequency. The clock is generated by a dedicated PLL servo synthesizer, which is programmed to achieve the desired oversample rate.

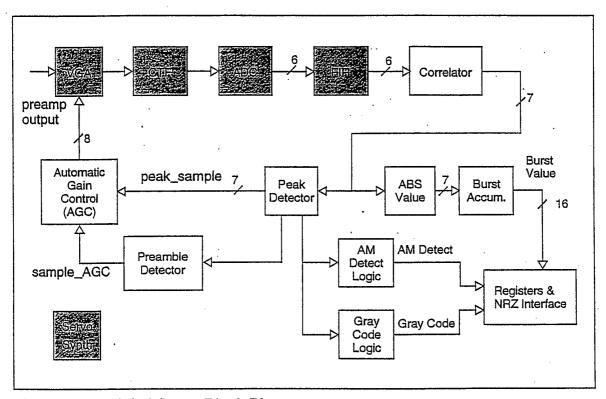


Figure 32 Digital Servo Block Diagram

6.1 Correlator

The correlator circuit, shown in Figure 33, is a simplified matched filter that is used to detect di-bits. This circuit suppresses DC shift, low frequency noise and second harmonic distortion such as amplitude asymmetry in MR heads. The correlator is a FIR filter producing an output of $x_{k+n}-x_k$, where n can be programmed to 4,5 or 6 to match over-sample rates of 8X, 10X or 12X respectively.

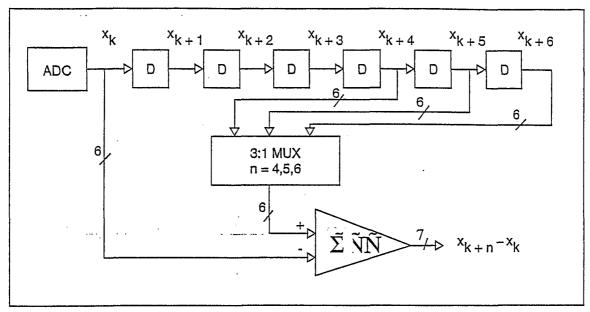


Figure 33 Correlator Block Diagram

Figure 34 shows the correlator transfer function in the frequency domain.

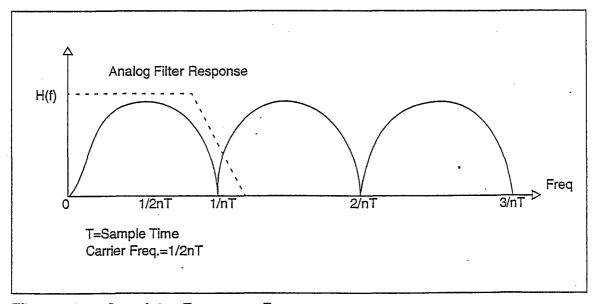


Figure 34 Correlator Frequency Response

6.2 Preamble Detector or 1's Detect

This block enables address mark detection when a valid Servo preamble is detected. It contains the control logic that generates the signal, sample_AGC, which is an input to

the AGC block. The preamble detect block is configured in several different modes, depending on which search mode is current. For further explanation of the search modes see Section 6.4, Section 6.5, Section 6.6 and Section 6.7.

Register R[*]1, is programmed with the number of consecutive di-bits that must be detected to qualify as detected preamble. Register R[*]2, contains a bit to disable the preamble detector. Either a micro or a timer enables the preamble detector to begin the search, and the circuit waits for a peak to be detected. When a peak is found the circuit will look for the another peak to occur within a given window. The size of the window is based on the over-sample ratio. When peak is detected outside of the expected window, or if the peak isn't detected within the window at all, the detector will reset and start the process over. However when a valid peak is detected, a second counter is incremented. When this second counter is equal to the value programmed in register R[*]1, the preamble_detected signal is asserted. This_signal remains active until an address mark has been detected, or until the search has been terminated.

The sample_AGC signal has three different modes of operation; it can be manually controlled with a register bit, it may be configured to auto sample after each successful preamble detection, or a normal mode that is used in oriented search mode where sample_AGC will be active after the "start search" bit is set. See the examples below.

6.3 AGC Block

The AGC block receives the sampled value of "peak_sample" from the peak detector and calculates a correction that is input to the VGA. The gain DAC in the AGC block is only updated when the signal, sample_AGC, from the preamble detect block is asserted. The AGC can also be preset prior to each servo sample by initializing the AGC_preset register R[*]3. Preset occurs on the next rising edge of SGATE. During initial searches when SGATE is always active, initializing the preset Register will generate an update of the gain DAC. If the preset register is loaded when SGATE is switching, the new value will update the GDAC on the next rising edge of SGATE.

The AGC block has a linear, and non-linear mode. Four gain bits control the gain as a function of the mode selected. Register R[*]4, an eight bit signed number is used to preset the AGC correction value. Register R[*]5 is programmed with the desired target AGC peak value, which is compared to the peak samples, with the difference being the AGC error. The AGC error is scaled as a function on the gain settings, then added to the previous AGC correction. The AGC correction is then formed from numerically integrated gain errors. The AGC correction input to the VGA is an eight bit unsigned number centered around 80H. The AGC_sample signal may be forced active by register control, when used for an initial search. Register R[*]6 is used to program the number of corrections to be made in normal and auto-sample modes. Examples of how the hardware and software may be used in different search modes is shown in Section 6.4, Section 6.5, Section 6.6 and Section 6.7.

6.4 Unoriented Search Mode

- 1. Get out of the latch.
- 2. Force SGATE active using the "timerset" register in the controller.
- 3. Preset AGC gain to a high value, set AGC to non-linear mode.
- 4. The bit register R[*]10 in the channel comes up reset so that the preamble detect logic is enabled on power-up.
- 5. Set Force AGC bit, register R[*]11, for manual mode. This allows the AGC loop to run during the entire time that the servo gate is active. Due to the use of non-linear mode AGC, the loop should acquire relatively quickly over servo data and move to only moderately higher gain over non-servo data.
- 6. Set uP Search bit, register R[*]12. This will start the preamble detector. When the preamble is detected, the address mark detect logic will be enabled.
- 7. After the address mark has been detected, clear the uP_Search bit, register R[*]12. In this mode, the search will be controlled by the microprocessor by setting and clearing this bit.
- 8. Complete the normal AMET/GRAY CODE qualification code algorithm that is currently in use. In this mode the search is still controlled by the controller, using the uP_Search bit in the SCA8700. After a number of address marks found, we may switch the enable_auto_sample bit, register R[*]13, to the Auto-sample mode setting, which clears the force-AGC bit. This will enable the logic that will generate a sample_AGC window after the preamble is detected for the number of di-bits programmed in the AGC_sample_val register R[*]14. After the qualification is complete, switch to oriented search mode.

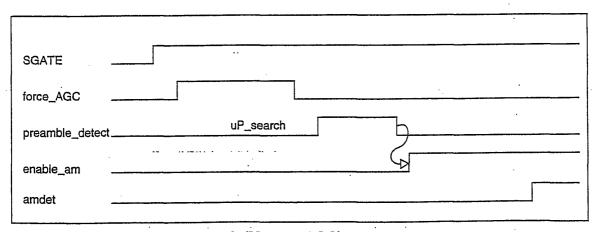


Figure 35 Unoriented Search (Manual AGC)

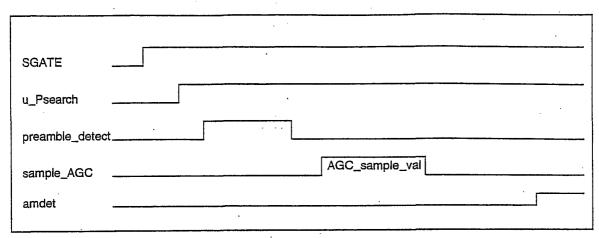


Figure 36 Unoriented Search (Auto Sample AGC)

6.5 Oriented Search Mode

- 1. Set en_amsync bit in the channel and in the controller to enable the timer controlled searches. These are two separate bits with the same name that have the same function. This assumes that the timers have all been programmed in the controller.
- 2. Clear the register R[*]20<> bit and set the register R[*]21<> bits. Setting the register R[*]register R[*]21<> bit puts the sample AGC logic in the normal AGC mode. This enables sample_AGC for the number of di-bits programmed in the register R[*]22. This register may have to be reprogrammed if the number of sample di-bits is different than the number required in the auto-sample mode. In this mode, the sample_AGC window will start after the start search (spin_comm) timer goes active.

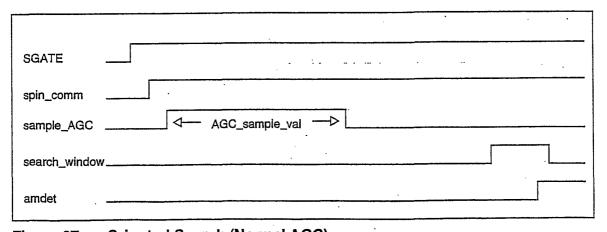


Figure 37 Oriented Search (Normal AGC)

6.6 Head Switch (option 1)

- 1. Switch heads. This occurs between servo bursts.
- 2. Preset AGC to high gain in the channel, non-linear AGC with high gain. The logic will remain in normal AGC mode.
- 3. Increase the AGC_sample_val in the channel to allowing more time to acquire. (What would be the maximum required number of di-bits?)
- 4. Reprogram SGATE and spin_comm timers to allow the use of more preamble. (Write to read recovery area.)
- 5. After first address mark, reprogram timers and AGC_sample_val back to normal values. Set the AGC back to linear mode and normal gain.

6.7 Head Switch (option 2: worst case scenario)

- 1. Switch heads.
- 2. Force SGATE active using the timerset register in the controller.
- 3. Preset AGC to high gain, non-linear AGC. Set AGC in non-linear mode, same as unoriented search.
- 4. Set Force_AGC bit in channel. Controller timers will still be in oriented search mode, wider window.
- 5. Wait for AMDET to interrupt to the uP, then clear the Force_AGC bit in the channel. Normal AGC operation will continue from this point.

6.8 Peak Detector

The function of the peak detector is to derive a signal, peak_samples, that is used for the AGC. Other peak detector outputs are; peak found and threshold crossed. The input to the peak detector is sample and sample_minus1 signals from the correlator. The peak detector only detects positive peaks. The incoming samples are compared to a programmable threshold, and when either a positive or negative sample crosses the threshold, the threshold_crossed output will be set. This signal remains set until the peak is found. The peak is found using the following algorithm: Wait until threshold_crossed is true. Then wait until the current sample is less than the previous sample, sample_minus1, indicating that the peak has been reached. Next, there are two sample pairing conditions to be considered. If the sample_minus1 is less than the sample_minus2, then the peak occurred at sample_minus2, or if the sample is less than the sample_minus1, then the peak occurred at sample_minus1. When the peak sample is found, the peak_found signal is asserted, and at the threshold_crossed signal is cleared. The peak_found signal will remain active for one sample clock period.

There is an input to the peak detector, sample AGC, which is output from the preamble detector. When this signal is asserted, the value of each detected peak will be registered on the peak_sample output, one sample clock after the peak_found signal is asserted. This is the value used by the AGC block to generate a gain correction.

6.9 Address Mark Detect

This circuit is designed around a programmable address mark of nine bits. The address mark is defined by programming 9 bits composed of registers R[*] and R[*]. Table 9 illustrates the address mark format. In this example a written pattern of 8 zero's, followed by a di-bit is represented.

Table 9 Servo Address Mark Format

8	7	6	5	4	3	2	1	0
R[*]<0>	R[*]	R[*]<6>	R[*]<5>	'R[*]<4>	R[*]<3>	R[*]<2>	R[*]<1>	R[*]<0>
0	0	0	0	0	0	0 .	0	1

The address mark detector also contains a voting circuit that can be enabled to allow a finite number of errors to occur within the address mark. The number of allowed errors is programmed in register bits R[*]18. After a servo event, it is possible to poll register bits R[*]19 to determine how many errors were made in the previous servo event. Refer to Table 10 for details.

Table 10 Servo Mark Detection Settings

R[*]	Number of Allowed Errors
00	0
01	1
10	2
11	N/A

R[*]	Actual Errors Detected
Bit 7	0 Errors Detected
Bit 6	1 Error Detected
Bit 5	2 Errors Detected
	•

Figure 38 shows a 10 MHz servo waveform with the address mark and the correct polarity for the address mark di-bit.

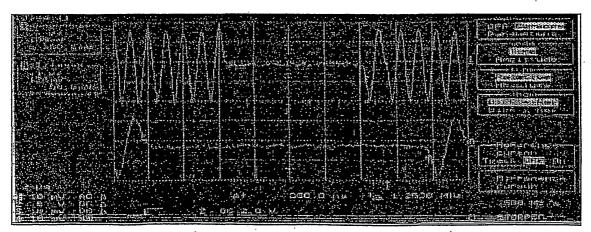


Figure 38 Servo Address Mark Polarity

6.10 Gray Code Detector

The Gray code detector has four functions: to detect the Gray code bits, to generate a Gray clock, to store the Gray code data in a shift register and to generate the gray_endb signal. The gray_decode block is clocked by a counter (gray_cnt) that increments on each falling edge of the sample count. This counter is held preset when AMDET is low and is reset at the end of each di-bit cell/window. The preset value can be programmed in the gray_end_val register R,[*], and is adjusted based on the oversample ratio. The reset value is determined based on the sample rate selected. Once the address mark is detected, the Gray code detector is enabled, and the timing of the detector is (becomes) relative to the peak of the address mark di-bit. Keep in mind that the AMDET signal has a resolution of +/-1 half rate clock, which is 1/2 the oversample frequency.

The Gray data flip-flop is set any time that a peak is detected and is reset at the start of every di-bit window (when gray_cnt=0). The Gray clock is generated 1/2 sample clock prior to the end of the cell. The Gray clock is used to shift the data into the Gray code shift register. If no address mark is detected, the shift register will contain the data from the last burst.

The gray_endb signal determines how many Gray codes are to be shifted in. This value is programmable with the gray_end_val register, which is compared to a counter that determines the number of gray clocks that have occurred.

Example:

Sample rate=12x=6 clocks per di-bit Gray_preset=2 Gray_cnt=0-5 Gray_cnt=0=reset gray data FF Gray_cnt=5=gray clock

6.11 Reset AMDET Timer

This timer runs off of the reference clock and the counter is reset with a synchronized AMDET signal. It can be programmed with a 12-bit value for the time the AMDET signal is reset. The rst_amb signal resets AMDET, and also resets or re-enables several other functions within the digital servo block.

Time desired in ns is R[*]30<> x T_{FREF} Note: The resolution is +/-1 T_{FREF} due to the synchronization of the AMDET signal, which resets the counter.

6.12 Demodulator (Demod)

The Demod block calculates the values for the A,B,C, and D position bursts. This function accumulates the magnitude of all of the samples in the accumulation window to

measure the area of a burst. The strobe signal from the controller enables a counter clocked by the sample clock. The counter is used as a 2-edge timer that opens a window to enable the accumulator. Two 6-bit registers control the timer, called start_accum and stop_accum. When the window is open, the accumulator sums the absolute value of the output samples of the correlator. There are four separate adders, 2 pairs that are interleaved, one that sums the two samples and one that accumulates the output of the first adder. When the en_accum signal goes inactive, an additional adder sums the output of the two interleaved accumulators. There is additional clock delay that will have to be considered when centering the windows around the bursts. The peak_found and en_accum signals come out on a test pin and should be useful in centering the sample windows.

From the rising edge of the strobe signal, the en_accum signal goes active after the number of clocks programmed in register R[*]40. When programming the start register, one needs to account for the preload required by the correlator of half of a di-bit. The value programmed in the stop_accum register should allow the signal, en_accum, to go inactive 2-3 clocks prior to the falling edge of strobe. This will allow time for the final addition and setup of the output latch. The accumulator is cleared 2 to 3 sample clocks after the falling edge of the strobe. The clear signal to the accumulator is deasserted 2 sample clocks later. This means that the strobe is deasserted a minimum of 5 sample clocks.

6.13 Data Transfer

The Data Transfer block controls the NRZIO bus during a servo burst. The state machine is clocked by the negative edge of RCLK. When the servo address mark is detected, the NRZIO interface receives data from the servo. In this state, data is set to all zeros. The state machine is controlled by a synchronized version of the strobe signal (synchronized to RCLK). The state machine waits for the first transition (rising edge) of the strobe signal, A_burst. On the next falling edge of RCLK after the rising edge of the strobe the NRZIO output is a sync byte, followed by the 3 bytes of Gray code, followed by all zeros again. The sync byte out will be the same sync byte that is used by the channel. All data will be clocked out on the falling edge of RCLK. On the falling edge of the first strobe, the channel will output a sync byte, followed by the two bytes of data. This will be repeated for the B,C and D. The data transfer after the D burst will have 1 additional byte that will be a status byte from the channel.

Note that the inactive time between strobe pulses must be at least 1 RCLK cycle to ensure proper operation of the data transfer. RCLK is a divided down version of the read synthesizer and is "gapped" to account for the channel code rate. So for a 16/17 rate channel, RCLK has three spacings of 8T, followed by one spacing of 9T. The worst case RCLK spacing is: 1/(channel rate) *9, where the channel rate is 17/16 * NRZ Rate.

7 Common Functions

Common functions are functions that are shared by the read, write, and servo sections of the channel. They consist of the NRZ data interface, R/W, and servo clock phase-locked loops (PLL) and the serial data interface.

7.1 NRZI Read-Write-Servo Interface

Read or write data is transferred to or from the controller by means of a byte-wide NRZIO bus. Read mode transfer and Write mode transfer timings are shown in Figure 39 and Figure 40.

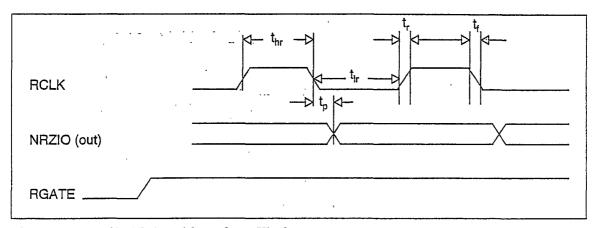


Figure 39 NRZI Read Interface Timing

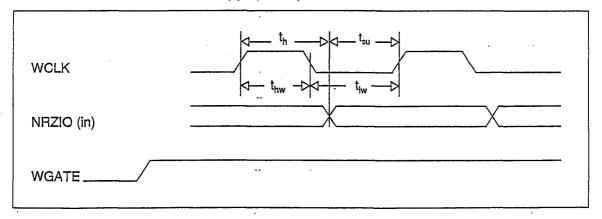


Figure 40 NRZI Write Interface Timing

While Figure 39 and Figure 40 show byte-wide data being clocked to and from the channel on the rising edge of the clock, the polarity of the RCLK and WCLK signals may

be altered by programming registers 20<4> and 20<5>, so that data may be clocked on either edge. Interface timing rules are defined in Table 11.

Table 11 NRZIO Interface Timing

Parameter	Sym	Condition	min.	max.	Units
RCLK, NRZIO rise/fall time	t _r &t _f	20-pF output load, 10-90%		3.7	ns
RCLK to NRZIO delay	t _p	Falling edge of RCLK to NRZ out		3.5	ns
NRZIO setup time	t _{su}	NRZ data valid to rising edge of WCLK	3		ns
NRZIO hold time	t _h	Rising edge of WCLK to NRZ data invalid	2		ns
RCLK high time	t _{hr}	Period RCLK is high	4	5	15/16 bit period
RCLK low time	t _{ir}	Period RCLK is low	4	6	15/16 bit period
WCLK high time	t _{hw}	Period WCLK is high	4	5 .	bit period
WCLK low time	tiw	Period WCLK is low	4	5	bit period
RCLK and WCLK periodicity		(8+9+8+9+8+9) = 51 PLL clock edge	s		
Direct Write mode WCLK periodicity		(8+8+8+8+8+8) = 48 PLL clock edge	s 		

A one-period ambiguity exists in RCLK high and low times. This constraint is reflected in the clock times listed in Table 11.

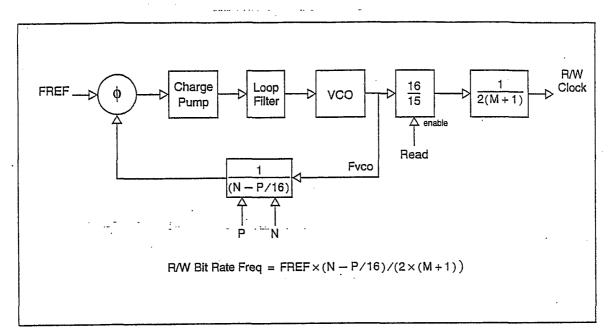
7.2 PLL Synthesizer - Clock Generation

The SCA8700 channel utilizes a single phase-locked loop (PLL) to synthesize Read mode and Write mode, (R/W) clock signals. A second PLL is used to synthesize Servo mode clock signals. Both PLL designs are identical, with the exception of a 16/15 frequency translation function that is added to the R/W PLL. The designs have been optimized for high bandwidth, fast lock-on operation and extremely low jitter output.

7.2.1 R/W Clock

The R/W synthesizer block diagram is shown in Figure 41, and the specifications follow in Table 12. The PLL output frequency is determined by Equation 2, which is also shown in Figure 41.

Referring to Figure 41, FREF is an external reference input frequency, and N, P and M are integers. The output bit-rate frequency is programmed by loading the 91<5:0>, the 90<7:4> and the 90<2:0>registers.



FREF should be between 20-80MHz in increments of 5Mhz.

Figure 41 Read Mode/Write Mode PLL

The operation of the R/W PLL is as follows: The VCO output frequency, Fvco, which is in the range of 800-1600 MHz is divided by a fractional divider of factor (N - P/16), and then phase-compared to an input reference frequency FREF, by means of a phase detector. Use of the fractional divider allows the phase detector to sample the phase error at a high rate, providing faster lock-on times with lower VCO phase jitter. The PLL R/W clock output is obtained by dividing Fvco by 2(M+1) using a digital divider. The user must set the R/W clock frequency to be the same as the desired encoded bit-rate. When the PLL provides the Read mode clock, a 16/15 frequency translation circuit is automatically inserted in the clock path to increase the clock rate by 6.66% (the bit-rate is unchanged). This provides an oversampled clock for use by the interpolated timing recovery (ITR) circuitry.

7.2.2 Servo Clock

The Servo PLL block diagram is shown in Figure 42, and the specifications follow in Table 12. The Servo PLL is similar to the R/W PLL in form and operation. A separate and complete set of registers are used to program the Servo PLL.

The PLL output frequency is determined by Equation 3. The Servo output frequency is programmed by loading; the 91<5:0>, 90<7:4> and 90<2:0> registers.

When a non standard FREF frequency is employed then Equation 3 is used to find P_S , M_S , and Lp_S values, subject to constraints of Equation 3.

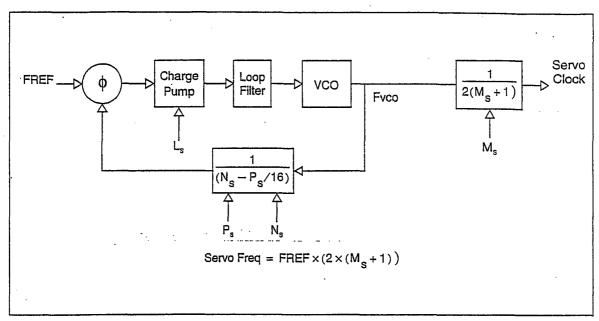


Figure 42 Servo Mode PLL

Table 12 Clock Synthesizer Specifications

Parameter	Symbol	Min	Max	Register(s)	Notes
Reference Frequency	FREF	20MHz	80 MHz	98<7:4>	in steps of 5Mhz
VCO Frequency	Fvco	800 MHz	1600 MHz		Fvco = FREF x (N-P/16)
Write or Servo Clock		53.125 MHz	800 Mhz		
Settling Time			10 usec		
Absolute Jitter			15 psec		1 sigma
Register Settings - Rea	d Mode/Wr	ite Mode:			
N Divide Value	N	12	48	N= 91<5:0>	
P Divide Value	P	0	15	P= 90<7:4>	
M Divide Value	М	0	7	M= 90<2:0>	
Register Settings - Serv	o Mode:				
N _s Divide Value	Ns	12	48	N _S = 93<5:0>	
P _S Divide Value	Ps	0	15	P _S = 92<7:4>	
M _s Divide Value	Ms	0	7	M _S = 92<2:0>	

7.2.3 Setting the PLL R/W and Servo Frequencies:

The PLL R/W output frequency follows the relation:

$$RW FREQ = NREF \times (N - P/16)/(2 \times (M + 1))$$
 (2)

The PLL Servo output frequency follows the relation:

Servo Freq =
$$FREF \times (N_S - P_S/16)/(M_S + 1)$$
 (3)

The N (N_s) and P(P_s) values should be chosen so that:

$$700 \text{ MHz} \le \text{FREF} \times (N - P/8) \le 1600 \text{ MHz}$$
 (4)

7.3 Serial Register Interface

The serial interface allows communication between the controller and the internal control registers of the device. Any given internal control register may be read-only (R), write-only (W) or both read and write (RW).

The serial interface communicates by means of three control pins, SDEN, SDATA and SCLK, by using the transfer protocol shown in Figure 43 with port timing rules specified in Table 13. The interface controller arbitrates the transfer and is always responsible for setting the direction of the transfer, for generating the address bits and for generating the clock. The transfer protocol is structured as an 18-bit word. The first bit is used to indicate a write-to or read-from the device. The next eight bits function as address bits, with the LSB sent first. A dummy "turn-around" bit is added in the middle of the bit stream to allow time for a direction change on the bus. Eight data bits follow either to or from the device, depending on the direction of the transfer.

During a register write operation, SDEN is asserted and serial data on the SDATA pin is clocked to the device on the positive edge of SCLK. After the 18-bit sequence is complete, byte-wide data is transferred to the selected device control register on the negative edge of SDEN.

During a register read operation, the bus direction and the address are clocked into the device on the positive edge of SCLK. After the turn-around bit, the device assumes control of the SDATA line and places the contents of the requested register, LSB first, to SDATA on the falling edge of SCLK.

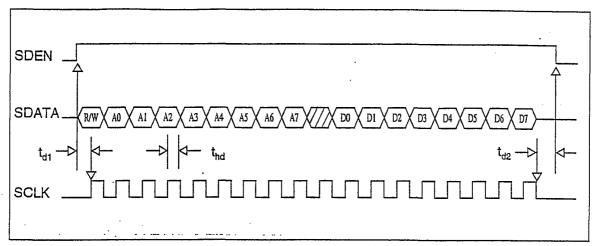


Figure 43 Serial Port Timing

Table 13 Serial Port Timing Specification

Parameter	min.	max.
t _{d1}	5 ns	
t _{d2}	5 ns	
t _{hd}	10 ns	

A more complete specification of the serial interface timing rules is found in Table 27.

8 System Operation

This section details the system operation of the SCA8700. Descriptions of the events that comprise the Read mode, Write mode and Direct Write modes are provided. Emphasis is placed on the timing rules that are in effect when transitioning from one mode to another.

8.1 Read Mode Sequence

An overview of a typical track architecture is shown in Figure 44. The first field, the preamble, consists of a series of 2T-spaced transitions, with T being the encoded bit period. The preamble readback pattern input to the ADC is a sine wave of frequency 1/4T. The SCA8700 is designed for a preamble length of 96 bits, although shorter and longer preamble lengths may be used. If the preamble field is less than 80 bits, the timing and gain synchronization may become unreliable. The preamble field is a known reference pattern that is used to set up timing, gain and DC-restore loops. Because the preamble is a single frequency, it cannot be used as a reference to adjust the self-adaptive FIR equalizer.

A sector read operation begins with the assertion of RGATE. The timing loop cycle consists of three phases, dividing the preamble into distinct regions: zero-phase restart, fast-acquire and data tracking. During the first phase, zero-phase restart, the initial phase of the timing loop is adjusted. The second phase, fast-acquire, is primarily used for frequency acquisition. After the first and second phases, the timing loop phase-frequency is close to the target phase-frequency value and within the capture range of the third and final phase, data-tracking. During tracking, the timing loop response is adjusted to be slow responding, requiring many averaged data samples to generate significant clock timing adjustments. Tracking mode is used for accurate and jitter-free data clock regeneration when reading user data.

The AGC loop operates throughout all three timing phases. However, the loop gain of the AGC is increased during the zero-phase restart and fast-acquire phases so that channel gain is close to the correct value before entering tracking mode. The AGC tracking phase adjusts the gain very slowly throughout the user data and requires an average of many samples to significantly change the gain setting.

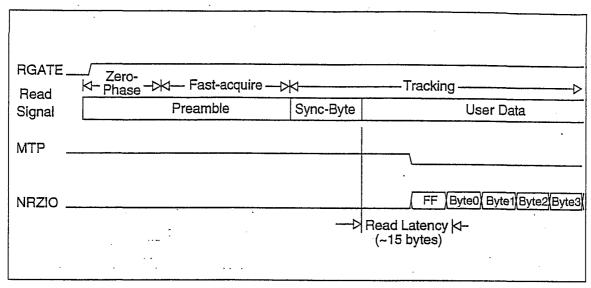


Figure 44 Read Mode Sector Architecture

8.1.1 Control Loop Acquire Sequence

Programmable counters within the SCA8700 are used to define the time intervals for each phase of the acquire sequence. Acquisition timing periods may be adjusted for preamble lengths up to 500 bits by programming the counter-timers described in Figure 45. The range of values allowed for each counter is specified in Table 14.

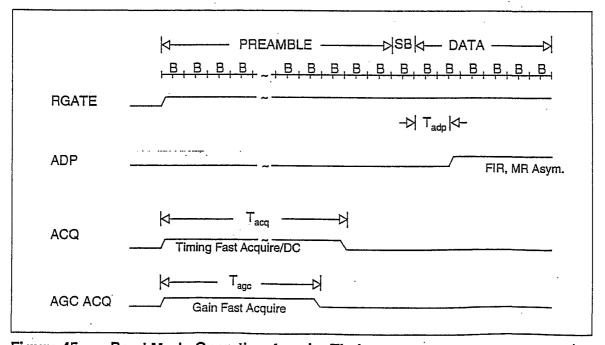


Figure 45 Read Mode Operation Acquire Timing

Table 14 Counter Values

Delay	Description	Range	Register	Default
T _{adp}	FIR self-adapt	fixed		
Tacq	Timing and DC Fast Acquire	0-127 nibbles	09<6:0>	
T _{agc}	AGC Acquire	0-127 nibbles	0A<6:0>	

8.1.2 Data Read Mode

A sector read operation begins with the assertion of RGATE. The SCA8700 cycles through the loop acquire sequence described in Section 8.1. After the sequence is completed, timing and gain control loops have converged and the tracking mode is entered. The device begins detecting data and searches for a unique sync-byte pattern in the bit-stream. The sync-byte is a special pattern used as a marker to indicate the start of user data. Once the sync-byte has been detected, an FF_h byte is output on the NRZIO bus. Subsequent detected and decoded user data bytes continue as output for as long as RGATE is asserted.

Approximately 16 bytes of read data latency are associated with a read operation as shown in Figure 46. As a consequence, when RGATE is de-asserted at the end of a sector, 16 bytes of data are left to be transferred to the controller. This residual data can be transferred using one of two methods, as selected by register 04<0>. The first method is for the controller to assert RGATE after the physical end of sector data, until the entire sector has been transferred. This is adequate provided the end of sector gap is greater than 16 bytes.

Using the second method, RGATE is de-asserted at the end of the sector. The device internally extends RGATE to flush out the residual data that is in the data path. When reading consecutive sectors, the combined length of the sector gap, the preamble length and the sync mark must be longer than the 15 byte read latency, and the controller must be able to accept NRZ data even after RGATE has been de-asserted.

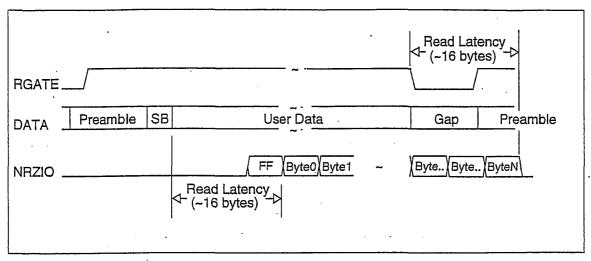


Figure 46 Read Mode Gate Extension

8.2 Write Mode Sequences

Data may be transferred from the controller to the NRZIO interface, through the SCA8700 to the write preamp by two basic methods, called Normal and Direct modes. Both methods have selectable options that modify how write data is processed.

8.2.1 Normal Write Mode

A normal Write mode operation is initiated when WGATE is asserted. A series of 00_h bytes are sent from the controller to the device on the NRZIO interface. The encoder output is a series of 2T-spaced transitions that generate the preamble. The preamble is continued for as long as 00_h bytes are sent to the interface. When an FF_h byte appears on the NRZIO interface, write logic output is a sync-byte in place of the FF_h, followed by encoded user data lasting the duration of WGATE assertion. Write data is subsequently precompensated and transferred to the PECL output stage. The Write path latency is 9 bytes. Data may be clocked to the device on the NRZIO interface on either the rising or falling edge of RCLK depending on the setting of register 20 < 4 > = 1. Figure 47 defines the timing of a normal Write mode operation.

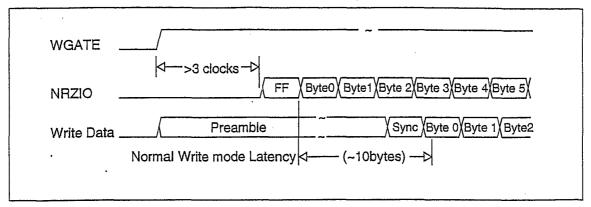


Figure 47 Normal Write

8.2.2 Direct Write Mode

In a manner analogous to the normal Write mode, WGATE is asserted; however, the encoder and scrambler are bypassed by setting register 20<1>=1 and the write precoder is bypassed by setting register 20<1>=1. NRZIO data is serialized, precompensated and then transferred directly to the PECL output without modification.

The controller sends a sequence of 00_h bytes, followed by one FF_h byte. This is followed by the continuation of user data for as long as WGATE is asserted, the FF_h byte is not transferred. Figure 48 shows the write sequence for a Direct Write mode operation.

If a Read mode operation is desired after a Direct Write mode, the write data placed on the NRZIO interface must contain the preamble, sync-byte, encoded data and any necessary ECC bytes.

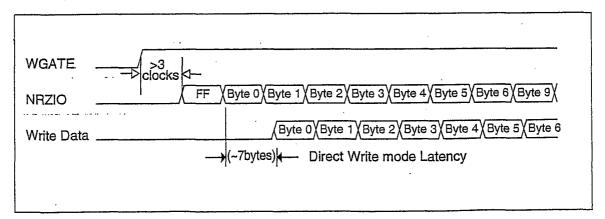


Figure 48 Direct Write

8.3 System Timing Constraints

A system timing diagram is shown in Figure 49 and timing rules are listed in Table 15.

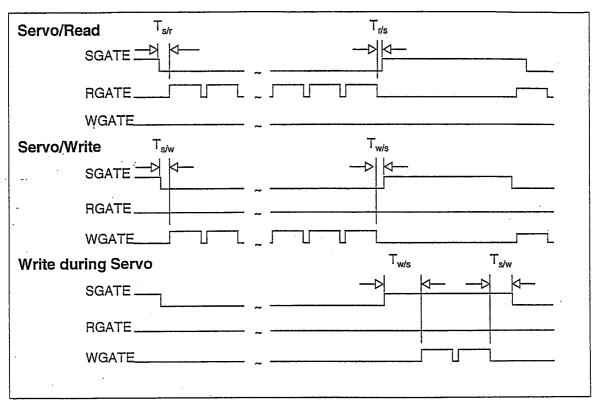


Figure 49 System Operation

Table 15 Timing Rules

Parameter	Min time	Description Servo to Read		
T _{s/r}	24 Read mode PLL Clocks			
T _{r/s}	24 Read mode PLL Clocks	Read to Servo		
T _{s/w}	24 Read mode PLL Clocks	Servo to Write		
T _{w/s}	24 Read mode PLL Clocks	Write to Servo		
T _{w/s}	24 Read mode PLL Clocks	Servo mode to Write mode/Servo mode		
T _{s/w}	24 Read mode PLL Clocks	Write mode/Servo mode to Idle mode		
T _{w/w}	24 Read mode PLL Clocks	Write mode to Write mode		
T _{r/r}	24 Read mode PLL Clocks	Read mode to Read mode		
T _{s/d}	500 ms	Suspend mode to Doze mode .		

Table 15 Timing Rules (cont'd)

Parameter	Min time	Description
Td/i	100 μs	Doze mode to Idle mode
Ti/s	24 Read mode PLL Clocks	Idle mode to Servo mode
Ts/i	24 Read mode PLL Clocks	Servo mode to Idle mode
Tr/i	24 Read mode PLL Clocks	Read mode to Idle mode

8.4 Write Mode to Idle Mode Recovery

When WGATE is asserted, the series switches shown in Figure 4, that are connected between the VGA input pins and the VGA circuit are set to an open or high impedance (HiZ) state. The timing diagram of the recovery sequence appears in Figure 50. The high impedance state prevents write voltage transients from entering the VGA and overloading the analog signal path. The HiZ condition is maintained for the duration of WGATE and is extended past the de-assertion of WGATE for a programmable length of time, T_{HR} , set in register R,[TBD].

In addition, a shunt resistance connected in parallel with the VGA inputs, is set to a low impedance value (LoZ) during WGATE. The LoZ period starts 50 ns before the end of HiZ and extends for a period of time, T_{LR} , set in register R,[TBD].

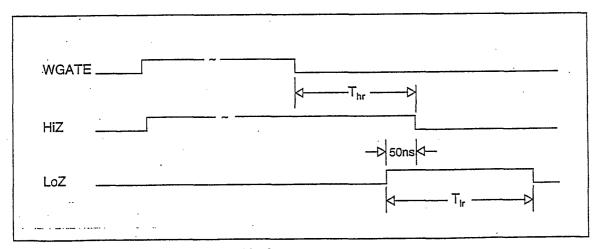


Figure 50 Write Mode to Idle Mode Recovery

Table 16 Write Mode Recovery Squelch Timings

Parameter	Description	Time / Resistance
T _{hr}	Time VGA input-open is active after WGATE	50 ns x R,[TBD]
T _{lr} .	Time VGA input-LoZ active after (Thr -50 ns)	50 ns x R,[TBD]
	Select 200, 400,1K or 2K Ohms for shunt LoZ	R,[TBD]

8.5 Channel Quality Monitor (CQM)

The functions shown in Figure 51 may be used to collect statistical data on the overall performance of the magnetic recording channel.

(000)
$$\hat{e}^2 = \sum_{n} [y_n - \hat{x}_n]^2$$

(001)
$$e^2 = \sum_{n} [y_n - x_n]^2$$

(010)
$$e_0^2 = \sum_n [y_n]^2$$

(011)
$$N(T_L, T_H) = \sum_{n} I(T_L < y_n < T_H)$$

(100)
$$N(e^2) = \sum_{n} i \left\{ [y_n - \hat{x}_n]^2 > T_{\hat{e}^2} \right\}$$

(100)
$$N(e^2) = \sum_{n} I \left\{ [y_n - x_n]^2 > T_{\hat{e}^2} \right\}$$

MSE1 referenced to estimated sample value

MSE2 referenced to known sample value

MSE3 - error signals

Surface analysis

Histogram 1 referenced to estimate

Histogram 2 referenced to known sample value

Where:

yn is the parameter being measured

 \hat{x}_n is the estimated noise free sample value

 \boldsymbol{x}_n is the known noise free sample value

a_n is the known data

I(•) is the index function, = 1 if I is true else 0

T_n are programmable thresholds

 $z_n = 1$ if decoder output byte n in error, else 0

$$(101) \quad \text{N(e}^2) = \sum_n I \Big(y_n^2 > T_{\hat{e}}^2 2 \Big) \qquad \text{Histogram 3}$$

$$(110) \quad \text{N(E)} = \sum_n I(z_n > 0) \qquad \qquad \text{Error Rate}$$

$$(111) \quad \text{D(y)} = \sum_n (y_n \times a_n) + (y_n \times (a_n - 1)) \qquad \text{DiBIt Extraction}$$
 Where:
$$y_n \text{ is the parameter being measured}$$

$$\hat{x}_n \text{ is the estimated noise free sample value}$$

$$x_n \text{ is the known noise free sample value}$$

$$a_n \text{ is the known data}$$

$$I(I) \text{ is the index function, } = 1 \text{ if I is true else 0}$$

$$T_n \text{ are programmable thresholds}$$

$$z_n = 1 \text{ if byte/bit n in error, else 0}$$

Figure 51 Channel Quality Measurements

The active measurement function is selected by the FUNSEL register, 70<2:0>, as defined by Table 17.

Table 17 Channel Quality Functions

FUNSEL register 70<2:0>	Function
0000	MSE1, Squared error of received sample minus estimated sample (slicer)
0001	MSE2, Squared error of received sample minus known sample (known data mode)
0010	MSE3, Squared error of selected parameter
0011	SAT, Surface analysis testing
0100	Histogram 1, referenced to estimated samples (slicer)

Table 17 Channel Quality Functions (cont'd)

FUNSEL register 70<2:0>	Function
0101	Histogram 2
0110	Histogram 3
0111	Error rate
1000	Di-bit Extraction .

The parameter to be measured is selected by the MONSEL register, 70<6:3>. Taken together, the values of the FUNSEL and MONSEL registers define a CQM test. The combination of function and parameter that are supported are shown by an "X" in Table 18.

Table 18 Quality Monitor Test Matrix

Test Register MONSEL 70<6:3>		FUNSEL register 70<2:0>								
		MSE 1 0000	MSE 2 0001	MSE 3 0010	SAT 0011	HIST 1 0100	HIST 2 0101	HIST 3 0110	Error 0111	Di-bit
0000	ITR Data	X	X		Х	X	X			Х
0001	Gain Error			Х				X		
0010	Timing Error			Х				Х		
0011	DC Restore Error			Х				X	•	
0100	MR Asym. Error			X			,	X		
0101	FIR Adpt. Error			X				X	<u> </u>	
0110	Sector Errors 1								X	
0111	Sector Errors 2								X	
1000	VA Bit Error				-				X	
1001	Slicer Bit Error								X	
1010	ECC BER								X	

8.5.1 The CQM State Machine

CQM measurements are controlled by a finite state machine (FSM) that manages the selected test. The FSM state diagram is described in Figure 52, allowed state transitions are listed in Table 19 and state variables are specified in Table 20.

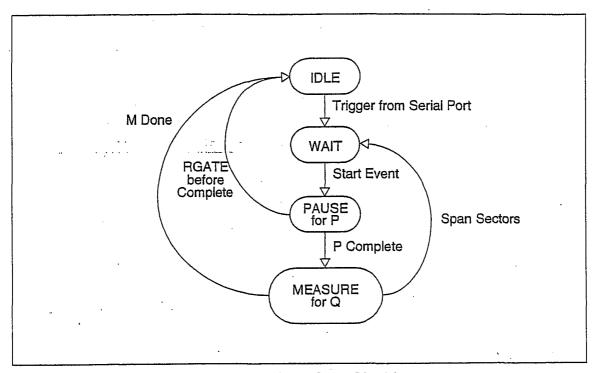


Figure 52 Measurement Interval Timer State Machine

Single sector operation is described in Figure 53. The measurement sequence is initiated when register 68<5> is set to 1. This event resets the state indicators and the P,Q and M counters. The FSM advances to the WAIT state where it waits for an RGATE assertion or a sync-byte-found signal depending on 68<4>. When the selected condition occurs, the FSM advances to the PAUSE state where a delay timer, P, counts P bits before transitioning to the MEASURE state. As a precautionary check, if the FSM is in the PAUSE state when RGATE is de-asserted, an error flag, register 68<0>, is set to 1 and the FSM returns to Idle mode.

While in the MEASURE state, data collection is enabled and parametric test data is accumulated in a 20-bit-wide register, called the M accumulator. Only the top 16 bits of the register are accessible through the serial port. An overflow condition is indicated by all the bits in the register being set to 1. A unit counter, or Q counter, is enabled to keep track of the number of measurements processed. The Q counter and the M accumulator are active until the end count, in registers 6A <7:0> and 6C<7:0>, is reached or RGATE is de-asserted.

Normally, measurement data accumulates until the end of sector, signalled by the end of RGATE. However, if 68<1>=1, data will accumulate until the end count of the Q counter, 6A<7:0> and 6C<7:0>. The FSM returns to Idle mode, and the measurement value, contained in the M accumulator, and the number of measurements made, contained in the Q counter, may be retrieved through the serial interface.

Multiple sector operation is described in Figure 54. If 68<1> = 1 and if the end count is not attained when RGATE is deasserted, the FSM returns to the WAIT state and will continue to collect more data on the next sector or sectors. When the Q counter end count is reached, and the required number of measurements have been made, the FSM sets indicator 68<1> to "1", and returns to the Idle mode state. With this method, the measurement may span multiple sectors.

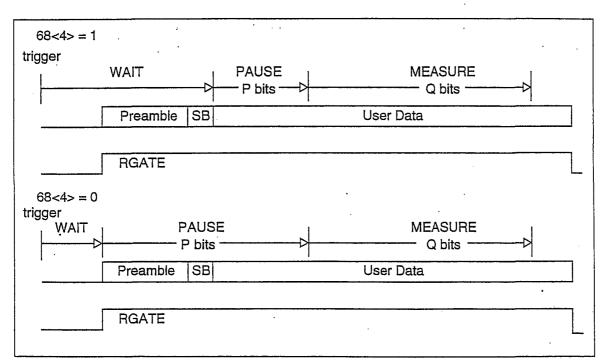


Figure 53 CQM Data Collection Sequence - single sector

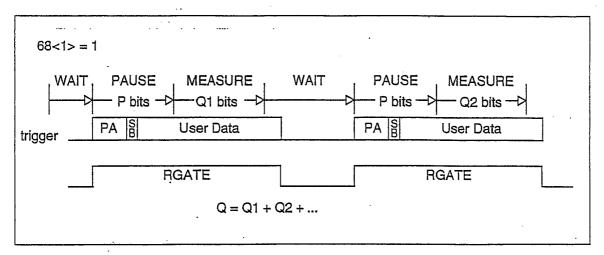


Figure 54 CQM Data Collection Sequence - multiple sectors

Table 19 CQM Measurement

Event	Definition
Trigger	Interface sets 68<5>=1. Enables and resets the state machine
Start	{on Sync-Byte found if (68<4>=1)} otherwise on RGATE assertion
P Complete	P count is complete setting 68<3> = 1
RGATE before P	RGATE ends before P setting 68<0>=1, an error indicator
Span Sectors	RGATE ends before Q and sector span is enabled, 68<1>=1
M Done	on {RGATE if 68<1> = 0} otherwise on {Q count complete which also sets 68<2> =1}

Table 20 CQM Variables

REG Variable	Definition
68<7>	trigger and reset
68<4>	start on sync-byte found enable
68<3>	P end count indicator
68<2>	Q end count indicator
68<1>	enable sector span
68<0>	error flag
69<7:0>	P end count value - Specified WAIT time (16 bit units)
6A<7:0> 6B<3:0>	12 bit Q end count value - MEASURE Sample (in multiples of 16 bits)

Table 20 CQM Variables (cont'd)

REG Variable	Definition			
6B<7:4> 6C<7:0>	12 bit Q counter value - Number of Measurements accumulator (in multiples of 16 bits)			
72<7:0> 71<7:0>	Top 16 bits of CQM 20 bit measurement accumulator (measurement)			
6D<5:0>	T _H , High Threshold			
6E<5:0>	T _L , Low Threshold			
6F<7:0>	T _E , Error Squared Threshold			
6D<7>	Sector error type			

8.5.2 Mean Squared Error

MSE1, MSE2 and MSE3 tests measure squared error. It is left to the user to calculate the real mean squared error by dividing the measured squared error by the number of measurements made, the value that is accumulated in the M counter.

For the MSE1 test, the error is calculated as the difference of the received sample output from the ITR and the estimated noiseless sample value. In the MSE2 test, the error is calculated as the difference in the received sample output from the ITR and a calculated sample derived from an onboard linear feedback shift register (LFSR). The MSE 3 test is used to measure the standard deviation of loop error signals.

8.5.3 Error Rate Tests

The M counter can be used to accumulate errors by using an number of different measures. When an error rate measurement is selected, the Q counter increments on sectors read, i.e. on RGATE deassertion. After Q sectors have been tested, the state machine transitions to the Idle mode state. Assuming 512 byte sectors, 268 million bits may be tested before the counter overflows. This allows measuring error rates to 10^{-7} errors per bit.

8.5.3.1 Sector Error Rate (Zero-Pattern Method)

An all 00_h byte data pattern is sent to the scrambler and encoder during Write mode. The 00_h byte pattern is scrambled before being encoded and written to the disk. Upon readback, the detector, decoder and descrambler invert the process to reconstruct the 00_h byte pattern. Errors are detected by the occurrence of non- 00_h bytes.

The error accumulator counts sector errors using two different criteria:

- A sector with 1 or more bytes in error, counted as 1 sector in error, 6D < 7 > = 0.
- A sector with 5 or more bytes in error, counted as 1 sector in error, 6D<7> = 1.

Statistically, for channel error rates less than 10⁻⁶ errors/bit, most sectors in error will contain only a-single error event. However, that one error event may corrupt several bytes. When a single error event causes mis-synchronization, hundreds of bytes in error may be generated. Measure (1) will count either outcome as one error. Measure (2) will count only sectors with long bursts of errors, which are probably not ECC correctable.

In order to test large numbers of bits, the CQM state machine parameter should be set to span multiple sectors.

8.5.3.2 Slicer Bit Error Rate

The output of the slicer circuit is compared to known data generated by a linear feedback shift register. For correct comparisons sector data must be written using the known-data Write mode. Bit-wise miscompares are accumulated in the M counter. In order to test large numbers of bits, the CQM state machine parameter should be set to span multiple sectors.

8.5.3.3 Viterbi (VA) Bit Error Rate

The output of the Viterbi detector is compared to known data generated by a linear feedback shift register. For correct comparisons sector data must be written using the known-data Write mode. Bit-wise miscompares are accumulated in the M counter. In order to test large numbers of bits, the CQM state machine parameter should be set to span multiple sectors.

8.5.3.4 Bit Error Rate with ECC

Sector data is written using the "zero pattern" method as outlined in the sector error rate test. Byte output from the decoder is de-interleaved into four byte interleave sequences. One of the four interleave sequences is selected to be byte-wise compared to a zero byte. Byte miscompares are accumulated in the M counter. In order to test large numbers of bits, the CQM state machine parameter should be set to span multiple sectors.

8.5.4 Di-bit Measurement

The di-bit extraction test deconvolves a pseudo-random binary readback sequence that has been written previously to a sector as data. The measurement evaluates one sector to determine one value of the di-bit function. Subsequent values are obtained by shifting the phase of the pseudo-random binary sequence (PRBS) that is used to generate known-data in the deconvolution equation.

Data must be written using known-data Write mode. That is, 20<3> bit set to 1. When a normal Write cycle is executed, the device output is a repeating PRBS data pattern that takes the place of normal encoded write data. Write data input to the NRZIO interface

from the controller is ignored. The synchronization field and sync-byte are output just as in a normal write, although a repeating PRBS is substituted for data.

On readback, the 127 bit PRBS is derived from a linear feedback shift register (LFSR) that performs the polynomial recursion, $x_{n+8} = (x_{n+7} + x_{n+3} + 1)_{mod2}$. In this extraction algorithm, the phase of the PRBS determines the time variable of the extracted di-bit function. In order to obtain all 127 values of the extracted di-bit the phase of the PRBS is incremented by changing the starting value, the seed of the LFSR contained in 73<6:0>.

For the most accurate result, measurement data should be accumulated over multiples of 127 amplitude (ITR) samples. Since the Q counter increments in multiples of 16 bits, a recommended ending value for Q is 127, which is $16 \times 127 = 2032$ bits

8.6 SNR Margining Tests

Three different methods for SNR margin testing are supported in the SCA8700 device; additive white noise, off-track interference emulation and noise multiplication.

8.6.1 Additive White Noise Test

A white noise generator circuit can be used to add noise to the readback signal at the input of the CTF, output of the VGA. This effectively lowers channel SNR and increases bit error rate. When enough noise is added so that the error rate is between 10⁻⁶ to 10⁻⁷ (errors/bit) the error rate becomes a sensitive indicator of the effect of channel parameter settings. Pre-comp, head current, equalizer settings, etc. may then be more easily adjusted to find optimal settings.

Injected noise is "white", while preamp noise may be "colored", and as a result the channel parameter settings found using this method may be only close to optimal. Because injected noise is added after the VGA, the effective SNR obtained will be relatively independent of the signal level input of the VGA, and will be repeatable to the extent that the CTF and FIR transfer functions are constant. The amplitude of the injected noise, which has a 300 MHz noise bandwidth is varied by register R,[TBD]. This can produce effective SNR's of 15dB to 25dB. SNR herein is defined as the isolated pulse peak voltage divided by RMS noise voltage.

8.6.2 Off-Track Interference Emulator

The input to the Viterbi detector prefilter can be artificially corrupted by adding a scaled output from a linear feedback shift register (LFSR). The amplitude of the LFSR can be varied by register 75<7:0>. The frequency content of the LFSR signal is designed to match the spectrum of off-track interference experienced by the channel during off-track stress testing (OTC).

8.6.3 Noise Multiplier Test

This test assumes known data, so a known-data write must be used to set up test data sectors. The known-data pattern used, a repeating PRBS, is modified to satisfy the parity constraint of the Viterbi detector by setting register 73<7> to 1.

The error signal at the input to the Viterbi detector prefilter is measured by comparing input amplitude samples to the known-data pattern. The derived error signal is multiplied by a scaling factor and then added back to the known signal. This uniformly multiplies all noises and distortions by the scaling factor, creating a uniform degradation of the effective detector SNR. The amplitude of the noise multiplication error is adjusted by register 75<7:0>.

8.6.4 Arbitrary Waveform Injection

The ViewDac circuit of the SCA8700 can be used to generate arbitrary waveforms that may be used to simulate analog input signals. These waveforms can be injected at various nodes in the analog signal path as illustrated in Figure 55.

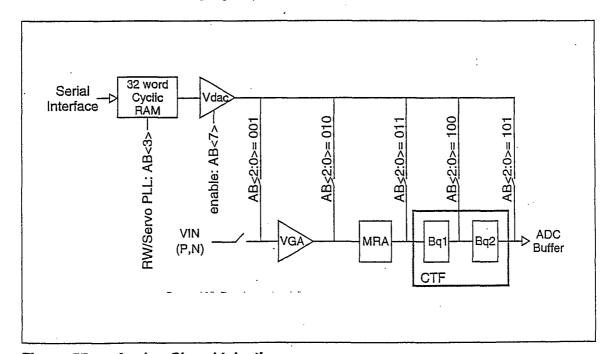


Figure 55 Analog Signal Injection

A 32-word cyclic random access memory (RAM) is first loaded with waveform sample values via the serial interface. The clocked output samples are input to the viewdac (Vdac) where they are converted to analog values. As shown in Figure 55, the output of the viewdac can be connected to various inputs in the analog signal path as selected by register AB<2:0>. The cyclic RAM is clocked from either the R/W PLL or Servo PLL

depending on the setting of AB<3>. Normally, in this mode the input signal from the preamp, VIN(P,N) is disconnected from the VGA by setting AB<4> to 1.

The analog signal injection function may be used to simulate typical sinusoidal input waveforms that can be used with the CQM, to measure and calibrate the frequency transfer function of the VGA and CTF.

8.7 View DAC

The SCA8700 allows real time viewing of digital signals in the analog domain by using a high speed, 7-bit View DAC. The functional description of the View DAC is shown in Figure 56, and operating modes are specified in Table 21 and Table 22.

Register B0<2:0> controls the selection of internal signals which are routed to the View DAC. The selected data can then be brought off-chip at reduced or full speed depending upon the setting of B0<7:3>. The actual divisor will be the value of B0<7:3>+1. For example, if the setting in this field is 000, then the data is divided by 1, and by 8 if the setting is 111.

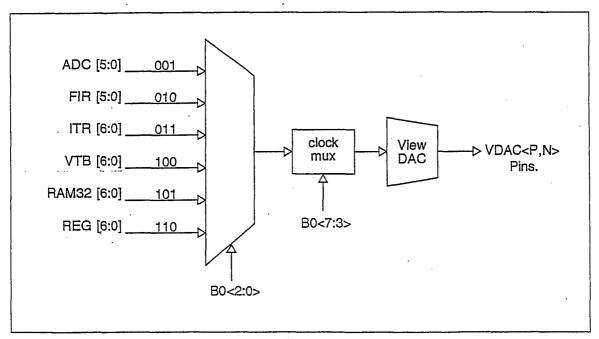


Figure 56 View DAC

Table 21 View	DAC	Input	Select
---------------	-----	-------	--------

B0<2:0>	Description
000	Selects a value of 0 into the View DAC input
001 -	Selects the output from the ADC
010	Selects the output from the FIR
011	Selects the output from the ITR
100	Selects the output from the Viterbi
101	Selects the output from a 128-byte RAM
110	Selects the output from a user loaded serial port register

Table 22 View DAC Decimation

B0<7:3>	Description	
000	View DAC output is every clock period	
001	View DAC output is every 2nd clock period	
•••	•••	
111	View DAC output is every 8th clock period	

8.8 Analog Test Port

A differential analog test port may be used to monitor and inject analog signals along the signal path of the front end of the SCA8700. VGA input pins VIN_P and VIN_N are multiplexed to input ports along the signal path. ASIG_P and ASIG_N pins are switched to the selected output along the signal path as shown in Figure 57.

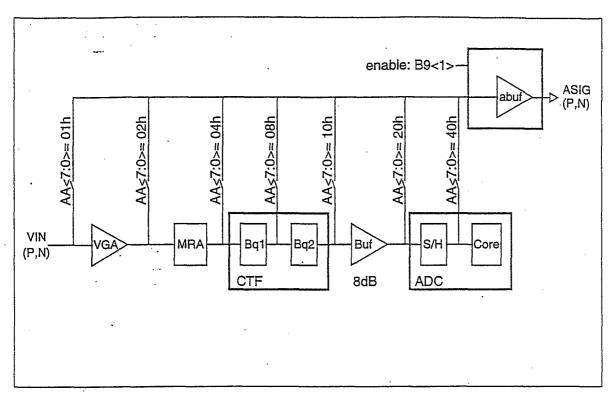


Figure 57 Analog Test Port

Table 23 specifies the value of register AA<7:0> needed to connect a selected signal to the ASIG output pins.

Table 23 Analog Test Port

AA<7:0>	Output Selected
00000000	No connect to Aout normal op.
00000001	Connects pins ASIG_P/ASIG_N to output testbus
00000010	VGA output
00000100	Asymmetry correction output
00001000	Ist biquad output
00010000	CTF output
00100000	8 dB buffer output
01000000	S/H output

8.9 Multiplexed Test Pin (MTP)

A single MTP is used to connect to internal test signals. The function of the MTP is controlled by register BA<2:0>. Figure 24 lists available signals.

Table 24 Multiplexed Test Pin

BA<2:0>	RGATE	.WGATE	SERVO	MTP	Description
000	Х	Х	Х	NSYNC	Not sync-byte found
001	X	Х	X	WRITE_ERROR	WRITE error.
010	Х	X	X	GRAY_DATA	Gray decode output
011	X	Х	Х	PLLR_LOCKED	Read PLL locked
100	X	Χ .	Х	PLLS_LOCKED	Servo PLL locked
101	X	X	X	WRP_INVALID	WRP Invalid/WRP Error
110	X	Х	X.	FIR_SATURATION	FIR tap out of range
.111	Х	0	0	NSYNC	Not sync-byte found
111	0	1	Х	WRITE_ERROR	WRITE error
111	0	0	1 .	GRAY_DATA	GRAY decode output

9 Register Map

9.1 Register Map Index

Table 25 Register Map Group Assignments

Table 25 Register Map Group Accignments							
Group	Address Range	Description					
00000	00 - 07	Power and Mode Control					
00001	08 - 0F	Counter Timers					
00010	10 - 17'	ITR .					
00011	18 - 1F	ITR					
00100	20 - 27	NRZIO and Write					
00101	28 - 2F	FIR					
00110	30 - 37	FIR					
00111	38 - 3F	FIR					
01000 -	40 - 47	Servo					
01001	48 - 4F	Servo					
01010	50 - 57	Servo					
01011	58 - 5F	Servo					
01100	60 - 67	Viterbi and Sync Detector					
01101	68 - 6F	CQM					
01110	70 77	CQM					
01111	78 - 7F	AGC					
10000	80 - 87	AGC .					
10001	88 - 8F .	Thermal Asperity					
10010	90 - 97	PLL					
10011	98 - 9F	PLL					
10100	A0 - A7	CTF					
10101	A8 - AF	Test					
10110	B0 - B7	Test					
10111	B8 - BF	Test					
11000	C0 - C7	Test					
11001	C8 CF	unused					
11010	D0 - D7	unused					
11011	C8 - DF	unused					

Table 25 Register Map Group Assignments

Group	Address Range	Description	
11100	E0 - E7	unused	
11101	E8 - EF	unused	
11110	F0 - F7	unused	
11111	F8 - FF	unused	

9.2 Register Assignments

Note: 1) Bit fields marked with '0' are reserved.

00 CHIP ID (Reset value: 00_H)

R	7	6	5 .	4	3	2	1	0
00	0	0	0	. 0	CF3	CF2	CF1	CF0

Bits	Name	Description
<3:0>	CF	

01 POWER CONTROL

 RW
 7
 6
 5
 4
 3
 2
 1
 0

 01
 0
 0
 0
 APCS1
 APCS0
 DPCS1
 DPCS0

Bits	Name	Description
<3:2>	APCS	Analog Power Control x0 Power controlled according to mode, as referenced in Table 4 01 Power up circuits selected by 1 bits of register 02 11 Power up circuits selected by 0 bits of register 02
<1:0>	DPCS	Digital Power Control x0 Power controlled according to mode, as referenced in Table 4 01 Power up circuits selected by 1 bits of register 03 11 Power up circuits selected by 0 bits of register 03

02 POWER CONTROL ANALOG

(R	es	et	va	lue	: :	0	0	۱
•	-					-	~	•	u,

RW	7	6	5	4	3	2	1	0
02	0	0	AFE	ADC	WPR	BGP	PLLS	PLLR

Bits	Name	Description .							
	If 01<3:2>=01 circuits with the respective bit set to 1 are powered up If 01<3:2>=11 circuits with the respective bit set to 0 are powered up								
<5>	AFE	Analog Front End .							
<4>	ADC	Analog to Digital Convertor							
<3>	WPR	Write Precomp							
<2>	BGP	Band Gap Power Regulator							
<1> PLLS Servo PLL									
<0> PLLR Read PLL									

03 POWER CONTROL DIGITAL

RW	7	6	5	4	3	2	1	. 0
03	0	NRZIO	RDP	WRP	AGC	VIT	ITR	FIR

Bits	Name	Description							
	If 01<1:0>=01 circuits with the respective bit set to 1 are powered up If 01<1:0>=11 circuits with the respective bit set to 0 are powered up								
<6>	NRZIO	NRZIO Interface Output							
<5>	RDP	Digital Read Path							
<4>	WRP	Digital Write Path							
<3>	AGC	Analog Gain Control							
<2>	VIT	Viterbi Detector							
<1>	ITR	Digital Timing Recovery							
<0>	FIR	FIR Filter							

04 MODE CONFIG 0 (Reset value: 04									
RW	7	6	5	4	3	2	1	0	
04	0	0	o	o	0	SUSP	WDS	RGEXT	

	_1	
Bits	Name	Description
<2>	SUSP	Suspend Mode 0 Go to Doze mode, refer to Figure 3 1 Go to Suspend mode, refer to Figure 3
<1>	WDS	Write During Servo 0 Disable 1 Enable. Allows the user to "erase" bad servo burst areas. The Write mode DURING Servo mode can only be entered from Servo mode
<0>	RGEXT	Read Gate Extension Enable 0 Disabled 1 Enabled, Read gate extension extends internal RGATE to flush data

08 SYNC MARK INSERT TIME

(Reset value: 00_H)

RW	7	6	5	4	3	2	1	0
08	SMIT7	SMIT6	SMIT5	SMIT4	SMIT3	SMIT2	SMIT1	SMIT0

stored in the Viterbi path memory

Bits	Name	Description
<7:0>	SMIT	Sync Mark Insert Time
		The value of time in VCO clocks from RGATE when a "sync mark found" will
		be inserted. This register will be used in the event that a sync mark
		cannot be found during a normal read operation. No sync mark is
		inserted if register value is 00h

09 ACQUISITION TIME

R	7	6	5	4	3	2	11	0
09	0	AQT6	AQT5	AQT4	AQT3	AQT2	AQT1	AQT0

Bits	Name	Description
<6:0> AQT Acc		Acquisition Time
		AQT<6:0> is a programmable 7-bit delay that determines ITR acquisition
		time. Time is 09<6:0> x 4T
		Typically set to 18 _h

A GAIN ACQUISITION TIME (Reset value: 00 _H)								
7	6	5	4	3	2	1	0	
0	GAQT6	GAQT5	GAQT4	GAQT3	GAQT2	GAQT1	GAQT0	
Name	Description	escription						
GAQT	GAQT<6:0	Gain Acquisition Time GAQT<6:0> is a programmable 7-bit delay that determines AGC acquisition time. Time is 0A<6:0> x 4T Typically set to 18 _h						
11 ITR ALPHA AQUISITION (Reset value: 29 _H)								
7	6	5	44	3	2	1	0	
ALAQ7	ALAQ6	ALAQ5	ALAQ4	ALAQ3	ALAQ2	ALAQ1	ALAQ0	
Name	Descriptio	n	<u> </u>					
ALAQ	ITR Loop	Filter Alpha	1					
ETA AQU	ISITION					(Reset va	alue: 31 _H)	
. 7	6	5	4	3	2	1	0	
BETAQ7	BETAQ6	BETAQ5	BETAQ4	BETAQ3	BETAQ2	BETAQ1	BETAQ0	
Name	Descriptio	n					· · · · · · · · · · · · · · · · · · ·	
BETAQ	ITR Loop	Filter Beta				٠.		
LPHA TR	ACKING				9	(Reset va	lue: 1B _H)	
Ż	6	. 5	4	3	2	1	0	
ATRAC7	ATRAC6	ATRAC5	ATRAC4	ATRAC3	ATRAC2	ATRAC1	ATRAC0	
Bits Name Description								
Name	Description	n		***************************************				
	7 0 Name GAQT PHA AQ 7 ALAQ7 Name ALAQ 7 BETAQ7 Name BETAQ7	7 6 0 GAQT6 Name Description GAQT Gain Acq GAQT<6:0 time Typ PHA AQUISITION 7 6 ALAQ7 ALAQ6 Name Description ALAQ ITR Loop ETA AQUISITION 7 6 BETAQ7 BETAQ6 Name Description 1	7 6 5 0 GAQT6 GAQT5 Name Description Time GAQT Gain Acquisition Time GAQT GAQT<6:0> is a programme. Time is Only Typically set to Typically set t	7 6 5 4 0 GAQT6 GAQT5 GAQT4 Name Description Time GAQT G:0> is a programmable Time. Time is 0A<6:0> x 4 Typically set to 18h PHA AQUISITION 7 6 5 4 ALAQ7 ALAQ6 ALAQ5 ALAQ4 Name Description ALAQ ITR Loop Filter Alpha ETA AQUISITION 7 6 5 4 BETAQ7 BETAQ6 BETAQ5 BETAQ4 Name Description BETAQ BETAQ ITR Loop Filter Beta LPHA TRACKING 7 6 5 4	7 6 5 4 3 0 GAQT6 GAQT5 GAQT4 GAQT3 Name Description GAQT Gain Acquisition Time GAQT<6:0> is a programmable 7-bit delay the string of the stri	7 6 5 4 3 2 0 GAQT6 GAQT5 GAQT4 GAQT3 GAQT2 Name Description GAQT < 6:0> is a programmable 7-bit delay that determing time. Time is 0A<6:0> x 4T	7 6 5 4 3 2 1 0 GAQT6 GAQT5 GAQT4 GAQT3 GAQT2 GAQT1 Name Description GAQT Gain Acquisition Time GAQT GAQT5 bit delay that determines AGC at time. Time is 0A<6:0> x 4T Typically set to 18h (Reset value of the value of time. Typically set to 18h PHA AQUISITION (Reset value of time. Typically set to 18h Name Description ALAQ4 ALAQ3 ALAQ2 ALAQ1 Name Description (Reset value of time. Typically set to 18h) (Reset value of time. Typically set to 18h) (Reset value of time. Typically set to 18h) ETA AQUISITION (Reset value of time. Typically set to 18h) (Reset value of time. Typically set to 18h) BETAQ7 BETAQ6 BETAQ5 BETAQ4 BETAQ3 BETAQ2 BETAQ1 Name Description BETAQ BETAQ4 BETAQ3 BETAQ2 BETAQ1 Name Description BETAQ4 BETAQ3 CReset value of time. Typically set to 18h LPHA TRACKING (Reset value of time. Typically set to 18h Reset value of time. Typically set to 18h	

14 ITR BETA TRACKING

RW	7	6	5	4	3	2	1	0
14	BTRAC7	BTRAC6	BTRAC5	BTRAC4	BTRAC3	BTRAC2	BTRAC1	BTRAC0
Bits	Bits Name Description							
<7:0>	BTRAC	ITR Loop Filter Tracking Beta						

20 NRZIO/WRITE CONFIG

	RW	7	6	5	4	3,1	2	1	0
	20	.0	pp	WCLKP	RCLKP	WRKD	DIRW	WPD	SCRD
_									····

Bits	Name	Description
<6>	PP	Push Pull 0 Open drain 1 Push - pull (default)
<5>	WCLKP	Write Clock Polarity 0 NRZ data clocks in on rising edge of WCLK 1 NRZ data clocks in on falling edge of WCLK
<4>	RCLKP	Read Clock Polarity 0 NRZ data switches after falling edge of RCLK 1 NRZ data switches after rising edge of RCLK
<3>	WRKD	Known Data Write 0 normal 1 enable Known Data Write mode
<2>	DIRW	Direct Write 0 Normal mode 1 enable Direct Write mode
<1>	WPD	Write mode Precoder Disable 1 = disable
<0>	SCRD	Scrambler Disable 1 = disable

WRITE MODE PRECOMP PHASE SELECT 1 (Reset value: 00 _H)								
7	6	5	4	3	2	1	0	
0	WPC16	WPC15	WPC14	WPC13	WPC12	WPC11	WPC10	
Name	Descriptio	n						
WPC1	Write mod	te mode Precompensation Phase 1						
23 WRITE MODE PRECOMP PHASE SELECT 2 (Reset value: 00 _H)								
7	6	5	4	3	2	11	0	
0	WPC26	WPC25	WPC24	WPC23	WPC22	WPC21	WPC20	
Name	Descriptio	n						
WPC2	Write mod	le Precomp	ensation P	hase 2				
24 WRITE MODE PRECOMP PHASE SELECT 3 (Reset value: 00 _H)								
7	6	5	4	3	2	1	0	
0	WPC35	WPC35	WPC34	WPC33	WPC32	WPC31	WPC30	
Name	Description	n	24					
WPC3	Write mod	Write mode Precompensation Phase 3						
	7 0 Name WPC1 FMODE I 7 0 Name WPC2 MODE I 7 0 Name Name	7 6 Name Description WPC1 Write mode FMODE PRECOMINATE O WPC26 Name Description WPC2 Write mode FMODE PRECOMINATE O WPC35 Name Description O WPC35	7 6 5 0 WPC16 WPC15 Name Description WPC1 Write mode Precomp E MODE PRECOMP PHASE 0 WPC26 WPC25 Name Description WPC2 Write mode Precomp E MODE PRECOMP PHASE 7 6 5 0 WPC35 WPC35 Name Description Description	7 6 5 4 0 WPC16 WPC15 WPC14 Name Description 7 6 5 4 0 WPC26 WPC25 WPC24 Name Description WPC2 Write mode Precompensation F EMODE PRECOMP PHASE SELECT 7 6 5 4 0 WPC35 WPC35 WPC34 Name Description Name Description	7 6 5 4 3 0 WPC16 WPC15 WPC14 WPC13 Name Description WPC2 WPC24 WPC23 Name Description WPC2 Write mode Precompensation Phase 2 E MODE PRECOMP PHASE SELECT 3 7 6 5 4 3 0 WPC35 WPC34 WPC33 Name Description	7 6 5 4 3 2 0 WPC16 WPC15 WPC14 WPC13 WPC12 Name Description WPC26 WPC25 WPC24 WPC23 WPC22 Name Description WPC35 WPC34 WPC33 WPC32 Name Description	7 6 5 4 3 2 1 0 WPC16 WPC15 WPC14 WPC13 WPC12 WPC11 Name Description WPC1 Write mode Precompensation Phase 1 (Reset value) T 6 5 4 3 2 1 0 WPC26 WPC25 WPC24 WPC23 WPC22 WPC21 Name Description Description (Reset value) 7 6 5 4 3 2 1 0 WPC35 WPC35 WPC34 WPC33 WPC32 WPC31 Name Description Description	

28-31 FIR READ MODE COEFFICIENTS 0-9

(Reset	value:	00")
--------	--------	------

1	RW	7	6	5	4	3	2	1	0
	28 - 31	RFC7	RFC6	RFC5	RFC4	RFC3	RFC2	RFC1	RFC0

Bits	Name	Description
<7:0>	RFC	FIR 8-bit coefficient of tap 0 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 1 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 2 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 3 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 4 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 5 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 6 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 7 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 8 for Read mode
<7:0>	RFC	FIR 8-bit coefficient of tap 9 for Read mode

32-3B FIR SERVO MODE COEFFICIENTS 0 - 9

RW	7	6	5	4	3	2	11	0
32 - 3B	SRF7	SRF6	SRF5	SRF4	SRF3	SRF2	SRF1	SRF0
Bits	Bits Name Description							
<7:0> SRF FIR 8-bit coefficient of tap 0 for Servo mode								

DIIS	Name	Description
<7:0>	SRF	FIR 8-bit coefficient of tap 0 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 1 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 2 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 3 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 4 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 5 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 6 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 7 for Servo mode
<7:0> SRF F		FIR 8-bit coefficient of tap 8 for Servo mode
<7:0>	SRF	FIR 8-bit coefficient of tap 9 for Servo mode

3C FIR CONFIG 0

(Reset value: 00_H)

RW	7	6	5	4	3	2	11	0
3C	CS7	CS6	CS5	CS4	CS3	CS2	CS1	CS0

Bits	Name	Description
<7:0>	cs	Cursor Tap Mask, bits 0 - 7 If CSn = 1, then the coefficient value of tap n is not adapted. Recommend taps <4> and <5> be set to 1

3D FIR CONFIG 1

(Reset value: 00_H)

RW	7 ·	- 6	5	4	3	2	. 1	. 0	İ
3D	0.	0	0	0	IFP	SA	CS9	CS8	

Bits	Name	Description
<3>	IFP	Initialize From Previous Read mode FIR coefficients are always loaded from the Read mode shadow registers to the FIR coefficient registers on the assertion of RGATE at the beginning of a Read mode 1 The shadow registers are updated at the end of a Read if FIR coefficient saturation does not occur 0 The shadow registers are not updated during a Read mode. They contain fixed coefficients either from a previous Read mode or values that have been loaded via the serial interface
<2>,	SA	Self-Adaptive Mode Enable If SA = 1, self-adaptive mode is enabled during Read mode
<1>	CS9	Cursor Tap Mask, bit 9 If CS9 = 1, then the coefficient value of tap 9 is not adapted
<0>	CS8	Cursor Tap Mask, bit 8 If CS8 = 1, then the coefficient value of tap 8 is not adapted

3E FIR ADAPTATION GAIN

RW	7	6	5	4	3	2	1	0
3E	0	0	0	0	AG3	AG2	AG1	AG0

Bits	Name	Description
<3:0>	AG	Adaptation Gain
	:	Set the adaptation loop gain during regular tracking in Read mode

60 VITERBI CONFIG

(Reset value: 00_H)

RW	7	6	5	4	3	2	1	0
60	0	0	0	0	0	0	0	HDPOL

Bits	Name	Description
<0>	HDPOL	Viterbi Head Polarity Select 0 Positive 1 Negative

61 SYNC DETECTOR THRESHOLD

RW	7	. 6	5	4	3	. 2	1	0	
61	0	. 0	0	0	STH3	STH2	STH1	STH0	

Bits	Name	Description
<4:0>	STH	

68 CQM CONFIG 0

(Reset value: 00_H)

R	7	6	5	4	3	2	1	0
68	Α.	0	EN	SB	EP	EQ		ER

Bits	Name	Description
<7>	A	When set to 1 triggers CQM by moving to HOLD state and resets all state variables
<5>	EN	Enable When set to 1, enables the entire CQM block
<4>	SB	Sync-byte If set to 1 HOLD state is entered on sync-byte found, else on RGATE assertion
<3>	EP	End P When P Counter Terminal Count Complete value is set to 1 else 0 (read only bit)
<2>	EQ	End Q When Q Counter Terminal Count Complete value is set to 1 else 0 (read only bit)
<1>	L	Loop Enable When set to 1 the CQM will return to Idle mode if Q count not complete on end of RGATE
<0>	ER	Error Flag An error flag that is set if still in WAIT state at end of RGATE

69 CQM HOLD TIME

RW	7	6	5	4	3	2	1	0
69	PT7	PT6	PT5	PT4	PT3	PT2	PT1	PT0

Bits	Name	Description
<7:0>	PT	Hold off counter end count. Sets value to delay sampling of data by CQM

6A CQM	Q END C	OUNT MS	B				(Reset va	alue: 00 _H)		
RW	7	6	5	4	3	2		0		
6 A	QT11	QT10	Q Т9	QT8	QT7	Q6	Q5	Q4		
Bits	Name	Description	n							
<7:0>	QT	Q sample	counter en	d count. Se	ets the nun	nber desire	d samples			
6B CÓW	Q END C	OUNT					(Reset va	alue: 00 _H)		
RW	. 7	6	5	4	3	2	1	0		
6B	Q11	Q10	Q9 R	Q8	QT3	QT2	QT1	QT0		
Bits	Name	Description	Description							
<7:4>	Q	Q sample	counter va	lue. Sets th	ne number	desired saı	mples. Upp	er 4 bits		
<3:0>	QT	1	sample counter end count. Contains the current sample count. Upper 4 bits							
6C CQM	Q COUN	T LSB					(Reset v	alue: 00 _H)		
R	7	. 6	5	44	3	2	1	0		
6C	Q7	Q6	Q5	Q4	Q3	Q2	Q1	Q0		
Bits	Name	Description	n ·							
<7:0>	QT	Q sample	counter va	lue. Contai	ns the cur	rent sample	count. Lo	wer 8 Bits		
6D CQM	HIGH TH	RESHOLI				,	(Reset v	alue: 00 _H		
RW	7	6	5	4	3	2	11	0		
6D	SEL	0	TH5	TH4	ТНЗ	TH2	TH1	THO		
Bits	Name	Description	n			•	· · · · · · · · · · · · · · · · · · ·			
<7>	SEL	0 A secto		<i>leasure</i> as 1 or mor as 5 or mor	-		·			
<5:0>	TH	High Thr This is a t	eshold (T _H wo's comp) lement valu	ue from –3	2 to +32. Se	ee Figure	51		

6E CQM LOW THRESHOLD

(Reset value: 00_H)

RW	7	. 6_	5	4	3	2	1	0
6E	0	0	0	TL4	TL3	TL2	TL1	TLO

Bits	Name	Description
<5:0>	TL	Low Threshold (T _L) This is a two's complement value from -32 to +32. See Figure 51
1	Ì	I his is a two's complement value from -32 to +32. See Figure 31

6F COM HISTOGRAM THRESHOLD

RW	7	6	5	4	3	2	1	0	
6F	TE7	TÉ6	TE5	TE4	TE3	TE2	TE1	TEO	

Bits	Name	Description
<7:0>	TE	Low Threshold (T _L)
	,	This is a two's complement value from -32 to +32. See Figure 51

70 CQM TEST CONFIG 1

(Reset value: 00_H)

RW	· 7	6	5	4	3	2	1	0
70	0	MS3	MS2	MS1	MS0	FS2	FS1	FS0

Bits	Name	Description
<6:3>	MS	MONSEL 0000 ITR sample value output 0001 Gain errors 0010 Timing errors 0011 DC restore errors 0100 MR asym errors 0101 FIR adaptation errors 0110 Sector errors - type 1 0111 Sector errors - type 2 1000 VA output bit errors 1010 SCC interleave bit errors
<2:0>	FS	FUNSEL 0000 MSE1 - referenced to slicer 0001 MSE2 - referenced to known data 0010 MSE3 - no reference 0011 SAT, surface analysis test 0100 Histogram 1 - referenced to slicer 0101 Histogram 2 - referenced to known data 0110 Histogram 3 - no reference 0111 Error rate function 1000 Di-bit extraction function

71 CQM M ACCUMULATOR LSB

R	7	6	5	4	3	2	11	0
71	ML7	ML6	ML5	ML4	ML3	ML2	ML1	MLO

Bits	Name	Description
<7:0>	ML	CQM Measurement Accumulator Lower 8 Bits

72 CQM	72 CQM M ACCUMULATOR MSB (Reset value: 00 _H)								
R	7	6	5	4	3	2	1	0	
72	MM7	мм6	MM5	MM4	ммз	MM2	MM1	ММО	
Bits	Name	Descriptio	n		· · · · · · · · · · · · · · · · · · ·	,		_	
<7:0>	ML	CQM Mea	surement /	Accumulato	or Upper 8 I	3its			
73 KNOV	VN DATA	READ PF	RBS SEEI)			(Reset va	alue: 00 _H)	
RW	7	- 6	5	4	3	2	1	0	
73	GMOD	KDS6	KDS5	KDS4	KDS3	KDS2	KDS1	KDS0	
Bits	Name	Descriptio	n		· · · · · · · · · · · · · · · · · · ·	·			
<7>	GMOD	Generate	Modified P	RBS					
<6:0>	KDS	Known Da	Known Data RRBS Seed for Read mode						
NOISE INJECTION CONFIG (Reset value: 00									
NOISE IN	JECTION	N CONFIG		_			(Reset va	alue: 00 _H)	
NOISE IN	JECTION	N CONFIG	5	4	3	2	(Reset va	alue: 00_H)	
•				4	3	2	•		
•			5	4	3	2	•		
RW	7	6 Description	5		3	2	1		
Bits <7:0>	7 Name	6 Description	5 n a specifica	tion		2	1	0	
Bits <7:0>	7 Name	Description see Balbo	5 n a specifica	tion		2	1	0	
Bits <7:0>	Name	Description see Balbo	5 n a specifica ENCE EM	tion			(Reset va	0 alue: 00 _H)	
Bits <7:0> 75 OFF-7	Name RACK IN	Description see Balbo	5 a specifica ENCE EM 5 OTE5	tion	3	2	(Reset va	0 alue: 00 _H)	
Bits <7:0> 75 OFF-7 RW 75	Name FRACK IN 7 OTE7	Description see Balbo TERFERI 6 OTE6	5 a specifica ENCE EM 5 OTE5	tion ULATOR 4 OTE4	3 OTE3	2	(Reset va	0 alue: 00 _H)	

76 NOISE MULTIPLIER

(Reset value: 00_H)

RW	7	66	5	4	3	2	1	0	
76	NMA7	NMA6	NMA5	NMA4	NMA3	NMA2	NMA1	NMAO	
Bits Name Description									
<7:0>	NMA	Noise Multiplier Amplitude							

78 AGC/DC OFFSET/MRA CONFIG

Bits	Name	Descripti	on	•				
78	0	0	MRAUR	MRAUS	VOSUR	vosus	GURE0	GUSE0
RW	7	6	5	4	3	2	1	0

Bits	Name	Description
<5>	MRAUR	MRA Update Method Read 0 disable - A fixed initial MRA loop setting is contained in register 7F 1 update - The initial MRA setting in 7F is updated at the end of a read
<4>	MRAUS	MRA Update Method Servo 0 disable - A fixed initial MRA loop setting is contained in register 80 1 update - The initial MRA setting in 80 is updated at the end of a read
<3>	VOSUR	DC Offset Update Method Read 0 disable - A fixed initial DC offset loop setting is contained in register 7D 1 update - The initial DC offset setting in 7D is updated at the end of a read
<2>	VOSUS	DC Offset Update Method Servo 0 disable - A fixed initial DC offset loop setting is contained in register 7E 1 update - The initial MRA setting in 7E is updated at the end of a read
<1>	GURE	Gain Update Method Read 0 disable - The initial AGC gain is set in register 7A and is not updated 1 update - The initial AGC gain in register 7A is updated at the end of a read
<0>	GUSE	Gain Update Method Servo 0 disable - The initial AGC gain is set in register 7B and is not updated 1 update - The initial AGC gain in register 7B is updated at the end of read

79 AGC LOOP GAIN

(Reset value: 20_H)

RW	7	6	5	.4	3 .	2	1	0
79	GTHLD	GTLG2	GTLG1	GTLG0	GAHLD	GALG2	GALG1	GAL _G 0

Bits	Name	Description
<7>	GTHLD	Track Mode Gain Hold 0 normal adaptation 1 disable - the accumulator will not adapt during tracking in Read mode
<6:4>	GTLG	AGC Track Mode Loop Gain Track Mode Loop Gain = 2 ^{GTLG}
<3>	GAHLD	Acquisition Mode Gain Hold 0 normal adaptation 1 disable - the accumulator will not adapt during acquisition in Read mode
<2:0>	GALG	AGC Acquisition Mode Loop Gain Acquisition Mode Loop Gain = 2 ^{GALG}

7A AGC Read Mode PRESET

(Reset value: 00_H)

RW	7	6	5	4	. 3	2	1	0
7 A	RPS7	RPS6	RPS5	RPS4	RPS3	RPS2	RPS1	RPS0

Bits	Name	Description
<7:0>	RPS	AGC Read mode Preset This two's complement shadow register holds the initial gain setting for the next Read mode sector

7B AGC Servo Mode PRESET

]	RW	7	6	5	4	3	2	1	0	i
	7B	SPS7	SPS6	SPS5	SPS4	SPS3	SPS2	SPS1	SPS0	İ

Bits	Name	Description
<7:0>	SPS	AGC Servo mode Preset This two's complement shadow register holds the initial gain setting for the next Servo mode sector

7C DC 01	FFSET LO		(Reset value: 20 _H)							
RW	. 7	6	5	4	3	2	1	0		
7C	GTHLD	GTLG2	GTLG1	GTLG0	GAHLD	GALG2	GALG1	GALG0		
Bits	Name	Description								
<7>	GTHLD	Track Mode Gain Hold 0 Normal mode 1 Bypass; the accumulator will not adapt during Read Track mode								
<6:4>	GTLG	AGC Track Mode Loop Gain Track Mode Loop Gain = 2 ^{GTLG} where GTLG =< 5								
<3>	GAHLD	Acquisition Mode Gain Hold 0 Normal mode 1 Bypass; the accumulator will not adapt during Read mode								
<2:0>	GALG	AGC Acquisition Mode Loop Gain Acquisition Mode Loop Gain = 2 ^{GALG} where GTLG =< 5								
7D DC OFFSET Read Mode PRESET (Reset value: 00 _H)										
RW	7	6	5	4	3	2	1	0		
70	ROS7	ROS6	ROS5	ROS4	ROS3	ROS2	ROS1	ROS0		
Bits	Name	Description								
<7:0>	ROS	DC Offset Read Mode Preset This two's complement shadow register holds the initial offset setting for Read mode								
7E DC OFFSET Servo Mode PRESET (Reset value: 00 _H)										
RW	7	6	5	4	3	2	. 1	0		
7E	SOS7	SOS6	SOS5	SOS4	SOS3	SOS2	SOS1	SOS0		
Bits	Name	Description								
<7:0>	SOS	DC Offset Servo Mode Preset This two's complement shadow register holds the initial offset setting for Servo mode								

7F MR A	MR ASYMMETRY Read Mode PRESET (Reset value: 00							alue: 00 _H)
RW	7	. 6	5	4	3	2	1	0
7E	MRARP7	MRARP6	MRARP5	MRARP4	MRARP3	MRARP2	MRARP1	MRARP0
Bits	Name	Descriptio	escription					
<7:0>	MRARP	This two's	IR Asymmetry Read Mode Preset his two's complement shadow register holds the initial asymmetry compensation setting for Read mode					
80 MR A	SYMMETI	RY Servo	Mode PF	RESET			(Reset v	alue: 00 _H
RW	7	6	5	4 .	3 .	2	1	0
7F	MRASP7	MRASP6	MRASP5	MRASP4	MRASP3	MRASP2	MRASP1	MRASP0
Bits	Name	Description	Description					
<7:0>	MRASP	This two's	compleme	nvo Mode F ent shadow setting for	register ho		ial asymme	etry
82 MR A	SYMMETI	RY CONF	IG	•		•	(Reset v	alue: 00 _H
RW	7	6	5	4	3	2	1	0
82	0	0	0	0	0	MRAR	MRALG1	MRALG0
Bits	Name	Description	n					· · · · · · · · · · · · · · · · · · ·
<2>	MRAR	MRA Ran 0 Normal 1 Input ra	range	led by 20%				
<1:0>	MRALG	Selects lin	reduce inpu	I MRA ampi ut signal an				

ANIIIC	Mode RE	COVERY	CONFIG			•	(Heset va	lue: 00 _H)		
RW	7	_6	5	4	3	2	1	0		
84										
Bits	Name	Descriptio	n							
<7:4>		See Balbo	a specifica	tion						
90 R/W P	LL CON	FIG1				ı	(Reset va	lue: 00 _H		
RW	7	6	5	4	3	2	. 1	0		
90	P3	P2	P1	P0	ENOS	M2.	M1	МО		
Bits	Name	Descriptio	n							
<7:4>	Р	P Counter	(Fractiona	l Feedback	Divider)					
<3>	ENOS	Enable Ov	ersampling/	9		<u></u>				
<2:0>	М	M Divider	(Output Di	vider)				,		
91 R/W F	PLL CON	FIG2					(Reset va	alue: 00 _H		
RW	7	6	5	4	3	2	1	0		
91	- EN	LOCK	N5	N4	N3	N2	N1	NO		
Bits	Name	Description	n			Description				
<7>										
, ,,,,,	EN	Enable Pl	L							
<6>	LOCK	Enable PL PLL Lock								
		PLL Lock		: Divider)						
<6> <5:0>	LOCK	PLL Locke N Divider	ed .	: Divider)			(Reset va	alue: 00 _t		
<6> <5:0>	LOCK	PLL Locke N Divider	ed .	: Divider) 4	3	2		alue: 00 ₊ 0		
<6> <5:0>	N NO PLL C	PLL Locke N Divider	ed (Feedback		3	2 MS2	(Reset va	0 MS0		
<6> <5:0> 92 SERV	N NO PLL C	PLL Locke N Divider ONFIG1 6	ed (Feedback 5 PS1	4	1		(Reset va	0		
<6> <5:0> 92 SERV RW	N N O PLL C 7 PS3	PLL Locker N Divider ONFIG1 6 PS2 Description	ed (Feedback 5 PS1	4	0		(Reset va	0 MS0		

93 SERVO PLL CONFIG2

(Reset value: 00_H)

Dia	Manage	Description							
93	ENS	LOCKS	NS5	NS4	NS3	NS2	NS1	NS0	
RW	7	6	5	4	3	2	1	0	

Bits	Name	Description
<7>	ENS	Enable PLL
<6>	LOCKS	PLL Locked
<5:0>	·NS	N _s Divider (Feedback Divider)

98 CLOCK CONFIG

(Reset value: 00_H)

RW	7.	. 6	5	4	3	2	11	0	
98	FR3	FR2	FR1	FR0	0	· · co ·	COS1	COSO	

Bits	Name	Description
<7:4>	FR	Reference Input Frequency Select FREF = 98<7:4> x 5MHz
<2>	CO.	Clock Override If set to 1 overrides mode control to clock digital with selection in 98<1:0>
<1:0>	cos	Clock Override Select 00 FREF 01 READ 10 SERVO 11 WRITE

AO BIQUAD1 COMPLEX PAIR POLE FREQUENCY Read Mode (Reset value: 00H)

RW	7	6	5	4	3	2	1	0
AO	FCR17	FCR16	FCR15	FCR14	FCR13	FCR12	FCR11	FCR10

Bits	Name	Description
<7:0>	FCR1	Continuous Time Filter Biquad 1 Read mode Complex Pair Pole Frequency

RW	7	6	5	4	3	2	1	0
A1	FCR27	FCR26	FCR25	FCR24	FCR23	FCR22	FCR21	FCR20
Bits	Name	Descriptio	n					

A2 BIQUAD1 COMPLEX PAIR POLE FREQUENCY Servo Mode (Reset value: 00H)

FCR2 Continuous Time Filter Biquad 2 Read mode Complex Pair Pole Frequency

RW	7	6	5	4	3	2	1	0
A2	FCS17	FCS16	FCS15	FCS14	FCS13	FCS12	FCS11	FCS10

Bits	Name	Description
<7:0>	FCS1	Continuous Time Filter Biquad 1 Servo mode Complex Pair Pole Frequency

A3 BIQUAD2 COMPLEX PAIR POLE FREQUENCY Servo Mode (Reset value: 00H)

RW	7	6	5	4	3	2	1	· 0
АЗ	FCS27	FCS26	FCS25	FCS24	FCS23	FCS22	FCS21	FCS20

Bits	Name	Description
<7:0	> FCS2	Continuous Time Filter Biquad 2 Servo mode Complex Pair Pole Frequency

A4 BIQUAD1 QUALITY FACTOR

<7:0>

RW	7	6	5 .	· 4	3	2	1 .	0
A4	QS3	QS2	QS1	QS0	QR3	QR2	QR1	QR0

Bits	Name	Description .
<7:4>	QS	Continuous Time Filter Biquad 1 Servo mode quality factor
<3:0>	QR	Continuous Time Filter Biquad 1 Read mode quality factor

A5 BIQUAD2 QUALITY FACTOR

	_	_			
100		TIO IT	~ .	An.	١.
Inc	:5EL	valu	E .	UU.	

1	RW	7	6	5	4	3	2	1	0
	A 5	QS3	QS2	QS1	QS0	QR3	QR2	QR1	QR0

Bits	Name	Description
<7:4>	QS	Continuous Time Filter Biquad 2 Servo mode quality factor
<3:0> QR		Continuous Time Filter Biquad 2 Read mode quality factor

A8 ANALOG TEST INPUT PORT

(Reset value: 00_H)

Ì	RW	7	6	5	4	3	2	1	0
	A8	Al7	Al6	Al5	Al4	AI3	Al2	Al1.	AlO

Bits	Name	Description
<7:0>	. Al	Analog Input Select
		0000000 Normal operation
		0000001 Not used
		00000010 Shorts across VGA with bypass
		00000100 Asymmetry correction input
		00001000 CTF input
		00010000 CTF II biguad input
		00100000 ADC buffer input
		01000000 ADC S/H input
		10000000 Connect VIN_P/VIN_N pins to in/out testbus

AA ANALOG TEST OUTPUT PORT

RW	7	6	5	4	3	2	1	0
AA	AO7	-AO6	AO5	AO4	АОЗ	AO2	AO1	À00

Bits	Name	Description	
<7:0>	AO	Analog Output Select 00000000 Normal operation 00000001 Connects pins VIN_P/VIN_N to output testbus 00000010 VGA output 00000100 Asymmetry correction output 00001000 I Biquad output 00010000 CTF output	
		00100000 8 dB buffer output 01000000 S/H output	.•

AC TEST	BAND G	AP				*	(Reset va	alue: 00 _H)			
RW	7	6	5	4	3	2	1	0			
AC	0	0	0	0	0	0	0	0			
Bits	Name	e Description									
<7:0>		Band Gaj 00000000	o Normal Mo	ode			•				
AD TEST	VGA	, .					(Reset va	alue: 00 _H)			
RW	7	. 6	,5	4	3	2	1	0			
AD	0	0	0	0	0	0	0	0			
Bits	Name Description										
<7:0>		VGA Test	t Normal op	eration							
AE TEST	CTF						(Reset v	alue: 00 _H)			
RW	7	6	5	4	3	2	1	0 .			
AE	REFB7	REFB6	REFB5	REFB4	REFB3	REFB2	REFB1	REFB0			
Bits	Name	Description	'n					-			
<7:0>	REF	CTF Test	Normal op	eration							
AF TEST	ADC						(Reset v	alue: 00 _H)			
RW	7	6	. 5	4	3	2	1	0			
AF	0	AT6	AT5	AT4	АТЗ	AT2	AT1	ATO			
Bits	Name	Description	n	· · · · · · · ·							
<6:0>	REF	ADC Test 00000000	t Normal O _l	peration							

BO VIEW DAC

(Reset value: 00_H)

-	RW	7	6	5	4	3	2	11	0
	В0	DIV4	DIV3	DIV2	DIV1	DIV0	SEL2	SEL1	SEL0

Bits	Name	Description
<7:3>	DIV	Undersampling clock source divider 00000 No division, else division factor equal to DIV+1
<2:0>	SEL	View DAC Selected Input 000 Selects a value of 0 into the View DAC input 001 Selects the ADC output 010 Selects the FIR output 011 Selects the ITR output 100 Selects the Viterbi output 101 Selects the 32 byte RAM 110 Selects the Register bypass

B1 TEST MODE

RW	7	. 6	5	4	3	2	1 _	0 .
B1	. 0	0	0	DP1	DP0	TM2	TM1	ТМО

Bits	Name	Description
<4:3>	DP	Digital Path Input Test Bus Select 00 Allows ADC output to FIR input. This is the default condition upon system reset 01 Selects testbus inputs from multi-purpose input pins This feature should be selected while in Test Mode 10 Selects testbus inputs from multi-purpose pins for Servo mode 11 Selects output of LFSR to be applied to the FIR input
<2:0>	TM	Test Modes (active only when TM=1) 000 Normal Operating mode (default condition) 001 Read mode test 010 Write mode test 011 Servo mode test 100 SCAN 101 unused 110 unused

B8 DIGITAL TEST PORT

(Reset value: 00_H)

RW	7	6	5	4	3	2	1	. 0
B8	0	0	0	0	DPS3	DPS2	DPS1	DPS0

Bits	Name	Description
<3:0>	DPS	Digital Test Port Selection 0000 VDAC input 0001 Select the status pins from the PLL 0010 Select the FIR timing signals, COC FSM Mode bits 0011 Enables: ADC,AGC, AFE, BG, FIR, ITR 0101 Enables: NRZ, PECL, PM, RSYNTH, SSYNTH, Servo mode 0110 Enables: VITERBI, VGA, WPC, VGA_HIZ 0111 coc_fix_gain, coc_high_gain, mod4acc, track, dc_asymm 1000 misr_rbacken, misr_clk, misr_out 1111 Ring oscillator

B9 TEST PORTS ENABLE

RW	7	6	5	4	3	2	1	0
В9	0	0 .	TAPT	NRZB	- 0	PECL	DCBE	WPTE

Bits	Name	Description
<5>	TAPT	Digital Test Port Enable
<4>	NRZB	View DAC Enable
<2>	PECL	PECL Enable
<1>	DCBE	Analog Buffer Enable
<0>	WPTE	Write Precomp Test Enable

BA TEST MUX PIN

(Reset value: 00_H)

RW	7	6	5	4	3	2 .	1	0	
ВА	0	0	. 0	0	0	MPT2	MTP1	МТРО	

Bits	Name	Description
<2:0>	MPT	Test Port Select 000 not sync-byte found 001 Write mode error 010 Gray decode output 011 read PLL locked 100 servo PLL locked 101 WRP Invalid/WRP Error 110 FIR tap out of range 111 not sync byte found, selected by mode 111 Write mode error, selected by mode 111 Gray decode output, selected by mode

BC TEST ARB

RW	7	6	5	4	3	2	1	0
ВС	0	0	0	0	0	0	0	0

Bits	Name	Description
<0>		Arbitrary waveform generator value. Writing to this register will fill a register bank (34 deep) with sample values. When enabled, these values will circulate to the View DAC input to produce an arbitrary waveform

BD TEST PLL MUX

RW	7	6	5	44	3	2	1	0
BD	0	0	PTMX2	PTMX1	PTMX0	TPCL2	TPCL1	TPCL0

Bits	Name	Description
<5:3>	PTMX	PLL Test Mux 000 no clock 001 Read mode clock/8 010 Read mode PLL clock 011 Read mode PLL clock/N 100 Read mode PLL clock/8 101 Servo mode PLL clock 110 Servo mode PLL clock/N 111 Servo mode PLL clock/8
<2:0>	TPCL	PECL Current Project 001 16mA 010 19mA 011 22mA 100 28mA 101 28mA 110 31mA 111 37 mA

BE TEST MRA

(Reset value: 00_H)

1	RW	· 7	6	5	4	3	· 2	1 .	0
j	BE	0	0	0	0	0	0	0	0

Bits	Name	Description
<0>		MRA Test 00000000 Normal operation. DCOUT_P: free DCOUT_N: free 00000001 DC look at MRA outputs. DCOUT_P: mra_vp. DCOUT_N: mra_vn 00000010 Test offset DAC current output. DCOUT_P: vosp DCOUT_N: vosn 00000100 View asymmetry sum node (nonfunctional) DCOUT_P: s1p DCOUT_N: s1n 00001000 Force autozero (nonfunctional) DCOUT_P: free DCOUT_N: free 00010000 Test hzp and hzn high Z outputs of nonlinear amplifier. DCOUT_P: hzp DCOUT_N: hzn 00100000 View VREG with both pins (Kelvin) DCOUT_P: vreg DCOUT_N: vreg 01000000 View input igp and ign points for gain control (unity) DCOUT_P: mra_igp DCOUT_N: mra_ign 10000000 Normal operation (reserved test mode) DCOUT_P: free DCOUT_N: free

BF TEST MISR

RW	7	6	5	4	3	2	1 .	O
BF .	0	0	0	LFSR	WP	RP	iTR	FIR

Bits	Name	Description	
<4>	LFSR	Selects LFSR for all tests	
<3>	WP	Selects NRZ formatter Write mode path MISR observation	
<2>	RP	Selects NRZ formatter Read mode path MISR observation	•
<1>	ITR	Selects ITR MISR observation	
<0>	FIR	Selects FIR MISR observation	

*								
R	7	. 6	5	4	3	2	1	0
СО	0	M6	M5	M4	МЗ	M2	M1	MC
Bits	Name	Descriptio	n					
<6:0>	M	Register-b	ased inpu	t to the Viev	w DAC. Be	sure to pro	gram B0<2	2:0>
C1 TEST	VIEWDA	C INPUT	2	•			(Reset v	alue: (
R	7 ·	6	5	4	3	. 2	1	0
C1	0	M6	M5	M4	МЗ	M2	M1 _.	МС
Bits	Name	Descriptio	n					
<6:0>	M	Reads bad	ck value of	View DAC	input		(Reset v	alue:
C2 TEST	ABUFFE	<u>.l</u>	ck value of	View DAC	input · 3	2	(Reset v	alue: (
	ABUFFE	:R				2 BT2	•	0
C2 TEST	ABUFFE	ER 6	5	. 4	. 3	T	1	
C2 TEST	**************************************	6 0 Descriptio 0000 Norr	5 0 n nal operati	0	3 BT3	BT2	1	0
C2 TEST RW C2 Bits	ABUFFE 7 0 Name BT	6 0 Descriptio 0000 Norr	5 0 n nal operati	4 0	3 BT3	BT2	1	O BT
C2 TEST RW C2 Bits <3:0>	ABUFFE 7 0 Name BT	6 0 Descriptio 0000 Norr	5 0 n nal operati	4 0	3 BT3	BT2	1 BT1	O BT
C2 TEST RW C2 Bits <3:0>	ABUFFE 7 0 Name BT	6 0 Descriptio 0000 Norr 0001 Bypa	5 0 n nal operati	4 0 ion of analog o	3 BT3 utput testb	BT2	BT1	BT alue:
C2 TEST RW C2 Bits <3:0> C3 TEST RW	Name BT NS 7	6 0 Descriptio 0000 Norr 0001 Byps	5 0 n mal operati ass buffer 5 0	4 0 ion of analog o	3 BT3 utput testb	BT2	BT1 (Reset v	BT

C4 TEST	VIEW D	AC					(Reset v	alue: 00 ₊				
RW	7	6	5	4	3	2 '	1	0				
C4	0	0	0	0	VDT3	VDT2	VDT1	VDTO				
Bits	Name	Description	Description									
<3:0>	VDT	0000 Nor 0001 Byp 0010 Con	Tiew DAC test 000 Normal operation 001 Bypass output buffer 010 Connect DAC current outputs to DC testbus 100 Low DAC amplitude									
C8 TEST	MISR L	SB.					(Reset v	alue: 00,				
R	7	- 6	5	4	3	2	1	0				
C8	M7 ⁻	M6	M5	M4	МЗ	M2	M1	Mo				
Bits	Name	Description	on .	·								
<7:0>	М	1	ck lsb of M MISR_sel f		election							
C9 TEST	MISR						(Reset v	alue: 00 ₁				
R	7.	6	5 ·	4	3	2	1	0				
C9	M7	M6	M5	M4	МЗ	M2	M1	Мо				
Bits	Name	Description	on .									
<7:0>	М	Reads ba	ck middle c	of byte of se	elected MIS	SR						
	T MISR M						(Reset v					
R	7	6	5	4	3	2	1	0				
CA	M7	M6	M5	M4	МЗ	M2	M1	МО				
Bits	Name	Description	n									

Reads back MSB of byte of selected MISR

<7:0>

М

05 VOLTAGE REGULATOR

RW	7	6	5	4	3	2	1	o
05	P18A	A18V2	A18V1	A18V0	P18D	D18V2	D18V1	D18V0

Bits	Name	Description
<7>	P18A	1= power-off on-chip 1.8V regulator for the analog circuits (ADC, FSYN, SFYN)
		0= power-on (normal)
<6:4>	A18	Analog 1.8V regulator voltage fine tuning (all nominal in the following table) 000: 1.65V 001: 1.70V
		010: 1.75V 011: 1.80V 100: 1.85V 101: 1.90V 110: 1.95V 111: 2.00V
<3>	P18D	1= power off on-chip 1.8V regulator for the digital backend 0= power on (normal)
<2:0>	D18	Digital 1.8V regulator voltage fine tuning (all nominal in the following table) 000: 1.65V 001: 1.70V 010: 1.75V 011: 1.80V 100: 1.85V 101: 1.90V 111: 2.00V

21 PECL WRITE DRIVER

(Reset	value:	00_{H}
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RW	7	6	5	4	3	2	1	0
21	WD2	WD1	WD0	0	С	BYPWP	TEPH	STEPH

Bits	Name	Description			
< 7:5 >	WD	Write driver current control 000: off 001: 2mA 010: 10mA 011: 20mA 100: 30mA 101: 40mA 110: 50mA			
<3>	С	Write mode Precompensation Level 0 1-level precompensation 1 2-level precompensation			
<2>					
<1>	TEPH	1= FSYN Phase interpolator test mode enable 0= Normal mode			
<0>	STEPH	1= SFYN Phase interpolator test mode enable 0= Normal mode			
'4 Noise Generator (Reset value: 0					

74 Noise Generator

RW	7	6	5	4	3	2	1	0
74	NSENS	NSENR	NSG5	NSG4	NSG3	NSG2	NSG1	NSG0

Bits	Name	Description
<7>	NSENS	1= Enable noise generator in Servo mode
<6>	NSENR	1= Enable noise generator in Read mode Set both NSENS and NSENR to 0 for normal operation
<5:0>	NSG	Noise magnitude DAC control register. This register sets the magnitude of the noise generator output
		xx graph appears here xx

RW	7	6	5	4	3	2	1	0
84	TA TRIG1	TA TRIG2	TA MODE	TACEN	TAD2	TAD2	TAD1	TAD0

Bits	Name	Description
<7:6>	TATRIG	 TA sequencer re-trigger control 10= TA sequencer non-retriggerable, and release compensation after event times out 00= TA sequencer retriggerable (and compensation is released) after the previous event times out x1= TA sequencer non-retriggerable, and hold compensation until end of RG. In this mode all selected compensations (Low-Z Gain comp, HPF, Loop Hold are enabled until the end of RG
<5>	TAMODE	1= TA enabled beginning of RG 0= TA enabled during TRK mode only
<4>	TACEN	1= Enable the internal TA comparator 0= Disable the internal TA comparator This is meant for TA control from the external (FREEZEB) pin.
<3:0>	TAD	TAD pin function selection 0000 to 1001: TAD delayed by TADSEL*2 bytes (0 to 18 bytes of delay) 1011: TA comparator output 1100: sr0 (low Z switch control, for testing) 1101: sr1 (low Z switch control, for testing) 1110: sr2 (low Z switch control, for testing) 1111: sr3 (low Z switch control, for testing)

ŀ	RW	7	6	5	4	3	2	1	0
	85	LZRS2	LZRS1	LZRS0	LOOP H	LZD3	LZD2	LZD1	LZD0

Bits	Name	Description
<7:5>	LZRS ,	TA low Z recovery time step size TA low Z recovers in 3 intermediate steps: 25%, 50% and 75% between the low Z and the normal Z. The time step is the per step duration. Step duration= (1+LZREC[2:0]) byte, allows for 1 to 8 bytes per step
<4>	LOOP H	1= Enable the FREEZE pin to control the TA sequencer 0= Disable FREEZE pin
<3:0>	LZD	TA low Z length (duration) control When a TA compensation starts, the VGA input resistance first switches to low Z for a programmable amount of time, which is controlled by TALEN. Low Z time= (TALEN*2+1) bytes, for 0,=TALEN<=14 (decimal) 1111: TA low Z time is controlled by the internal comparator (if enabled) or by the FREEZEB pin (if enabled). If both are enabled, then they are logic OR'd to control the TA sequencer

RW	7	6	5	4	3	2	1	0
86	LZO1	LZO0	LZWS1	LZWS0	NRMZ1	NRMZ0	FREFSEL	DBW
Bits	Name	Description	on	-				

Bits	Name	Description
<7:6>	LZO	TA low Z option select 00: Normal impedance 2K ohm (no low Z on TA events) 01: 1K ohm low Z 10: 400 ohm low Z 11: 200 ohm low Z
<5:4>	LZWS	Write/extended write squelch (low Z) resistance select 00: Normal impedance 2K (no low Z) 01: 1K ohm low Z 10: 400 ohm low Z 11: 200 ohm low Z
<3:2>	NRMZ	Normal read input resistance select 00: Normal impedance 1.3K 01: 1.65K ohm low Z 10: 2K ohm low Z 11: 4K ohm low Z Note: All low Z values in TA or write squelch modes are referred to when normal input resistance set to 2K ohms.
<1>	FREF SEL	Selects the clock source (FREF1) for WGDLY (write squelch) and SGTMR timer in Servo) 0: Clock source FREF1= FREF 1: Clock source FREF1= FREF/2
<0>	DBW	TA detector bandwidth selection 0: High BW (20 MHz 3dB corner) 1: Low BW (10MHz 3dB corner)

(Reset value: 00 _H)	(R	eset	value:	00")
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RW	7	6	5	4	3	2	1	0
87	GCMP2	GCMP1	GCMP0	HPFM1	HPFM0	cs	WGTST	HPFOST

Bits	Name	Description
<7:6>	GCMP	Gain compensation setting during TA squelch time Gain is increased during the TA low Z time by GCMP [2:0]*0.38 dB
<4:3>	HPFM	HPF mode control during a TA event 00: No feedback from TA sequencer to the HPF 01: HPF goes into high bandwidth for the duration (programmable by TALEN and LZREC bits) of TA 10: HPF stays in high bandwidth until the end of read
<2>	cs	TA sequencer clock source select 0: RCLK; this is normal mode 1: FREF; this is meant for testing
<1>	WGTST	Write squelch one-shot test enable 1: Enable WG_timer to the multiplexed MTPC0 pin 0: Allow the daisy-chain input (from another module) to the test pin
<0>	HPFOST	HPF one-shot (SGOS in HPFCTRL register diagram) test output enable 1: Enable HPF one_shot to the multiplexed MTPC0 pin 0: Allow the daisy-chain input (from another module) to the test pin

88 TA CONFIG 5 (Reset value: 00_H)

RW	7	6	5	4	33	2	1	0
88	0	DWE	SGQL	ENPOS	ENNEG	TDACTA	HIZEN	DSEN
Bits	Name	Description	Description					
<6>	DWE	1= Extern wri pin	External direct write enable 1= External direct write mode enabled when pin DWEN is high. At this time, write data outputs (WDO/WDOB) is controlled directly by DW/DWB pins (see table below) 0= External direct write mode disabled					

ĺ	<5>	SGQL	Servo Gate Qualify for external direct write mode
	<2>	TDACTA	TATH DAC test enable. When this bit is set high, the TATH DAC output is connected to the ITO pin.
ļ	<4>	ENPOS	Enable TA detector for positive TA's

(Reset value: 00_H)

Note: TA compensation is not activated during servo mode

89 TA DETECTOR THRESHOLD

<3>

<1>

<0>

RW	7	6	- 5	4	3	2	1 .	0
89	THS3	THS2	THS1	THS0	THR3	THR2	THR1	THRO

Bits	Name	Description
<7:4>	THS	TA detect threshold control in Servo
<3:0>	THR	TA detect threshold control in Read
		·

8A TA HPF CONTROL

RW	7	6	5	4	3	2	1	0
8A	HPFM2	HPFM1	НРЕМ0	BWS	BWR	LHM2	LHM1	LHMO

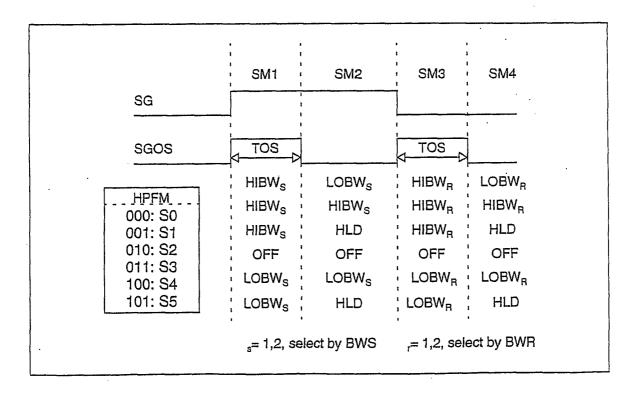
Bits	Name	Description
<7:5>	HPFM	Select the modes defined above. There are 6 legal modes.
<4>	BWS	Servo mode BW select 1= BW1 0= BW2
<3>	BWR	Non-servo mode BW select 1= BW1 0= BW2
<7:5>	HPF	-3dB corner: HIBW1: 3MHz LOBW1: 600kHz HIBW2: 1.5MHz LOBW2: 300kHz
<2:0>	LHM	Read mode Loop Hold Mode control 000: Normal. Timing and Gain*2 loops are not affected by the TAD_int*1 status *1: TAD_int is the internal thermal asperity signal. Both the internal detector and the FREEZE pin can trigger a TA event. Please see TA section for more information.
		*2: Gain and all other loops (MR, Boost, ADC Offset, FIR), except timing loop. 1xx: Gain hold always on 001: Gain hold when TAD_int is high 010: Timing TRK mode loop held when TAD_int is high 011: Both timing TRK and Gain loops held when TAD_int is high

44 SERVO GATE TIMER

(Reset value: 00H)

RW	7	6	5	4	3	2	1	0
44	WGDLY3	WGDLY2	WGDLY1	WGDLY0	SGTMR3	SGTMR2	SGTMR1	SGTMRO

Bits	Name	Description
<3:0>	WGDLY	Extended squelch after WG transitions from active to inactive Delay= WGDLY*TFREF1, for 0<=WGDLY<=15 TFREF1= FREF1 period (50ns or 100ns depending on FREFSEL) The delay is 0 to 750ns in 50ns step for a 20MHz FREF and FREFSEL= 0 The delay is 0 to 1.5us in 100ns step for a 20MHz FREF and FREFSEL= 1
<3:0>	SGTMR	HPF timer time select. Delay TOS= SGTMR*TFREF1, for 0<=SGTMR<=15 000: Timer off. Please refer to diagram in HPFCTRL section TOS is 0 to 750ns in 50ns step for a 20MHz FREF and FREFSEL= 0 TOS is 0 to 1.5us in 100ns step for a 20MHz FREF and FREFSEL= 1 TFREF1= FREF1 period (50ns or 100ns for a 20 MHz FREF, depending on FREFSEL bit)



10 SCA8700 Pin Description

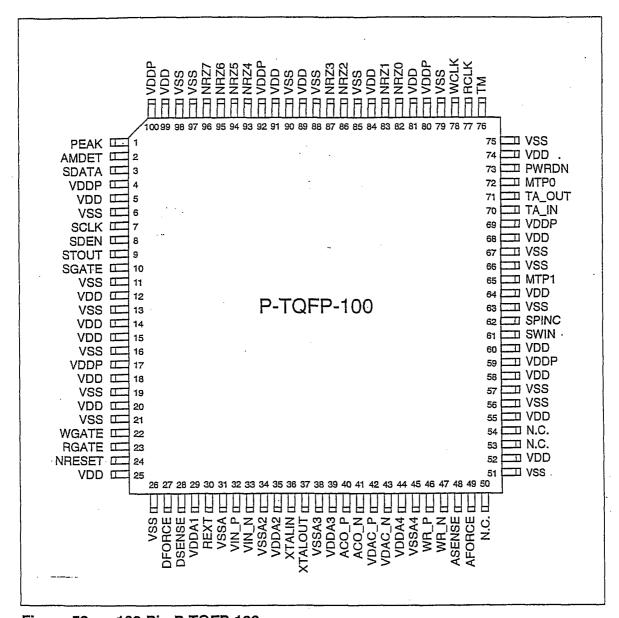


Figure 58 100 Pin P-TQFP-100

Table 26	SCA8700 Pin	Descriptions
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Pin Name 100-pin Type TQFP		Туре	Description
Analog Pins			
ACO_P	40	0	AC test bus output signal
ACO_N	41	Ō	AC test bus output signal
AFORCE	49	0	Analog domain power regulator external driver transistor control
ASENSE	48	1	Sense line for analog domain power regulator
DFORCE	27	0	Digital domain power regulator external driver transistor control
DSENSE	28	1	Sense line for digital domain power regulator
REXT	30	10	External reference resistor and technology monitor
VDAC_P	42	0	View DAC output signal and test port 1
VDAC_N	43	0	View DAC output signal and test port 2
VIN_P	32	1	Analog read signal from preamp and AC test bus input
VIN_N	33	I	Analog read signal from preamp and AC test bus input
WR_P	46	0	Write data output to preamp (PECL) and digital test output
WR_N	47	0	Write data output to preamp (PECL) and digital test output
XTALIN	36	1	Crystal oscillator input
XTALOUT	37	0 .	Crystal oscillator output
Digital Pins			
AMDET	2	0 .	Servo address mark detect signal
NRZ [7:0]	96, 95, 94, 93, 87, 86, 83, 82	IO(F)	NRZ read/write data port
GRAYD/ MTP1	65	0	Servo Gray data output/ Multi-purpose test port 1
NRESET	24	1	Active-low asynchronous reset
NSYNC/ MTP0	72	0	Active-low sync-found indication/ Multi-purpose test port 0
PEAK	1	0	Servo peak detect output

Table 26 SCA8700 Pin Descriptions (cont'd)

Pin Name	100-pin TQFP	Type	Description
PWRDN	73	ı	Active-high power-down signal
RCLK	77	O(F)	NRZ read data clock (Fast)
RGATE	23	1 .	Read gate
SCLK	7	1 .	Serial interface clock
SDATA	3	I/O(F)	Serial interface data (Fast)
SDEN	8	1	Active-high serial interface enable
STOUT	9	0	Servo burst strobe output
SGATE	10	1	Servo gate
TA_OUT	71	0	Thermal asperity detect input
TA_IN	70	1	Thermal asperity detect output
TM	76	1	Test mode enable
WCLK	78	I	NRZ write data clock
WGATE	22	I	Write gate
SWIN	61	ı	Servo sync byte search window enable
SPINC	62	1	Servo normal AGC mode timer signal
Power and (Ground Pins		
VDD	5,12,14,15, 18,20,25,52, 55,58,60,64, 68,74,81,84, 89,91,99	-	Digital core positive supply (+1.8V +/- 5%); 6 double pads/6 pins
VDDP	4, 17, 59, 69, 80, 92,100	_	Digital I/O positive supply (+3.3V +/- 10%); 7 pads/7 pins
VSS	6, 11, 13, 16, 19, 21,26, 51, 56, 57, 63,66,67,75, 79, 85, 88, 90, 97,98	-	Digital GND; 6 double pads/6 pins
VDDA1	29		Analog positive supply for power regulators, reference generator, VGA, MRA, NG, TS, CTF (1.8V +/- 5%); 1 double pad/1 pin
VSSA1	31	-	Analog ground corresponding to VDDA1; 1 double pad/ 1 pin

Table 26 SCA8700 Pin Descriptions (cont'd)

Pin Name	100-pin TQFP	Туре	Description
VDDA2	35	-	Analog positive supply for sample & hold and ADC (1.8V +/- 5%); 1 double pad/1 pin
VSSA2	34	-	Analog ground corresponding to VDDA2; 1 double pad/ 1 pin .
VDDA3	39		Analog positive supply for crystal oscillator and R/W-PLL (1.8V +/- 5%); 1 double pad/1 pin
VSSA3	38		Analog ground corresponding to VDDA3; 1 double pad/ 1 pin
VDDA4	44		Analog positive supply for write precompensation, Servo-PLL, View DAC and AC test buffer (1.8V +/- 5%); 1 double pad/1 pin
VSSA4	45	•	Analog ground corresponding to VDDA4; 1 double pad/ 1 pin

11 Electrical Specifications

11.1 Absolute Maximum Ratings

Parameter	Symbol	Limit Values	Unit
Ambient temperature under bias	T _A	-20 to 85	°C
Storage temperature	T _{STG}	- 65 to 125	°C
Supply voltage	V _{DD}	-0.5 to 4.2	V
Supply voltage	V _{DDA}	-0.5 to 4:2	V
Supply voltage .	V _{DDP}	-0.5 to 6.0	V
Voltage on any pin with respect to ground	Vs	If VDDP < 3 V: - 0.4 to VDD + 0.5 If VDDP > 3 V: - 0.4 to VDDP + 0.5	V

11.2 DC Characteristics

 $V_{\rm DDP}$ = 3.3 V ± 10%; $V_{\rm DD}$ = 1.8 V ± 5%; $V_{\rm SS}$ = 0 V; $T_{\rm A}$ = 0 to 70 °C

Parameter	Symbol	Lin	nit Valu	ıes	Unit	Test Condition	
•		min.	typ.	max.			
Input leakage current	I _{3L}	- 10	,	10	mA	$VIN = V_{ss}$ to V_{ddp}	
Digital input high level	. V _{IH}	2.0		VDDP + 0.3	V		
Digital input low level	V _{IL} .	0		0.80	V		
Digital output high level (Fast) pins RCLK,NRZ,SDATA	V _{OH}	VDD- 0.45			V	IO = 2 mA	
Digital output low level (Fast) pins RCLK,NRZ,SDATA	V _{OL}			0.45	V	IO = 5 mA	
Digital output high level (Default)	V _{OH}	VDD- 0.45			٧	IO = 2 mA	
Digital output low level (Default)	V _{OL}			0.45	V	IO = 5 mA	
VDD supply current (Suspend mode)	l _{DDS1}			50	mA		
VDD supply current (Idle mode)	I _{DDS2}			200	mA		

Parameter (cont'd)	Symbol	Lir	nit Val	ues	Unit	Test Condition
		min.	typ.	max.		
VDD supply current (Read mode)	I _{DDS3}			500	mA	80 Percent Read/ 500 MHz

200

mΑ

500 MHz

 $V_{\rm DDP}$ = 3.3 V \pm 10%; $V_{\rm DD}$ = 1.8 V \pm 5%; $V_{\rm SS}$ = 0 V; $T_{\rm A}$ = 0 to 70 °C

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11.3 AC Characteristics

VDD supply current (Write

mode)

Digital inputs are driven to 2.4 V for a logical "1" and to 0.45 V for a logical "0". Timing measurements are made at 2.0 V for a logical "1" and 0.8 V for a logical "0". The ACtesting input/output waveforms are shown below.

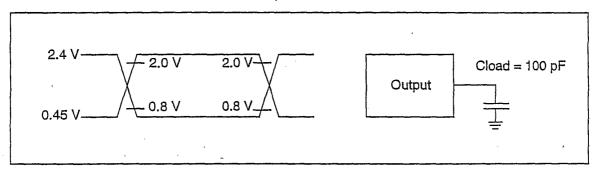


Figure 59 Input/Output Waveforms for AC-Tests

Table 27 Serial Interface

Parameter Sym	Symbol	Li	Limit Values			Test Condition
	•	min.	typ.	max.		
SCLK period	t _{PER}	20			ns	
SCLK high time	t _{CKH}	8	10	12	ns	
SCLK low time	t _{CKL}	8	10	12	ns	
SDEN setup time	t _{su1}	20			ns	
SDEN hold time	tHOT	20			ns	
SDATA setup time	t _{su} -	5			ns	·
SDATA hold time	t _{HD}	2			ns	·

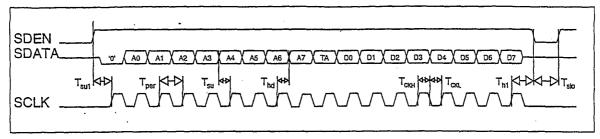


Figure 60 Serial Port Write Timing

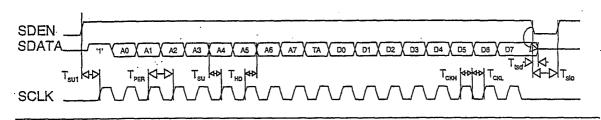


Figure 61 Serial Port Read Timing

Table 28 NRZIO Interface

Parameter	Symbol Limit Values			Unit	Test Condition	
		min.	typ.	max.	1	-
NRZIO delay time rising clk	t _{PRC}			3.7	ns	15 pF load, 10-90%
NRZIO delay time falling clk	t _{PFC}			3.7	ns	15 pF load, 10-90%
RCLK rise/fall time	t _R / t _F			3.7	ns	10 pF load, 10-90%
NRZIO setup time	t _{su}	5			ns	
NRZIO hold time	t _{HD}	2	,		ns	

Table 29 VGA Amplifier

Parameter	Symbol	Limit Values			Unit	Test Condition	
		min.	typ.	max.			
Input resistance differential		3.4		4.6	k Ohms	Not squelch Modes (Rin normal = 4K)	
Input resistance differential		3.4		4.6	k Ohms	Nonsquelch mode	

Table 29 VGA Amplifier (cont'd)

Parameter	Symbol	Liı	nit Val	ues	Unit	Test Condition	
		min.	typ.	max.	1	·	
Input capacitance differential		3		6	pF	No bandwidth Spec	
Input signal range		40	100	400	mVpp dif	No harmonic distortion	
Gain variation		-2		+2.	dB		
Gain switch time		0	20	32	ns	Read mode to Servo mode Servo mode to Read mode	
Output offset voltage		-5	0 .	+5	mV		
CMRR		40		· .	dB	Gain = 0 dB Fvcm DC to 30 MHz	
Input referred noise			7.5	15	nV/ VHz		

Table 30 Thermal Asperity Detect and Correct

Parameter	Symbol	Limit Values			Unit	Test Condition
		min	typ.	max.	1	·
ITA_OUT output pulse width				8	Bytes	
TA_Threshold step		26	28	30	mV	
TA low-Z value		255 680	300 800	345 920	Ohms	300 Ohms setting 800 Ohms setting
TA threshold DAC - DNL TA threshold DAC - INL				1/4	LSB	

Table 31 Noise Generator

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.	1	
Noise voltage range		1		20	mV _{rms}	400 MHz bandwidth
Noise bandwidth (high)				400	MHz	
Noise bandwidth (low)		1.5	·		MHz	

Table 32 Specifications for a Single Biquad

SPEC	CONDITIONS VDDA=1.8+/3% T=0 TO 70C Ambient	Min	Nom	Max
Complex-pole pair frequency range	This is NOT the same as traditional - 3dB Frequency, as the filter transfer function. ω_0 =0.43*750*17/16	87.5 MHz		350 MHz
Pole Frequency Programming step size	256 monotonic steps over the entire frequency range.			2%
Quality Factor (Q) range		0.6		1.6
Q programming step size	16 monotonic steps.			0.2
Absolute Pole frequency accuracy (f _{complex pair} >130MHz)	From nominal programmed value; Includes ALL sources of error. Environmental variation from nominal.	-50%		50%
· complex pair		-5%		+5%
Absolute Q accuracy (f _{complex pair} >130MHz)	From nominal programmed value; includes All sources of Q error. Environmental variation from nominal.	-50%		+50%
		-5%		+5%
Absolute Pole frequency accuracy (f _{complex pair} <130MHz)	From nominal programmed value; Includes ALL sources of error. Environmental variation from nominal.	-15%		+15%
		-5%		+5%
Absolute Q accuracy (f _{complex pair} <130MHz)	From nominal programmed value; Includes All sources of Q error. Environmental variation from nominal.	-15%		+15%
		-5%	}	+5%
Total Harmonic Distortion	Corner frequency programmed at 350MHz. Full-scale input set at a third of 116MHz; Q=1; Input adjusted to give full-scale output swing. Q=1.6 LAB CHARACTERIZATION ONLY			-34 Db

Table 33 Analog to Digital Converter - ADC

Parameter	Symbol	L	imit Valu	es	Unit	Test Condition
		min.	ty300 MHz sinep	max.		
Maximum conversion rate		50		850	MS/s	
Resolution			6 .		bits	
AC integral nonlinearity	·	-0.8		+0.8	lsb	(1) 200 MHz, full scale sine wave input
AC differential nonlinearity	#13# 7 05# 780 040 ***	-0.8		+0.8	lsb	same as (1)
Offset error		-4	0	4	lsb	
Gain error		-5		+ 5	%	
Analog input bandwidth		400	-		MHz	-1 dB
Input - full scale range (FSR)			1000		mVpp dif	
THD		·· · · · ·		-36	dB	(2) 200 MHz sine wave input at 75% of full scale
SNR		32			dB	same as (2)

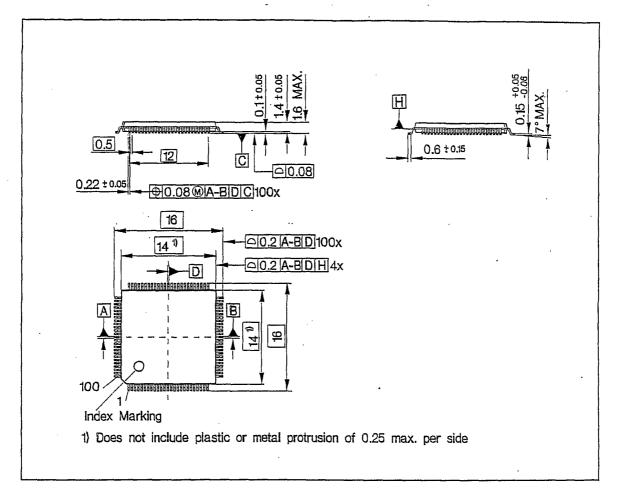
Table 34 Frequency Synthesizers - Read Mode or Servo Mode PLL

Parameter	Symbol Limit Values			Unit	Test Condition	
		min.	typ.	max.]	
VCO frequency Read mode		800		1600	MHz	
absolute jitter		,		15	ps	1s
settling time				10	us	0.1% frequency error
FREF, reference frequency		20		80	MHz	

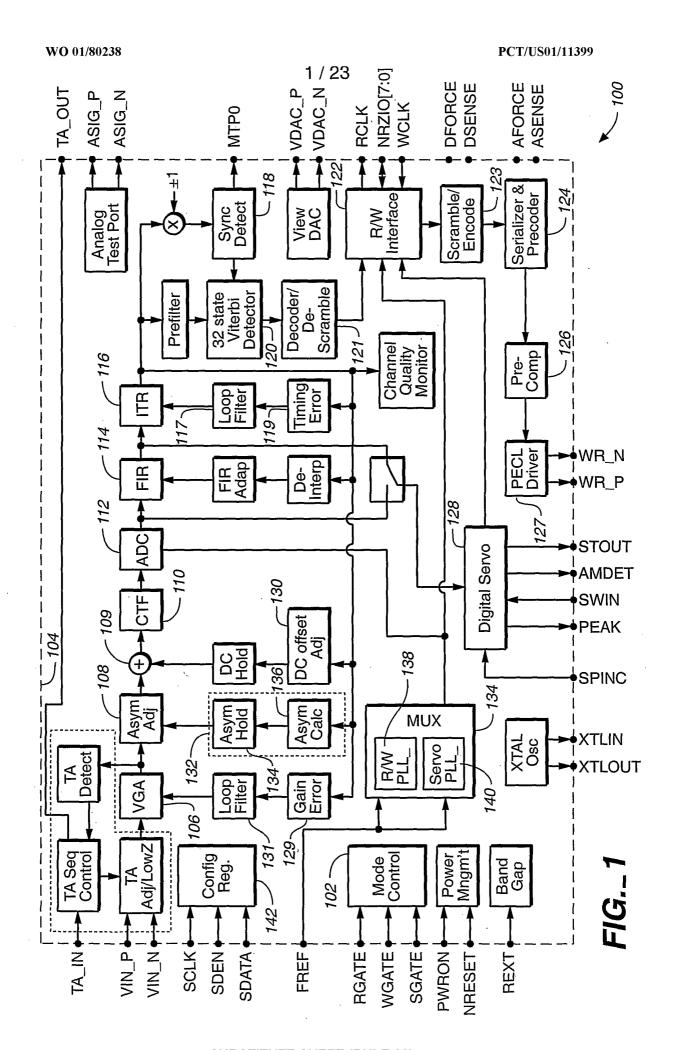
Table 35 Buffer used for View DAC and Analog Test Port

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
DC gain			TDB		dB	
Frequency bandwidth		1000			MHz	-3dB
THD		-42			dB	200MHz sine wave at 75% of full scale and 850 MHz update rate

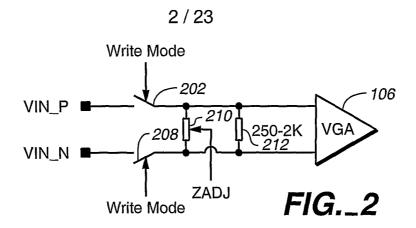
12 Package Outline Drawing

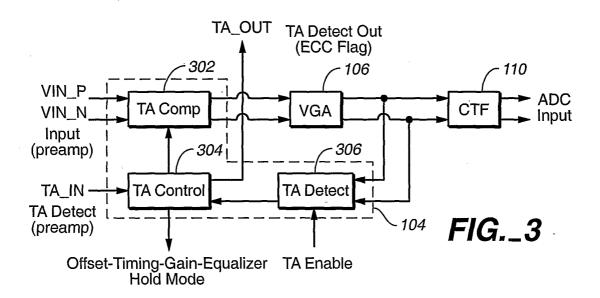


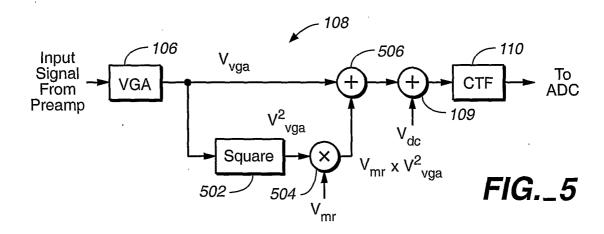
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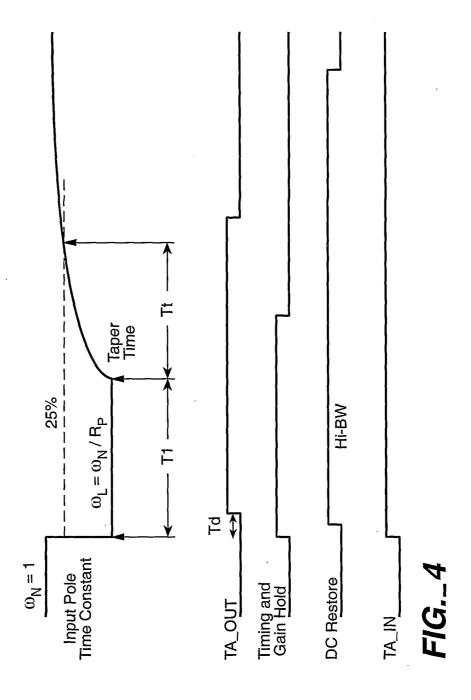


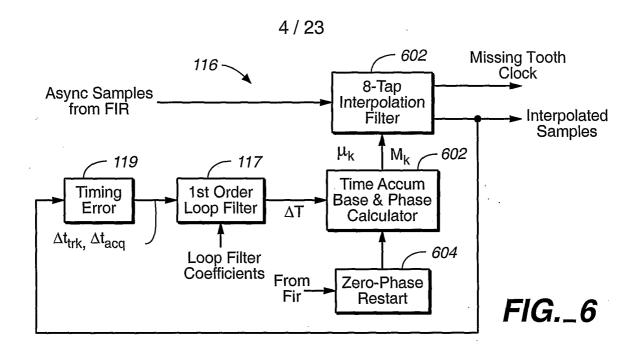
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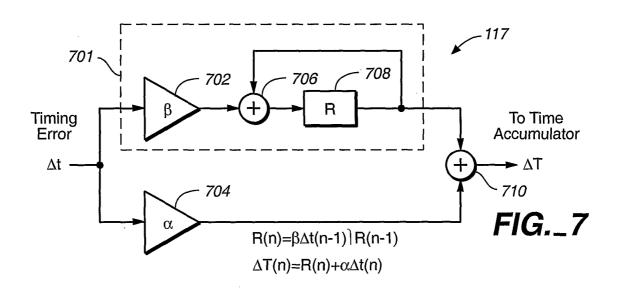


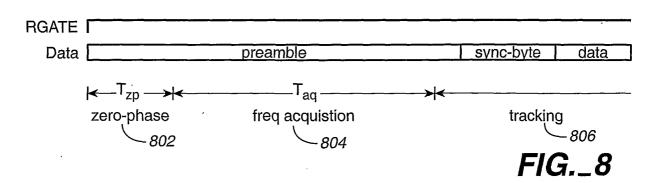


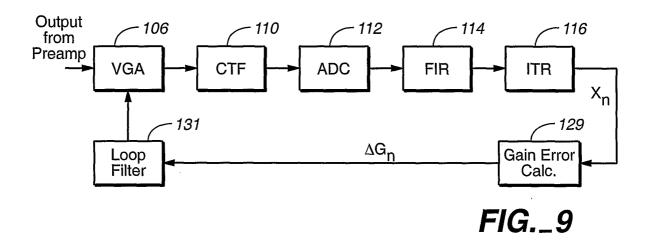


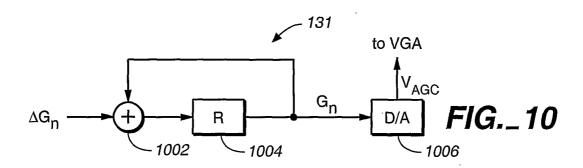


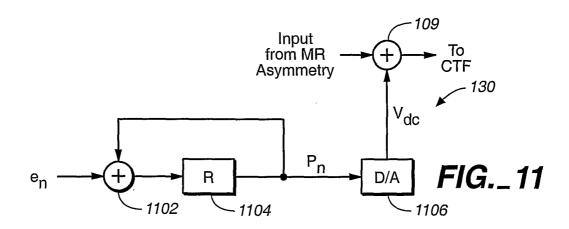


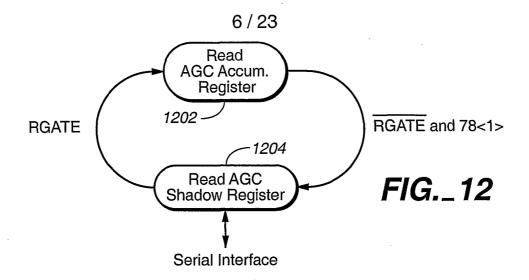


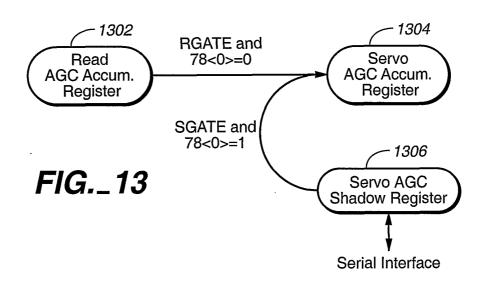


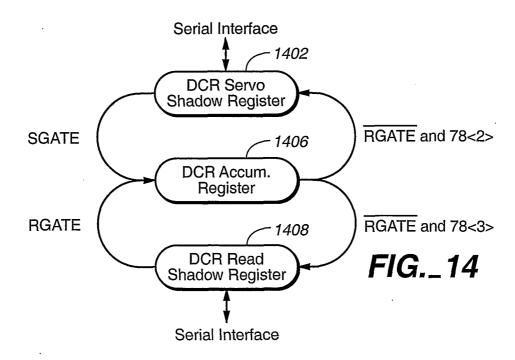


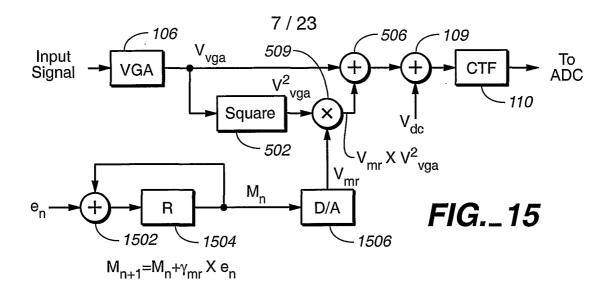


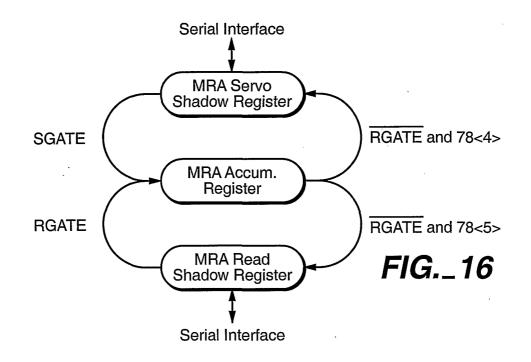


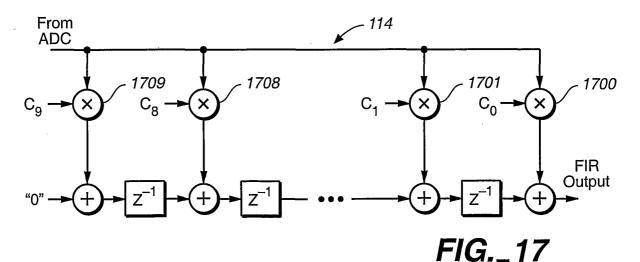


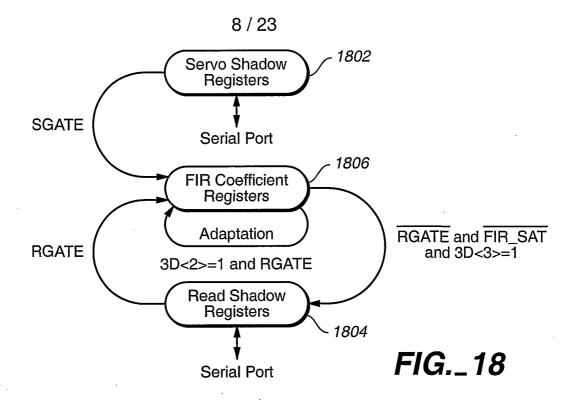


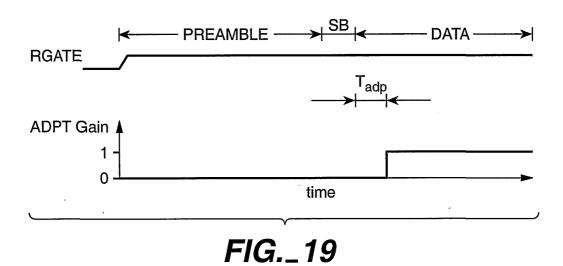


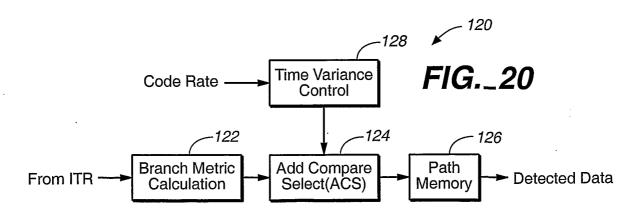




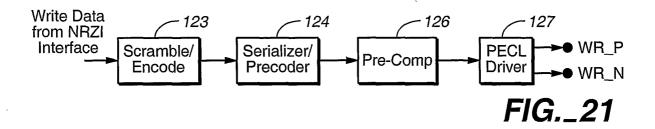


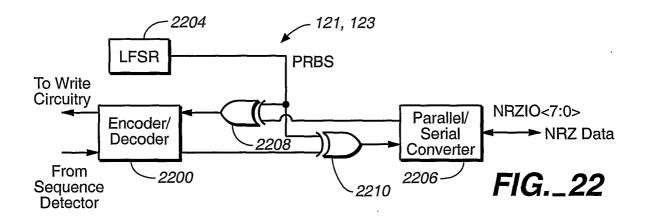






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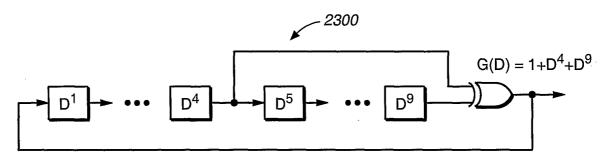
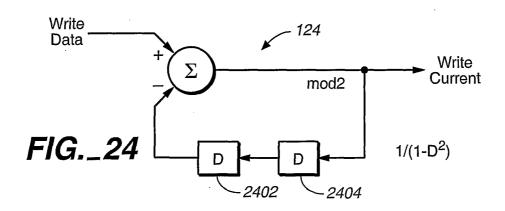


FIG._23





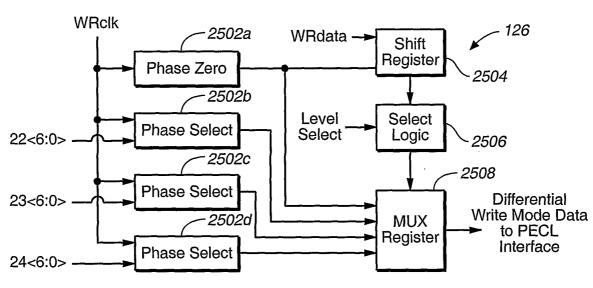
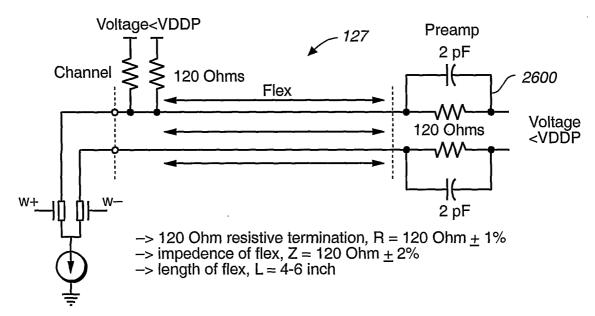
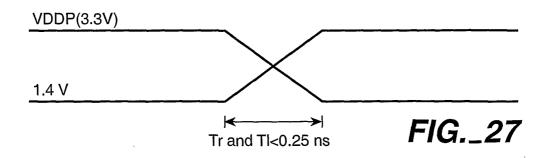


FIG._25

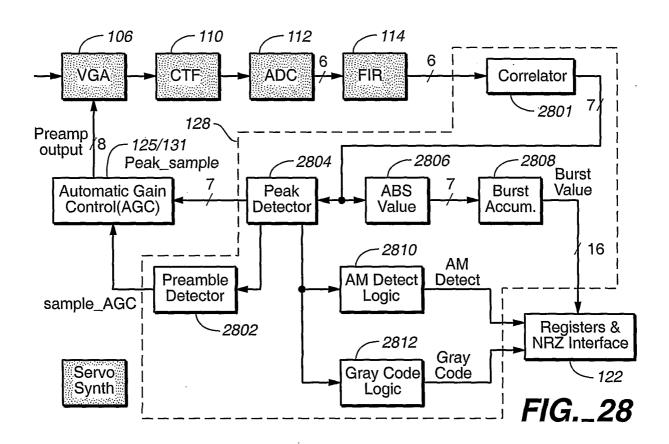


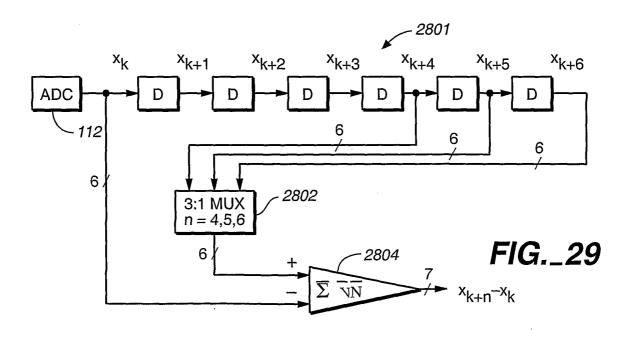
J = 21 < 7:5 > (16 to 37 mA) in steps of 3 mA

FIG._26



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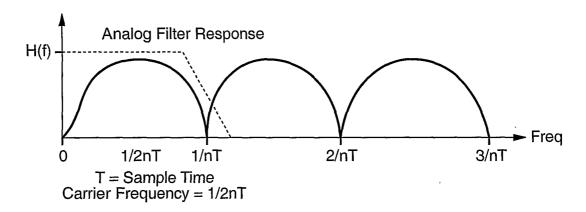


FIG._30

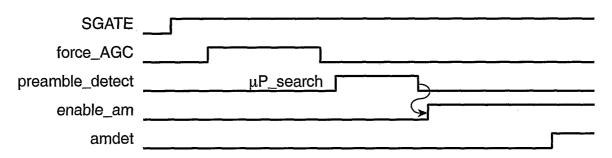


FIG._31

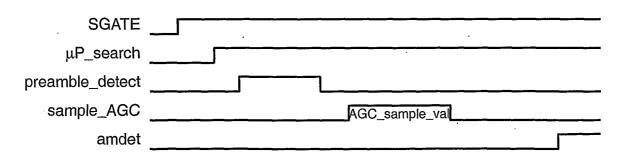


FIG._32

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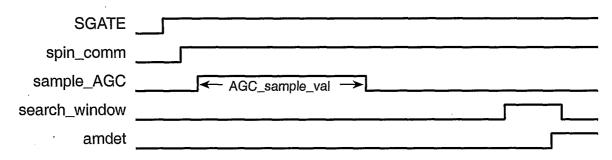


FIG._33

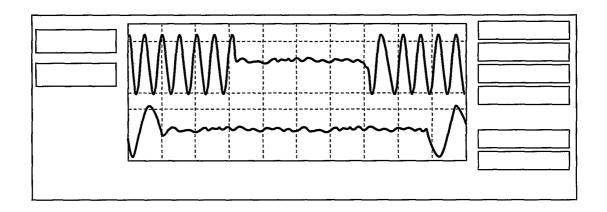


FIG._34

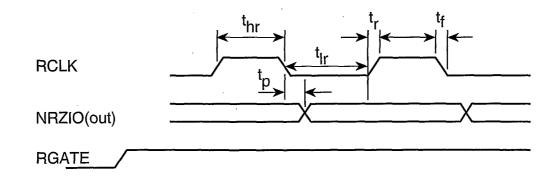


FIG._35



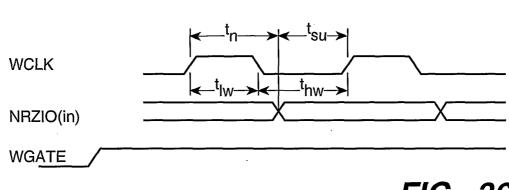
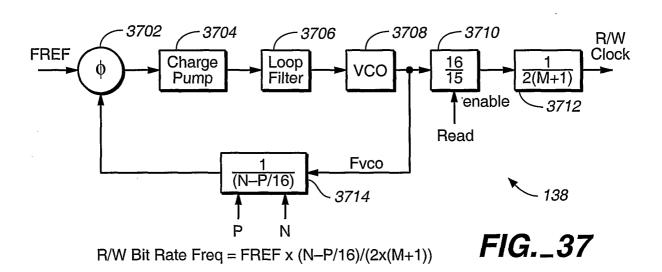
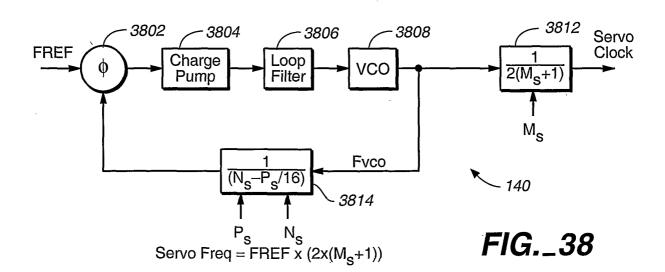
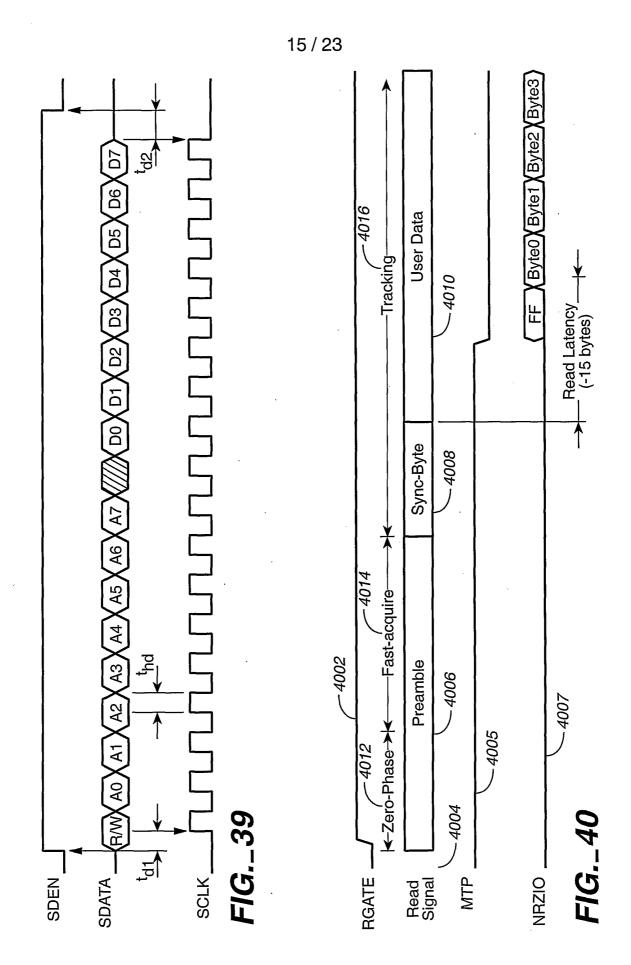
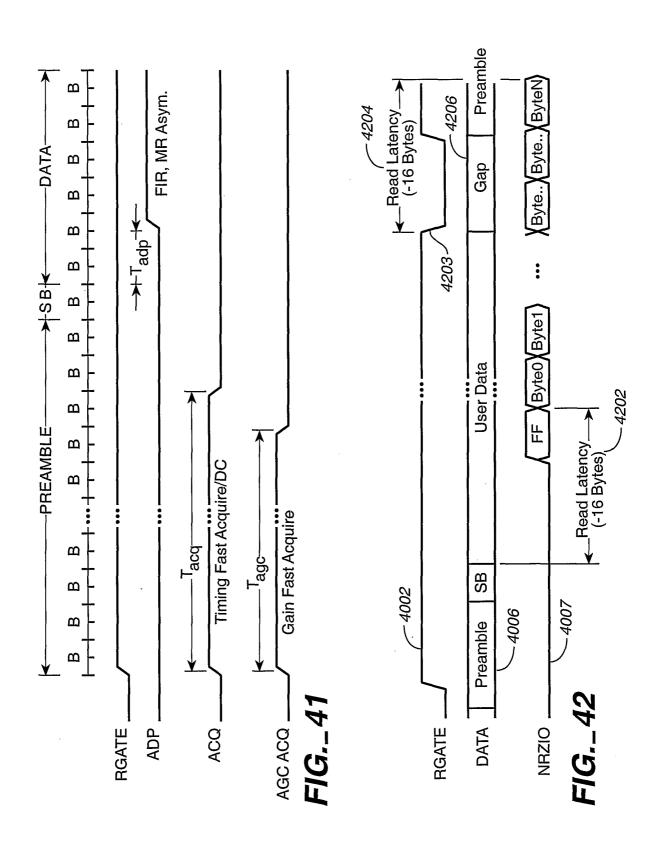


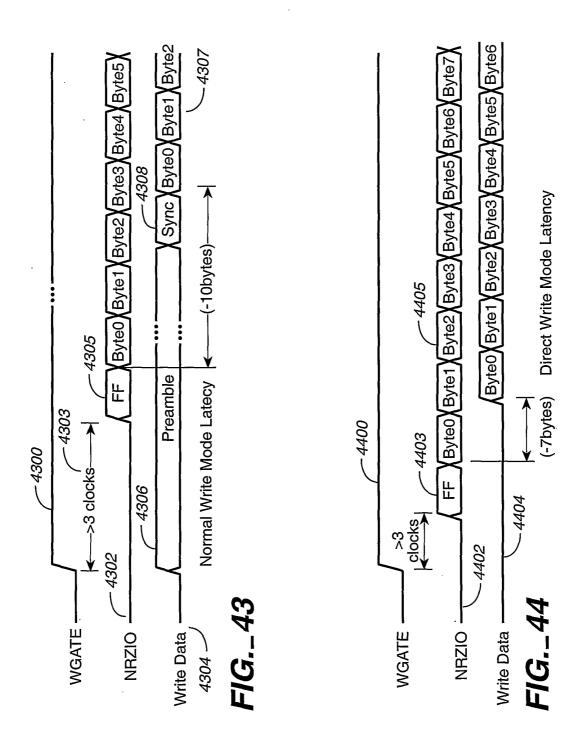
FIG._36

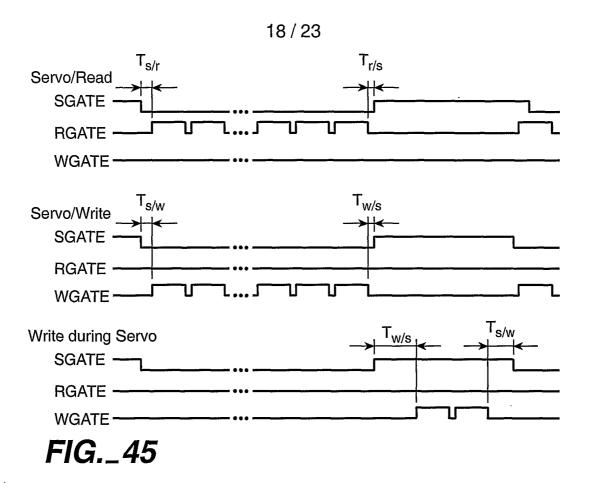


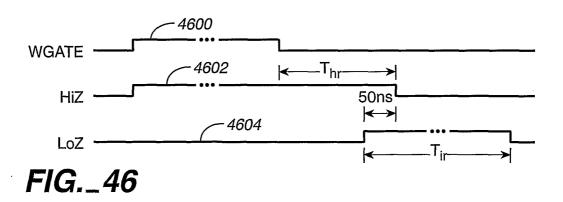












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(000)
$$\hat{e}^2 = \sum_{n} [y_n - x_n^{\hat{}}]^2$$

MSE1 referenced to estimated sample value

(001)
$$e^2 = \sum_{n} [y_n - x_n]^2$$

MSE2 referenced to known sample value

(010)
$$e_0^2 = \sum_{n} [y_n]^2$$

MSE3 - error signals

(011)
$$N(T_L, T_H) = \sum_n I(T_L < y_n < T_H)$$

Surface analysis

(100)
$$N(e^2) = \sum_{n} I\{[y_n - \hat{x_n}]^2 > T_{e^{-2}}\}$$

Histogram 1 referenced to estimate

(100)
$$N(e^2) = \sum_{n} I\{[y_n - x_n]^2 > T_{e^{-2}}\}$$

Histogram 2 referenced to known sample value

Where:

 \boldsymbol{y}_{n} is the parameter being measured

 x_n is the estimated noise free sample value

 \hat{x}_n is the known noise free sample value

a_n is the known data

I(-) is the index function, = 1 if I is true else 0

T_n are programmable thresholds

 $Z_n = 1$ if decoder output byte n in error, else 0

FIG._47a

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(101)
$$N(e^2) = \sum_{n} I[y_n^2 > T_{e^{-2}}]$$
 Histogram 3

(110)
$$N(E) = \sum_{n} I(z_n > 0)$$
 Error Rate

(111)
$$D(y) = \sum_{n=1}^{\infty} (y_n \times a_n) - (y_n \times (a_n - 1))$$
 DiBit Extraction

Where:

 \boldsymbol{y}_{n} is the parameter being measured

 $\mathbf{x}_{\mathbf{n}}$ is the estimated noise free sample value

 \hat{x}_n is the known noise free sample value

an is the known data

I(I) is the index function, = 1 if I is true else 0

T_n are programmable thresholds

 $Z_n = 1$ if byte/bit n in error, else 0

FIG._47b

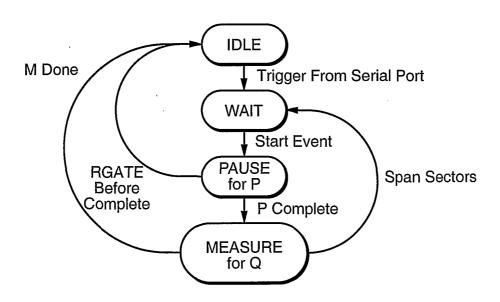
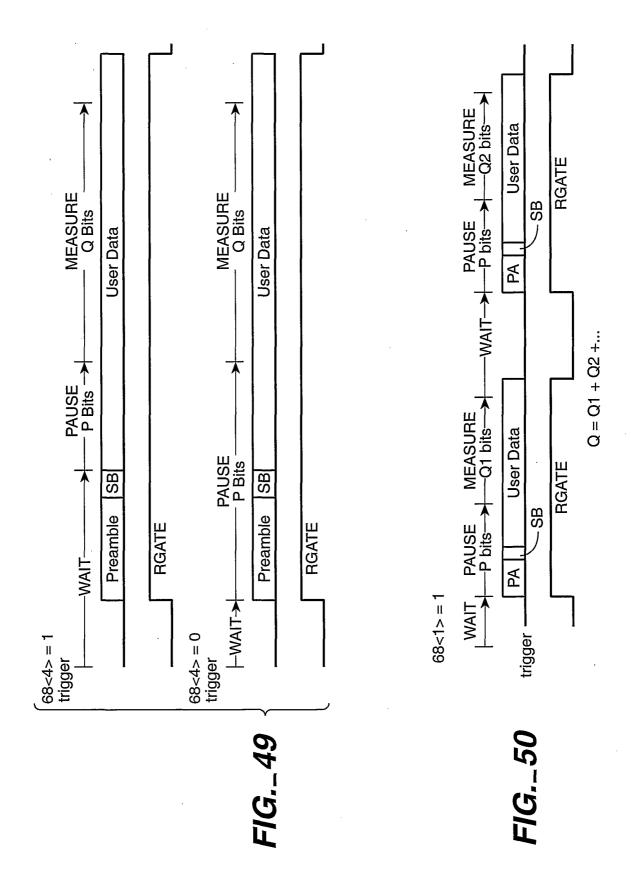
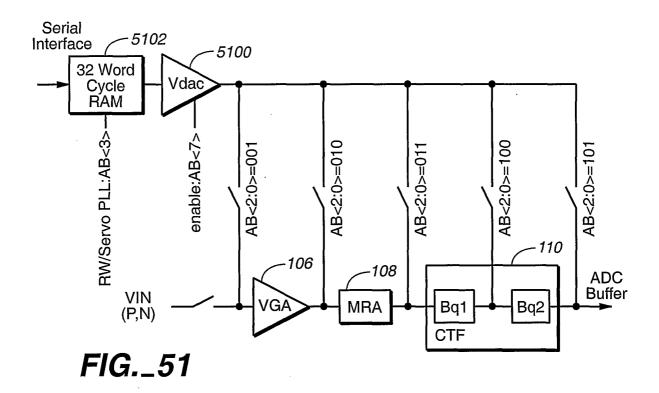
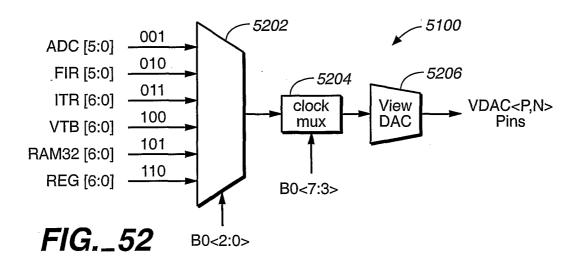
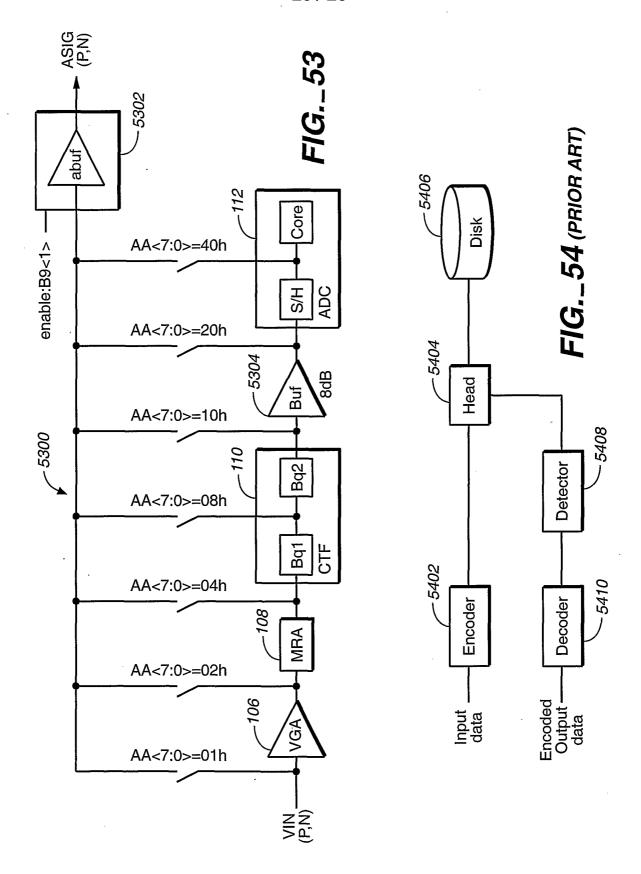


FIG._48









A. CLASSIFICATION OF SUBJECT MATTER IPC 7 G11B20/10 G11B5/09

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols) IPC $\,7\,$ G11B

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data, PAJ, IBM-TDB, COMPENDEX, INSPEC

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 Special categories of cited documents: "A" document defining the general state of the art which is not considered to be of particular relevance "E" earlier document but published on or after the international filing date "L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) "O" document referring to an oral disclosure, use, exhibition or other means "P" document published prior to the international filing date but later than the priority date claimed Date of the actual completion of the international search 	 "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art. "&" document member of the same patent family 		
10 September 2001	24/09/2001		
Name and mailing address of the ISA European Patent Office, P.B. 5818 Patentlaan 2 NL – 2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016	Authorized officer Schiwy-Rausch, G		

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